



**MxL86112C**

Ethernet PHY

**Single Port 1G Ethernet PHY**

MxL86112C

**Data Sheet**

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## Preface

This Data Sheet describes the features and system architecture of the Ethernet PHY MxL86112C, which is a Single Port 1G Ethernet PHY.

## Document Conventions

In the interest of brevity, this document uses short names to represent full product names.

**MxL86112C**      Ethernet PHY MxL86112C

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## Organization of this Document

- **Chapter 1, Product Overview**

This chapter provides an overview of the MxL86112C.

- **Chapter 2, External Signals**

This chapter provides a pinout of the MxL86112C device package.

- **Chapter 3, Functional Description**

This chapter provides the functional description for the MxL86112C.

- **Chapter 4, MDIO and MMD Register Interface Description**

This chapter describes the MDIO and MMD registers available to support the MxL86112C feature set.

- **Chapter 5, MDIO Registers Detailed Description**

This chapter describes the fields and reset values of the MDIO registers.

- **Chapter 6, MMD Registers Detailed Description**

This chapter describes the fields and reset values of the MMD registers.

- **Chapter 7, Electrical Characteristics**

This chapter provides the electrical characteristics for the MxL86112C.

- **Chapter 8, Package Outline**

This chapter provides a package outline and product ordering details for the MxL86112C.

- **Standards References**

## 1 Product Overview

The Ethernet PHY MxL86112C is a low power Ethernet PHY transceiver integrated circuit. It offers a cost-optimized solution that is well-suited for routers, switches, and home gateways. It performs the data transmission on an Ethernet twisted pair copper cable of category Cat5 or higher. MxL86112C supports the following data rates: 1000, 100, and 10 Mbit/s.

In terms of the Open System Interconnection (OSI) model, the MxL86112C implements a layer 1 physical media access device. It can be connected to another chip implementing a layer 2 MAC via a serial SGMII data interface.

On the Ethernet twisted pair interface, the MxL86112C is compliant with the following standards from IEEE 802.3 referenced in [\[1\]](#): 1000BASE-T (IEEE 802.3 Clause 40), 100BASE-TX (IEEE 802.3 Clause 25), and 10BASE-Te (IEEE 802.3 Clause 14). This interface supports the Energy-Efficient Ethernet feature to reduce idle mode power consumption. Power saving at the system level is also possible with the Wake-on-LAN feature. A low-EMI line driver with integrated termination facilitates the PCB design.

On the SGMII interface, connecting to another chip implementing a MAC layer, the MxL86112C supports the following standards: IEEE 802.3 Clause 36 and 27 [\[1\]](#), and Cisco SGMII [\[2\]](#). This interface also operates at data rates: 1000, 100, and 10 Mbit/s.

The MxL86112C supports a standard MDIO management interface as defined in IEEE 802.3 Clause 22 and Clause 45 [\[1\]](#). The MDIO serial interface can operate with a clock running up to 25 MHz. It allows a management entity (the external chip implementing the MAC) to access standard MDIO / MMD registers to control the MxL86112C behavior, or to read the link status. In addition, two vendor specific register banks (VSPEC1 and VSPEC2) allow MxL86112C specific configuration of LED, SGMII, and Wake-on-LAN features. The MDIO and MMD registers are documented in [Chapter 5](#). The MxL86112C is also configurable via pin strapping.

The MxL86112C can drive up to three LEDs. Each LED is independently programmable to indicate the link speed, and traffic activities. Several indication schemes can be selected.

External supplies of both 3.3 V and 0.97 V are required.

The MxL86112C uses a single row package (type PG-VQFN-40, size 5 mm x 5 mm).

## 1.1 Features

This chapter provides an overview of the features supported by the MxL86112C:

### Communication Interfaces

- The multiple speed, single-port Ethernet PHY interface to the twisted pair cable supports:
  - Ethernet modes and standards: 1000BASE-T (IEEE 802.3), 100BASE-TX (IEEE 802.3) and 10BASE-T (IEEE 802.3)
  - Ethernet twisted pair copper cable of category CAT5 or higher
  - Low EMI voltage mode line driver with integrated termination resistors
  - Transformerless Ethernet for backplane applications
  - Auto-negotiation (ANEG) with extended next page support
  - Auto-MDIX and polarity correction
  - Auto-downspeed (ADS)
  - Energy-Efficient Ethernet (EEE) and power down mode
  - Wake-on-LAN (WoL)
- The SGMII SerDes interface supports:
  - 1000BASE-X IEEE 802.3 Clause 36 and 37 [\[1\]](#)
  - Cisco Serial-GMII Specification [\[2\]](#) operating at 1.25 Gbaud/s
  - Clock and Data Recovery (CDR)
- The management interface supports the communication between the Station Management (acronym “STA” per IEEE 802.3) and the MxL86112C using:
  - An MDIO slave interface that provides access to the standard registers in the MMD as described in IEEE 802.3 Clause 22 and Clause 45 [\[1\]](#) and listed in [Chapter 5](#)
  - An MDIO interface clock of up to 25 MHz
  - An MDIO interface with 1.8 V and 3.3 V levels are supported
  - 3 MDIO message frame types as described in IEEE 802.3: Clause 22, Clause 22 Extended, Clause 45 [\[1\]](#)
- The LED interface supports:
  - Up to 3 LEDs
  - Single color LEDs
  - Connection of LED to ground or 3.3 V
  - Several LED indication schemes (link/activity, link speed)
  - Configuration of LED indication via MDIO registers
  - Control of LED brightness via software driver API
  - Alternative configuration of LED pins as GPIO for custom indication
- Supports two external interrupts EXINT0 and EXINT1:
  - Configurable as input from, or output to an external controller

### Clocking Features

- 25 MHz crystal operation
- Supports two general purpose clock pins GPC1 and GPC2 shared with GPIO

### Test Features

- Cable diagnostics: cable open/short detection and cable length estimation
- UART

### Other Features

- Temperature Sensor (warning, interrupt, reset and auto-downspeed)
- Dynamic Voltage Scaling
- FW upgrade over MDIO
- Low power mode to reduce the energy consumption when the Ethernet cable is unplugged, with automatic wake-up upon energy detection from cable

### Power Supply

- 3.3 V power supply
- 0.97 V power supply

## 1.2 Block Diagram

Figure 1 shows the block diagram of the MxL86112C. The main interfaces are:

- Data interface to a MAC processor, using SGMII
- Slave control interface driven by a MAC processor, using MDIO slave
- Interrupt signal MDINT allowing the MxL86112C to notify the MAC processor about a change of status
- LED control
- Twisted pair interface

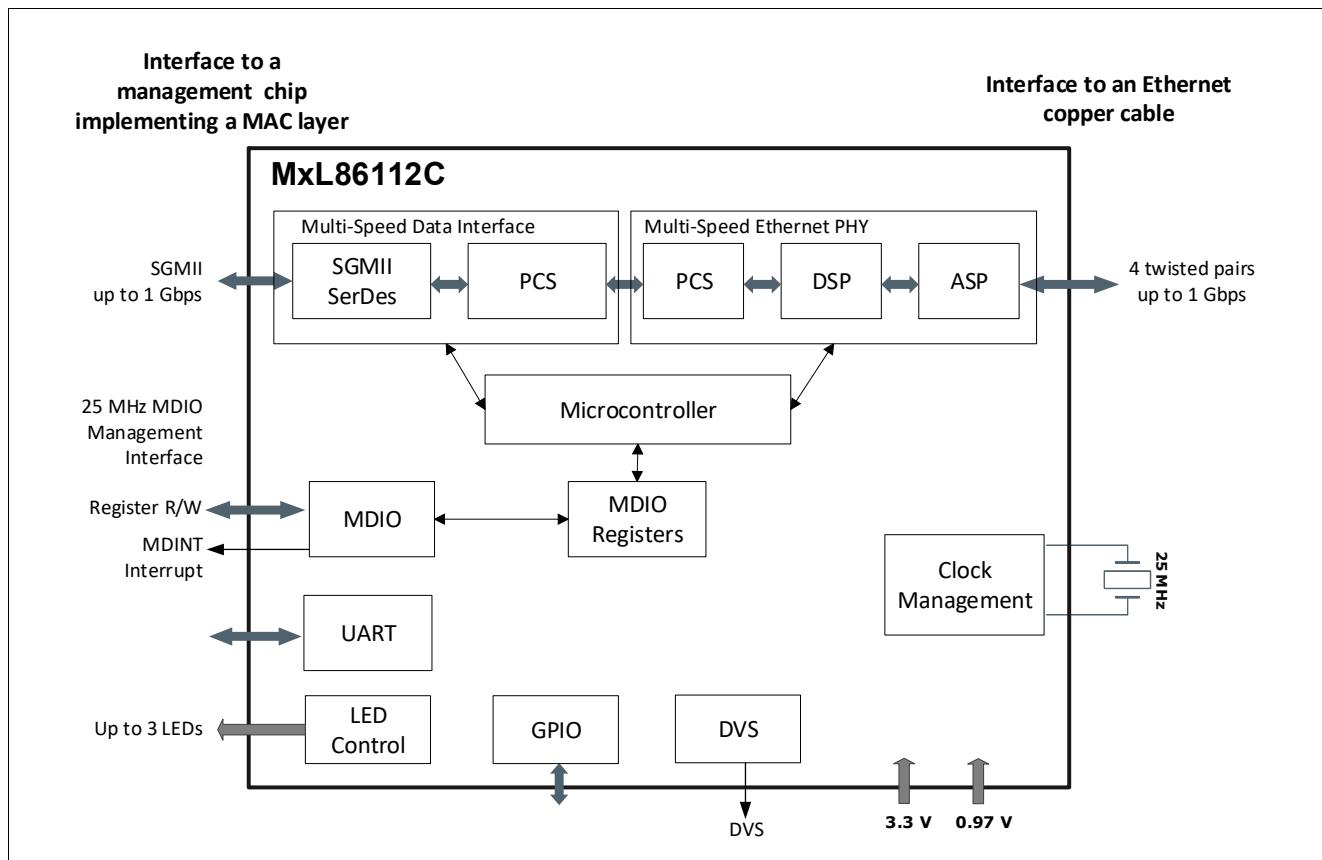


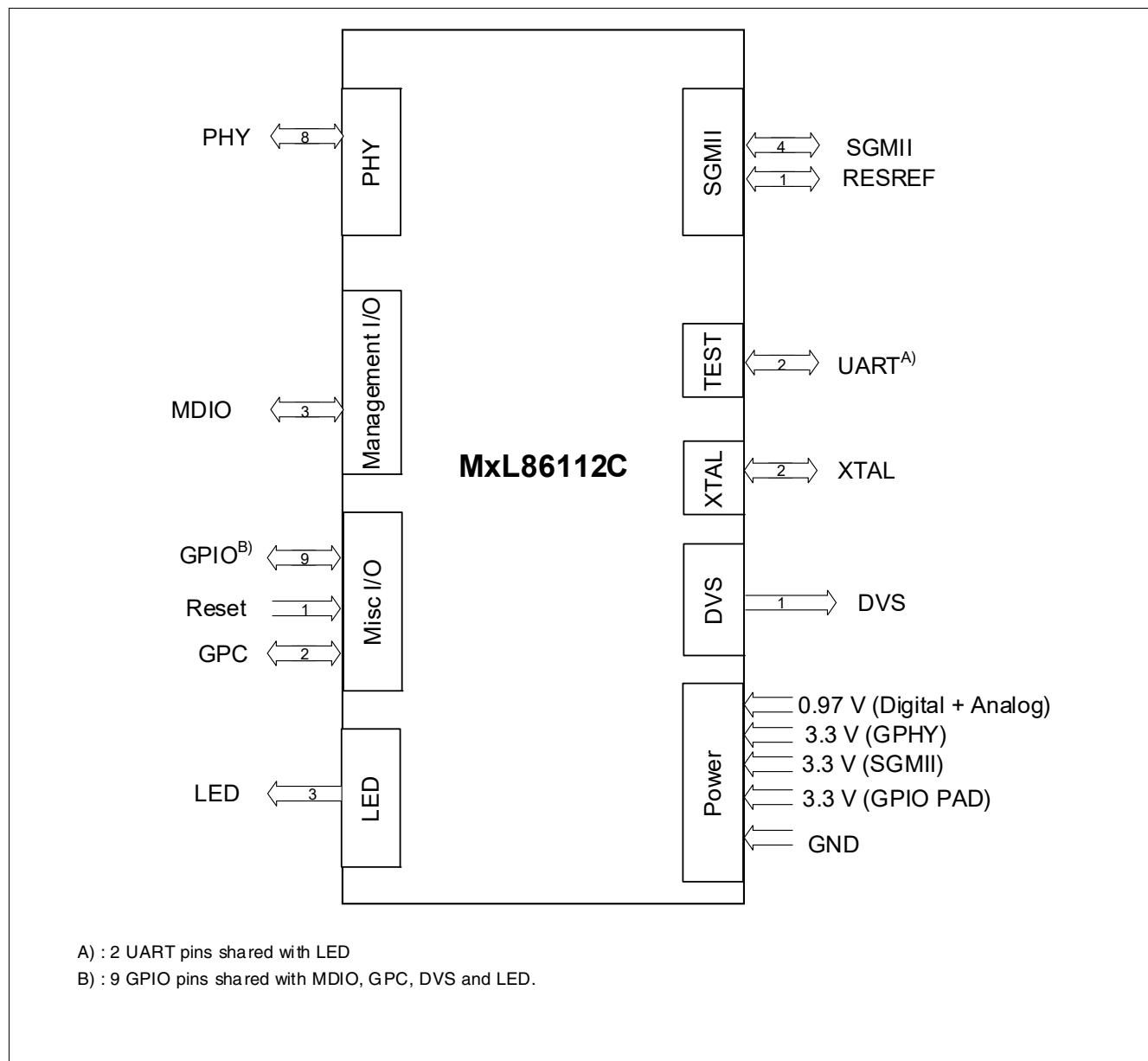
Figure 1 Ethernet PHY MxL86112C Block Diagram

## 2 External Signals

This chapter describes the signal mapping to the package.

### 2.1 Overview

**Figure 2** provides an overview of the external interfaces of the MxL86112C.



**Figure 2** Ethernet PHY MxL86112C External Signals Overview

## 2.2 External Signal Description

This chapter provides the pin diagram, abbreviations for pin types and buffer types, as well as tables describing the input and output signals.

### 2.2.1 Pin Diagram

The pin layout of the package is shown in [Figure 3](#).

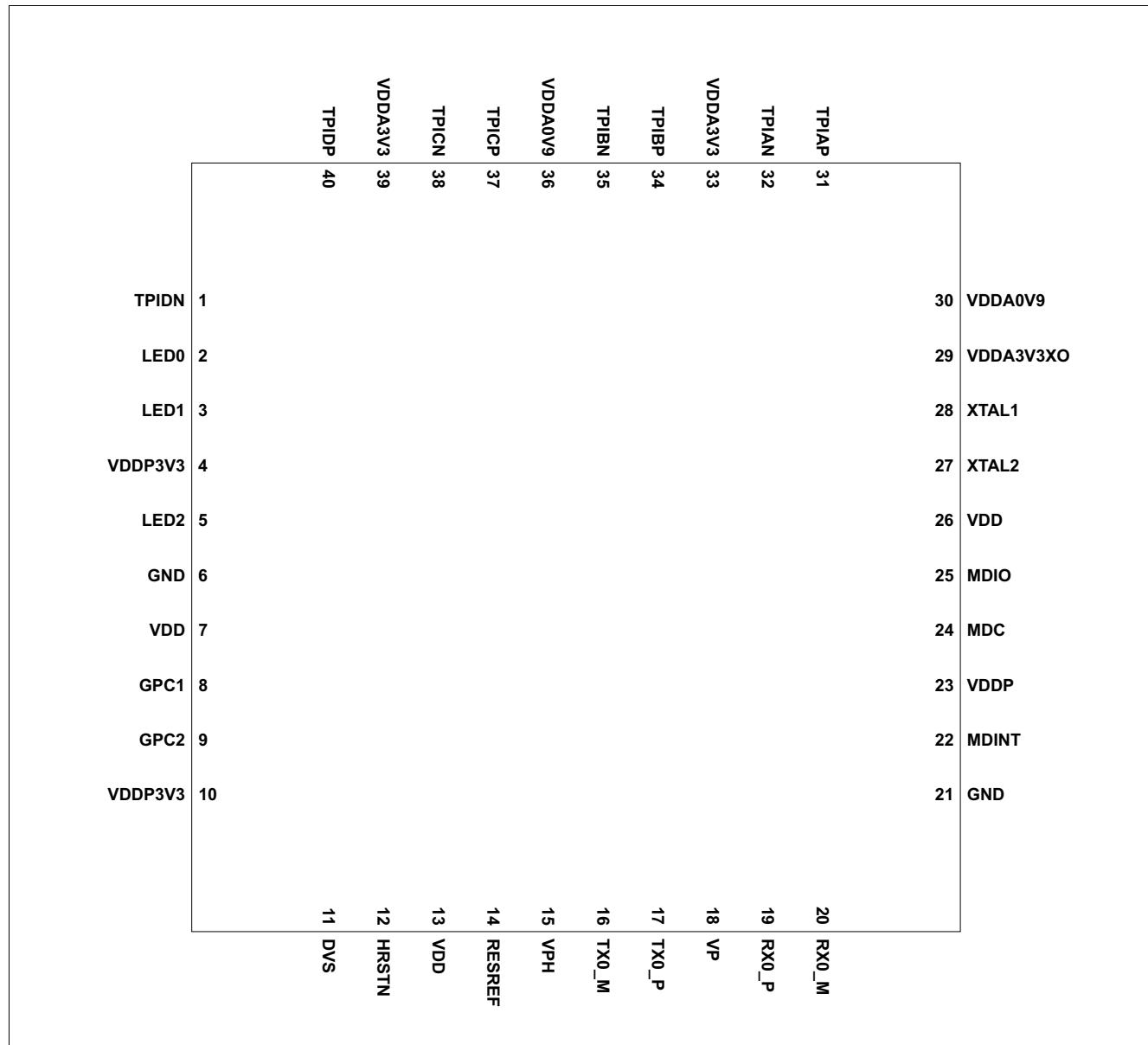


Figure 3 Pin Diagram for PG-VQFN-40 (Top View)

## 2.2.2 Abbreviations

Abbreviations that are used in the signal tables are summarized in [Table 1](#) and [Table 2](#).

**Table 1 Abbreviations for Pin Type**

Abbreviations	Description
I	Input only, digital levels
O	Output only, digital levels
I/O	Bidirectional input/output signal, digital levels
Prg	Bidirectional pad, programmable to operate either as input or output, digital levels
AI	Input only, analog levels
AO	Output only, analog levels
AI/AO	Bidirectional, analog levels
PWR	Power
GND	Ground

**Table 2 Abbreviations for Buffer Type**

Abbreviations	Description
A	Analog characteristics, see the AC/DC specification for more detail
Prg	Programmable (open-drain/push-pull, pull-up/pull-down characteristic are programmable)
PU	Pull up (internal, weak)

## 2.2.3 Input/Output Signals

A detailed description of all the pins is given in [Table 3](#) to [Table 8](#).

In [Table 5](#) to [Table 7](#), the signal names highlighted in **bold** are the same as the pin name and default use case. The signal names that are not in bold indicate alternate functions.

### 2.2.3.1 Ethernet PHY Twisted Pair Interface

**Table 3** Ethernet PHY Twisted Pair Interface Signals

Pin No.	Name	Pin Type	Buffer Type	Function
<b>Ethernet Port Ethernet PHY Twisted Pair Interface</b>				
31	<b>TPIAP</b>	AI/AO	A	<b>Twisted Pair Transmit/Receive Positive/Negative</b>
32	<b>TPIAN</b>	AI/AO	A	
34	<b>TPIBP</b>	AI/AO	A	
35	<b>TPIBN</b>	AI/AO	A	
37	<b>TPICP</b>	AI/AO	A	
38	<b>TPICN</b>	AI/AO	A	
40	<b>TPIDP</b>	AI/AO	A	
1	<b>TPIDN</b>	AI/AO	A	

### 2.2.3.2 SGMII Interface

**Table 4** SGMII Interface Signals

Pin No.	Name	Pin Type	Buffer Type	Function
20	<b>RX0_M</b>	AI	A	<b>Differential SGMII Data Input Pair</b>
19	<b>RX0_P</b>	AI	A	These are the negative and positive signals respectively of the differential input pair of the SGMII SerDes interface. Due to the integrated CDR, no external transmission of source-synchronous clock is required for SGMII. These pins must be AC coupled.
17	<b>TX0_P</b>	AO	A	<b>Differential SGMII Data Output Pair</b>
16	<b>TX0_M</b>	AO	A	These are the negative and positive signals respectively of the differential output pair of the SGMII SerDes interface.
14	<b>RESREF</b>	AI/O	A	<b>Pad to Connect External Tuning Resistor</b>

### 2.2.3.3 LED/GPIO Interface

The LED interface allows external LEDs to be connected to indicate the status of the Ethernet PHY interfaces. Single color LEDs are supported.

**Table 5 LED Interface Signals**

Ball No.	Name	Pin Type	Buffer Type	Function
<b>LED Signals</b>				
2	<b>LED0</b>	O		<b>GPHY LED0</b> LED control output, freely configurable, drives single-color or dual color LEDs. Voltage Domain: 3.3 V
	GPIO0	Prg	Prg	<b>General Purpose IO 0</b> Configurable as input or output. The output characteristic can be selected to be open drain or push-pull. Voltage Domain: 3.3 V
	FW_UTXD	O		<b>Firmware UART Data Output</b> Firmware UART interface data output Voltage Domain: 3.3 V
3	<b>LED1</b>	O		<b>GPHY LED1</b> LED control output, freely configurable, drives single-color LEDs. Voltage Domain: 3.3 V
	GPIO1	Prg	Prg	<b>General Purpose IO 1</b> Configurable as input or output. The output characteristic can be selected to be open drain or push-pull. Voltage Domain: 3.3 V
	FW_URXD	I		<b>Firmware UART Data Input</b> Firmware UART interface data input Voltage Domain: 3.3 V
5	<b>LED2</b>	O		<b>GPHY LED2</b> LED control output, freely configurable, drives single-color LEDs. Voltage Domain: 3.3 V
	GPIO2	Prg	Prg	<b>General Purpose IO 2</b> Configurable as input or output. The output characteristic can be selected to be open drain or push-pull. Voltage Domain: 3.3 V

### 2.2.3.4 Management Interfaces

MDIO management interface in accordance to IEEE 802.3 is provided.

**Table 6 Management Interface Signals**

Ball No.	Name	Pin Type	Buffer Type	Function
<b>MDIO Slave Interface</b>				
22	MDINT	O		<p><b>MDIO Interrupt</b>            The MDINT signal is used to send an interrupt to an external MAC SoC acting as station manager (STA). The STA can program its sensitivity to specific events using the PHY_IMASK register. The MDINT event is then raised when the event occurs using the polarity programmed by pin strap. The STA can read which type of event occurred in the PHY_ISTAT register. Upon read of PHY_ISTAT by the STA, the MDINT is deasserted by the device.            Voltage Domain: 1.8 V / 3.3 V</p>
	GPIO3	Prg	Prg	<p><b>General Purpose IO 3</b>            Configurable as input or output. The output characteristic can be selected to be open drain or push-pull.            Voltage Domain: 1.8 V / 3.3 V</p>
	EXINT1	Prg	Prg	<p><b>External Interrupt 1</b>            It can be selected as input or output mode. The output characteristic can be selected to be open drain or push-pull.            Voltage Domain: 1.8 V / 3.3 V</p>
24	MDC	I		<p><b>MDIO Slave Clock</b>            The external controller host (also called “STA” in IEEE standard) acts as clock master and provides the serial clock of up to 25 MHz on this input.            Voltage Domain: 1.8 V / 3.3 V</p>
	GPIO4	Prg	Prg	<p><b>General Purpose IO 4</b>            Configurable as input or output. The output characteristic can be selected to be open drain or push-pull.            Voltage Domain: 1.8 V / 3.3 V</p>
25	MDIO	I/O		<p><b>MDIO Slave Data Input/Output</b>            The external controller host (also called “STA” in IEEE standard) uses this signal to address internal registers and to transfer data to and from the internal registers.            Voltage Domain: 1.8 V / 3.3 V</p>
	GPIO5	Prg	Prg	<p><b>General Purpose IO 5</b>            Configurable as input or output. The output characteristic can be selected to be open drain or push-pull.            Voltage Domain: 1.8 V / 3.3 V</p>

## 2.2.3.5 Miscellaneous Signals

Table 7 Miscellaneous Signals

Ball No.	Name	Pin Type	Buffer Type	Function
<b>Reset and Clocking</b>				
28	XTAL1	AI	A	<b>Crystal: Oscillator Input</b> A crystal must be connected between XTAL1 and XTAL2. Additional load capacitances must also tie both pins to GND.
	CLK	AI	A	<b>Crystal Oscillator: Clock Input</b> A clock must be connected to CLK. Clock details are provided in <a href="#">Table 35</a> .
27	XTAL2	AO	A	<b>Crystal: Oscillator Output</b> A crystal must be connected between XTAL1 and XTAL2. Additional load capacitances must also tie both pins to GND.
12	HRSTN	I	PU	<b>Hardware Reset</b> Asynchronous active low device reset Voltage Domain: 3.3 V
11	DVS	O		<b>DVS</b> Do not connect. Voltage Domain: 3.3 V
	GPIO8	Prg	Prg	<b>General Purpose IO 8</b> Configurable as input or output. The output characteristic can be selected to be open drain or push-pull. Voltage Domain: 3.3 V
21	GND	I		<b>GND</b> This pin must be tied to Ground.
8	GPC1	Prg		<b>General Purpose Clock 1</b> General purpose clock. Either input or output mode can be selected. Voltage Domain: 3.3 V
	GPIO6	Prg	Prg	<b>General Purpose IO 6</b> Configurable as input or output. The output characteristic can be selected to be open drain or push-pull. Voltage Domain: 3.3 V
	EXINT0	Prg	Prg	<b>External Interrupt 0</b> It can be selected as input or output mode. The output characteristic can be selected to be open drain or push-pull. Voltage Domain: 3.3 V

**Table 7** Miscellaneous Signals (cont'd)

Ball No.	Name	Pin Type	Buffer Type	Function
9	<b>GPC2</b>	Prg		<b>General Purpose Clock 2</b> General purpose clock. Either input or output mode can be selected. Voltage Domain: 3.3 V
	<b>GPIO7</b>	Prg	Prg	<b>General Purpose IO 7</b> Configurable as input or output. The output characteristic can be selected to be open drain or push-pull. Voltage Domain: 3.3 V

### 2.2.3.6 Power Supply

This section specifies the power supply pins. They are categorized in 2 supply groups  $V_{HIGH}$  (3.3 V) and  $V_{LOW}$  (0.97 V).

**Table 8** Power Supply Pins

Ball No.	Name	Pin Type	Buffer Type	Function
33, 39	<b>VDDA3V3</b>	PWR		<b>High Voltage Domain Supply <math>V_{HIGH}</math></b> These are the input power pins for the analog front end in the high voltage domain. They have to be supplied with a nominal voltage of 3.3 V.
30, 36	<b>VDDA0V9</b>	PWR		<b>Low Voltage Domain Supply <math>V_{LOW}</math></b> These are the input power supply pins for the low voltage domain. They supply mixed signal blocks in the analog front end and the clock distribution block of the Gigabit Ethernet PHY. These pins have to be supplied with a nominal voltage of 0.97 V.
29	<b>VDDA3V3XO</b>	PWR		<b>XO Pad Voltage Domain Supply <math>V_{HIGH}</math></b> This is the supply pin for the internal PLL and the internal crystal oscillator (XO). This pin has to be supplied with a nominal voltage of 3.3 V.
18	<b>VP</b>	PWR		<b>SGMII Low Voltage Domain Supply <math>V_{LOW}</math></b> This is the pin for the low voltage domain of the SGMII interface. It supplies mixed signal blocks in the SGMII interface. This pin has to be supplied with a nominal voltage of 0.97 V.
15	<b>VPH</b>	PWR		<b>SGMII High Voltage Domain Supply <math>V_{HIGH}</math></b> This is the pin for the high voltage domain of the SGMII interface. It supplies mixed signal blocks in the PHY of the SGMII interface. This pin has to be supplied with a nominal voltage of 3.3 V.
23	<b>VDDP</b>	PWR		<b>Configurable MDIO Pad Voltage Domain Supply</b> This is the supply pin for the MDIO pad voltage, which is relevant for pin 22, pin 24 and pin 25. This group can operate with 1.8 V or 3.3 V. When operating with 1.8 V, this pin has to be supplied with a nominal voltage of 1.8 V. When operating with 3.3 V, this pin has to be supplied with a nominal voltage of 3.3 V.

**Table 8 Power Supply Pins (cont'd)**

Ball No.	Name	Pin Type	Buffer Type	Function
4, 10	<b>VDDP3V3</b>	PWR		<b>Pad Voltage Domain Supply <math>V_{HIGH}</math></b> This is the group of supply pins for the pad supply of GPIO pins (except the MDIO group of pin which is supplied by VDDP) This pin has to be supplied with a nominal voltage of 3.3 V.
7, 13, 26	<b>VDD</b>	PWR		<b>Core Voltage Domain Supply <math>V_{LOW}</math></b> This is the group of supply pins for the core digital voltage domain. These pins have to be supplied with a nominal voltage of 0.97 V.
6	<b>GND</b>	PWR		<b>Ground</b> This pin must be tied to Ground.

**Table 9 Device Ground**

Pin No.	Name	Pin Type	Buffer Type	Function
EPAD <sup>1)</sup>	VSS	GND		General Device Ground

1) The EPAD is the exposed pad on the bottom of the package. This pad must be properly connected to the ground plane of the PCB.

## 3 Functional Description

### 3.1 Power Supply, Clock and Reset

This chapter provides the information required to power up the MxL86112C.

#### 3.1.1 Power Supply

Two external power supplies of 3.3 V and 0.97 V are required.

#### 3.1.2 Clock Generation

An external 25 MHz crystal must be connected to the MxL86112C. The required crystal specification is documented in [Chapter 7.7.6](#). An internal PLL circuit generates all the required internal clocks.

#### 3.1.3 Reset Generation

The external hardware reset input (HRSTN pin) resets all the hardware modules:

- Driving the HRSTN pin low causes an asynchronous reset of the MxL86112C system.
- Releasing the HRSTN pin high triggers the power-on sequence and boot-up procedure.

The HRSTN pin is internally connected to a weak internal pull-up resistor.

#### 3.1.4 Power-On Sequence

The MxL86112C powers on when the power is applied as shown in [Figure 16](#) and [Figure 17](#). The following steps are executed at power on:

- Locking of internal PLL.
- Reading of pin strap information, as described in [Chapter 3.1.5](#).
- Booting of the microprocessor from internal ROM.
- Auto-negotiation on the Ethernet twisted pair interface and SGMII interface using the speed capability of 1 Gbit/s full-duplex.
- Training and link up in accordance with the IEEE 802.3 [\[1\]](#) and SGMII [\[2\]](#) standards.

#### 3.1.5 Configuration by Pin Strapping

The MxL86112C device can be configured by means of pin strapping on a number of the GPIO pins. The pin strapping configurations are captured during the chip power-on sequence, until the reset initialization is complete.

The pin strap values can be set to logical high or low by connecting the corresponding pin via an external 1 kΩ resistor to either ground or 3.3 V.

The pin strap mapping is described in [Table 10](#) and [Table 11](#).

**Table 10** Pin Names used for Pin Strapping

Pin Name	Pin Number	Configuration Item Description	Internal Pull-up/down
GPC1	8	PS_PHY_MADDR(0)	Pull-up
GPC2	9	PS_PHY_MADDR(1)	Pull-up
LED1	3	PS_PHY_MADDR(2) and PS_LED1_MODE	No
LED0	2	PS_SUPER_ISOLATE and PS_LED0_MODE	No
MDINT	22	PS_MDINT_POL	Pull-up
LED2	5	PS_RJ45_TAB and PS_LED2_MODE	No

**Table 11** Pin Strapping Configuration Description

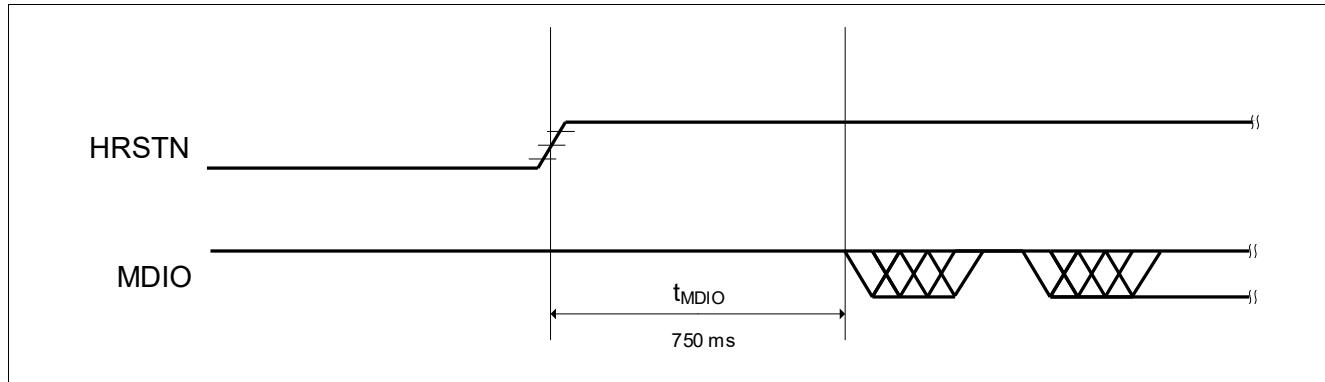
Pin Strapping Signals	Description
PS_PHY_MADDR(2:0)	<b>MDIO PHY Address</b> These values are used to specify the three least significant bits of the MDIO PHY Address. A high level means a logical 1 and low level means a logical 0. The two most significant bits of the 5-bit address are fixed at 0.
PS_MDINT_POL	<b>MDIO Interrupt (MDINT) Polarity</b> 0 <sub>B</sub> <b>HIGH</b> MDIO Interrupt (MDINT) is active high 1 <sub>B</sub> <b>LOW</b> MDIO Interrupt (MDINT) is active low
PS_LEDx_MODE	<b>LED Mode</b> This is to specify the LED mode per LED. PS_LED0_MODE follows the pin strapping setting of PS_SUPER_ISOLATE. PS_LED1_MODE follows the pin strapping setting of PS_PHY_MADDR(2). PS_LED2_MODE follows the pin strapping setting of PS_RJ45_TAB. 0 <sub>B</sub> <b>GROUND</b> Ground mode 1 <sub>B</sub> <b>POWER</b> Power mode
PS_RJ45_TAB	<b>RJ45 Pin Reversal</b> 0 <sub>B</sub> <b>DOWN</b> Tab down 1 <sub>B</sub> <b>UP</b> Tab up
PS_SUPER_ISOLATE	<b>Super Isolate</b> This is to specify whether the PHY is immediately active after a reset or it is halted until it is activated manually. 1 <sub>B</sub> <b>NORMAL</b> The PHY is active after reset 0 <sub>B</sub> <b>HALT</b> The PHY is inactive after reset

An alternative way to configure the MxL86112C after the boot process is to use the MDIO interface and write into various control registers, as detailed in [Chapter 3.2](#).

### 3.2 Configuration via MDIO Management Interface

The external controller (Station Management, STA) can be connected to the chip's slave MDIO interface. This allows access to the MDIO and MMD registers standardized in IEEE 802.3. Thus the STA can control chip configuration and retrieve status information. The MDIO transactions can be of any of the 3 types described in IEEE 802.3 Clause 22, Clause 22 Extended, and Clause 45 [1]. The list of MDIO registers is given in [Chapter 4](#).

[Figure 4](#) shows the minimum time required for the MDIO to be available for access.



**Figure 4** MDIO Access Timing

#### 3.2.1 MDIO Interface Voltage

The MDIO interface supports a voltage level of 3.3 V or 1.8 V. A voltage level of 3.3 V is supported by default. To operate this interface at a voltage level of 1.8 V, complete this procedure:

1. Supply the **VDDP** pin with 1.8 V.
2. Wait for MDIO interface to be available after the minimum time required as shown in [Figure 4](#).
3. Write 1 to the **MDIO\_VOL** bit of the **VSPEC1\_PM\_CTRL** register using the MDIO interface at a voltage level of 1.8 V.

After the configuration, both read and write operations are supported on the MDIO interface. See [Section 7.7.4](#) for the maximum MDIO clock frequency supported at 1.8 V voltage level.

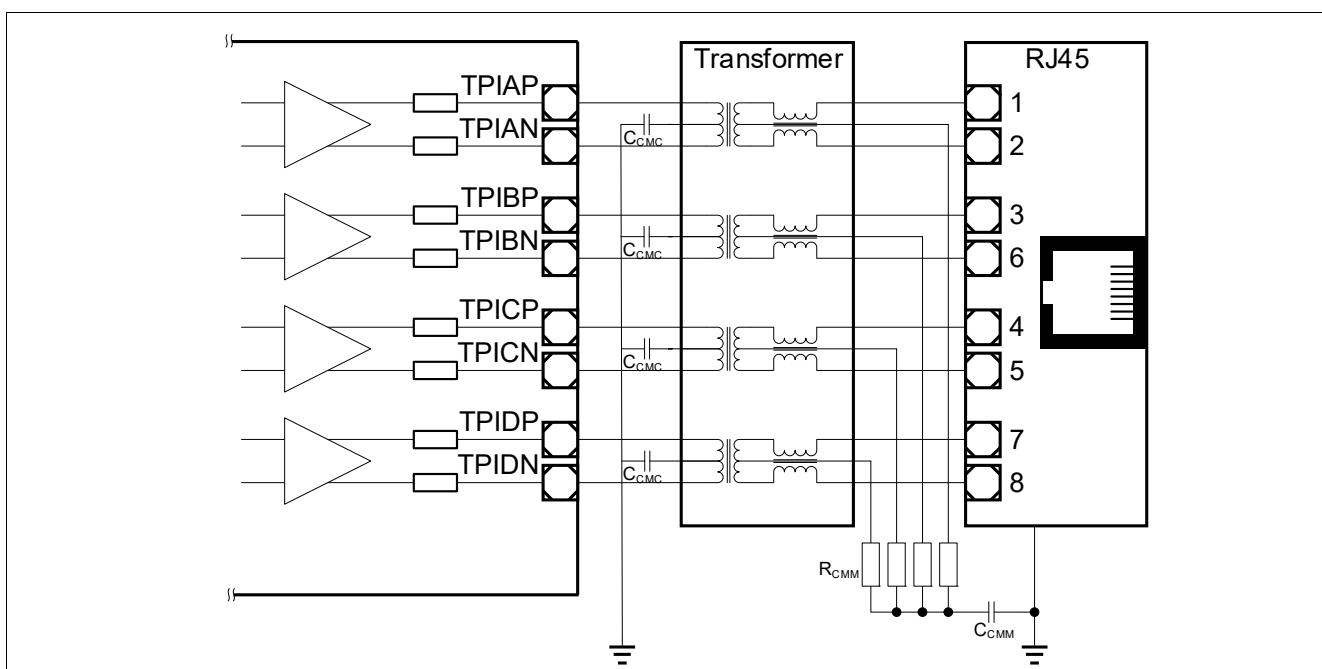
### 3.3 Ethernet PHY Interface

The Ethernet PHY implements the physical layer of the Ethernet standard. It supports digital signal processing (DSP) and analog signal processing (ASP) functions, to transmit data over the twisted pair cable.

#### 3.3.1 Twisted Pair Interface

The Twisted Pair Interface (TPI) of the MxL86112C is fully compliant with IEEE 802.3. To facilitate low power implementation and reduce PCB costs, the series resistors required to terminate the twisted pair link with a nominal  $100\ \Omega$  are integrated in the device.

As a consequence, the TPI pins can be connected directly via a transformer to the RJ45 plug. Additional external circuitry is required for common-mode termination and rejection. A schematic of the TPI circuitry taking these components into account is shown in [Figure 5](#). Refer to [Section 7.8.1](#) for details.



**Figure 5** Twisted-Pair Interface of MxL86112C Including Transformer and RJ45 Plug

#### 3.3.2 Transformerless Ethernet

Transformerless Ethernet (TLE) is required for backplane applications where the use of a transformer is not necessarily required to fulfill the galvanic decoupling requirements of the isolation specifications. In such applications, removing the transformer reduces both the external bill of material and the space requirements on the PCB.

As the MxL86112C incorporates a voltage-mode line driver, the only stringent requirement is to use AC coupling. AC coupling can be achieved using simple SMD type series capacitors. The value of the capacitors is selected so that the high-pass characteristics correspond to an equivalent standard transformer based application (recommended  $C_{coupling} = 100\ nF$ ). [Figure 6](#) shows the external circuitry for TLE.

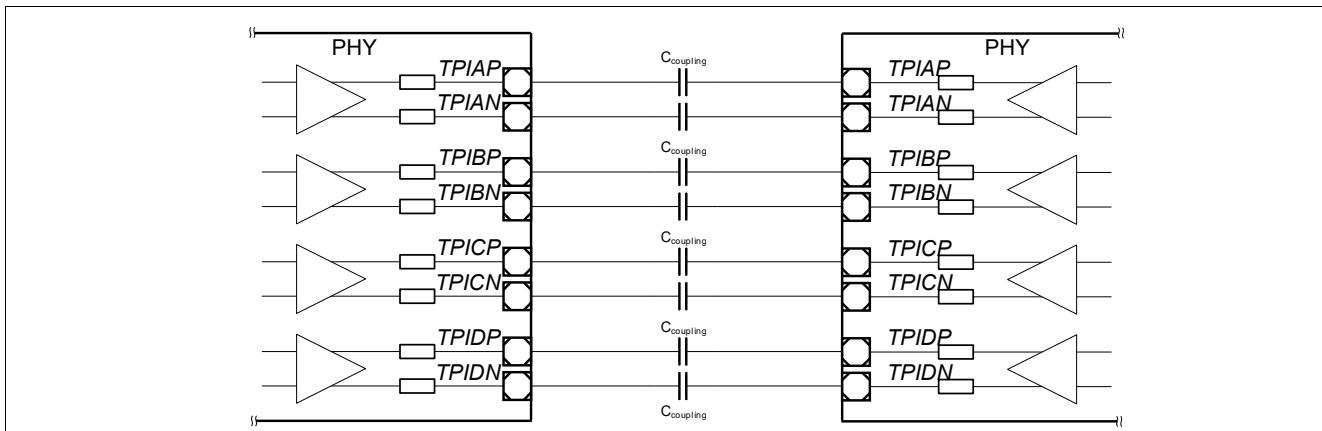


Figure 6 External Circuitry for the Transformerless Ethernet Application

### 3.3.3 Auto-negotiation

The MxL86112C supports auto-negotiation (ANEG) a part of the startup procedure to exchange capability information with the link partner. ANEG is enabled at MxL86112C initialization and its 1 Gbit/s speed capability is advertised.

The ANEG procedure is executed according to IEEE 802.3 Clause 28 and Clause 40 [1].

If the link partner does not support ANEG, the MxL86112C extracts the link speed configuration using parallel detection as described in Clause 28.

A STA connected to the MDIO interface can reprogram the MxL86112C advertised capability if required. It can also disable ANEG, in which case the system configuration must ensure compatibility between link partners to link up in a compatible mode.

**Attention:** *STD\_CTRL.DPLX takes effect only when the auto-negotiation process is disabled and the GPY TPI is not operating in loop-back mode, that is, bits STD\_CTRL.ANEN and STD\_CTRL.LB are set to zero. Forced Half Duplex mode (STD\_CTRL.DPLX = 0b0) is supported only in 10BT and 100BT speed modes. This field is ignored for higher speeds.*

### 3.3.4 Auto-downspeed

The auto-downspeed (ADS) feature implements a process to decrease the operating speed of the link when the link quality or cable is insufficient. The feature ensures maximum interoperability even in harsh or inadequate cable infrastructure environments. In particular, ADS is applied during the 1000BASE-T training phase. The downspeed is necessary when the cable quality or characteristics are inadequate. For example, it is possible to advertise 1000BASE-T during ANEG when both link partners are connected via a cable that does not support the 4-pair Gigabit Ethernet mode.

The MxL86112C detects such configurations to avoid repeating link up failures and clears Gigabit capability in the ANEG advertisement registers. After the resulting link down, the next ANEG procedure no longer advertises 1000BASE-T. The next link up is done at the next advertised speed below 1000 Mbit/s.

The MxL86112C also executes an ADS procedure when the signal quality is not suited to a 1000BASE-T link up due to increased alien noise or over long cables.

When the MxL86112C is configured to advertise no speed capability below 1000 Mbit/s, the ADS feature is disabled automatically.

### 3.3.5 Polarity Reversal Correction

For each of the 4 pairs, the MxL86112C automatically detects and corrects any inversion of the signal polarity on the P and N signals. The detection is done during the auto-negotiation phase. The detected polarity is frozen once the link has been established, and remains unchanged until the link is dropped.

The polarity corrections applied are indicated in the following register: PMA\_MGBT\_POLARITY (register 1.130) and are valid when auto-negotiation is complete.

### 3.3.6 Auto-Crossover Correction

To maximize interoperability, even in inadequate wiring environments, the MxL86112C automatically performs cable crossover (MDI-X). The supported pair-mappings detectable and correctable by the device are listed in **Table 12**.

The purpose is to compensate for any non-standard (ANSI TIA/EIA-568-A:1995) cabling, as well as both straight-through and crossover cable connections: the MxL86112C automatically detects and corrects any crossed cable configuration (transmit-receive pairing between partners does not match). The auto-crossover function is fully compliant with IEEE 802.3, Clause 40.4.4 [1], in 1000BASE-T mode.

The corrections applied are indicated in the following register: PMA\_MGBT\_POLARITY (register 1.130) and are valid when auto-negotiation is complete.

**Table 12 Supported Twisted Pair Mappings on a CAT5 or Better Cable**

Crossover Modes on RJ45 <sup>1)</sup>		RJ45 Pinning							
Mode	Description	1	2	3	4	5	6	7	8
11	Straight cable, standard compliant	TPIAP (A+)	TPIAN (A-)	TPIBP (B+)	TPICP (C+)	TPICN (C-)	TPIBN (B-)	TPIDP (D+)	TPIDN (D-)
00	Full Gigabit Ethernet MDI-X This is the standard compliant MDI-X with pair A-B swapped and pair C-D swapped	TPIBP (B+)	TPIBN (B-)	TPIAP (A+)	TPIDP (D+)	TPIDN (D-)	TPIAN (A-)	TPICP (C+)	TPICN (C-)

1) Pin assignment according to TIA/EIA-568-A/B

### 3.3.7 RJ45 Tab Up or Tab Down Configuration

The RJ45 plug on the system PCB can be soldered with the tab up or down as illustrated in [Figure 7](#).

The difference between tab up and tab down is a swap in position between A and D. The pin strap PS\_RJ45\_TAB allows the system designer to perform this configuration. As a result, a PCB layout does not need to be modified when a RJ45 tab up or down socket needs to be mounted.

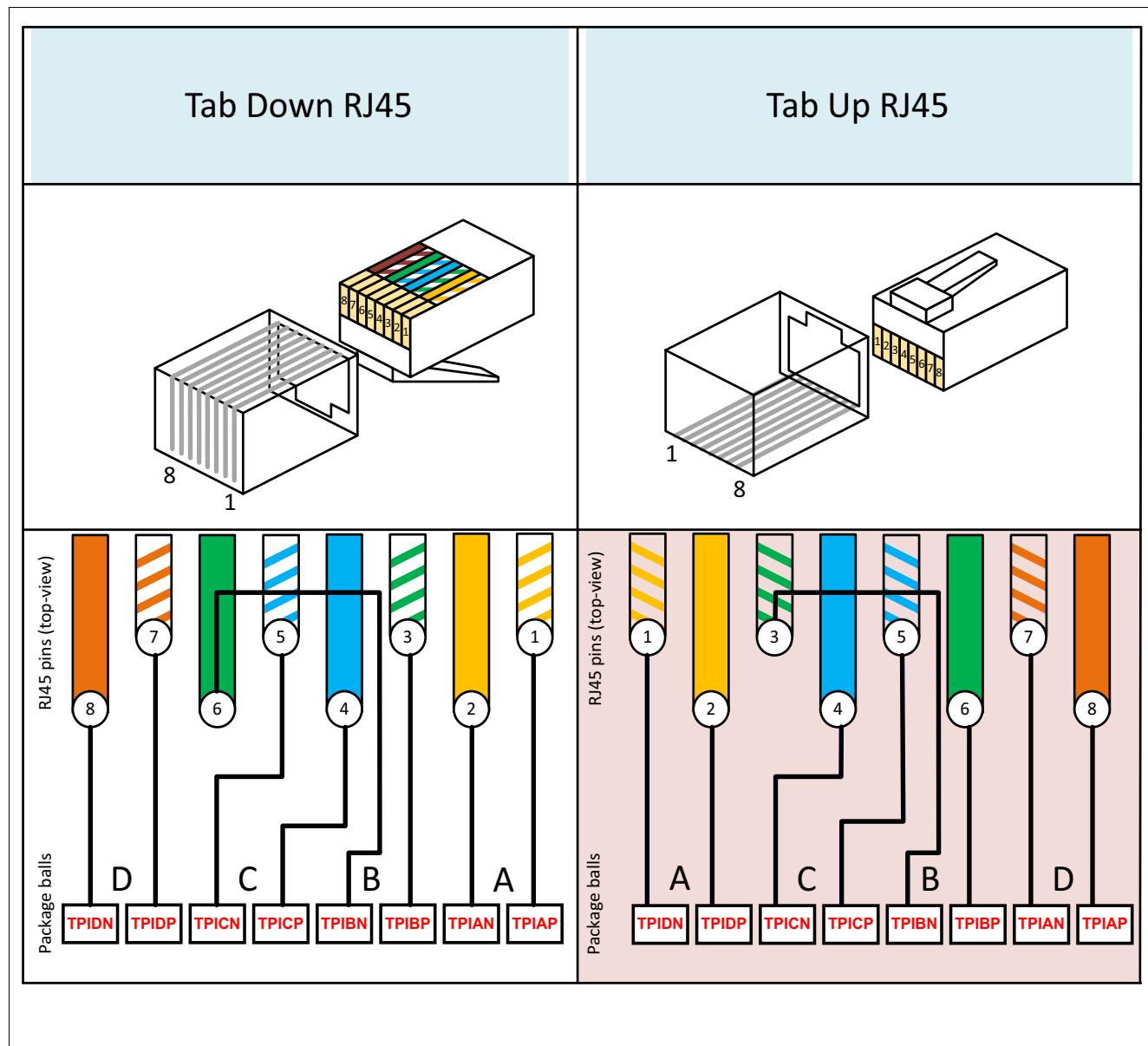
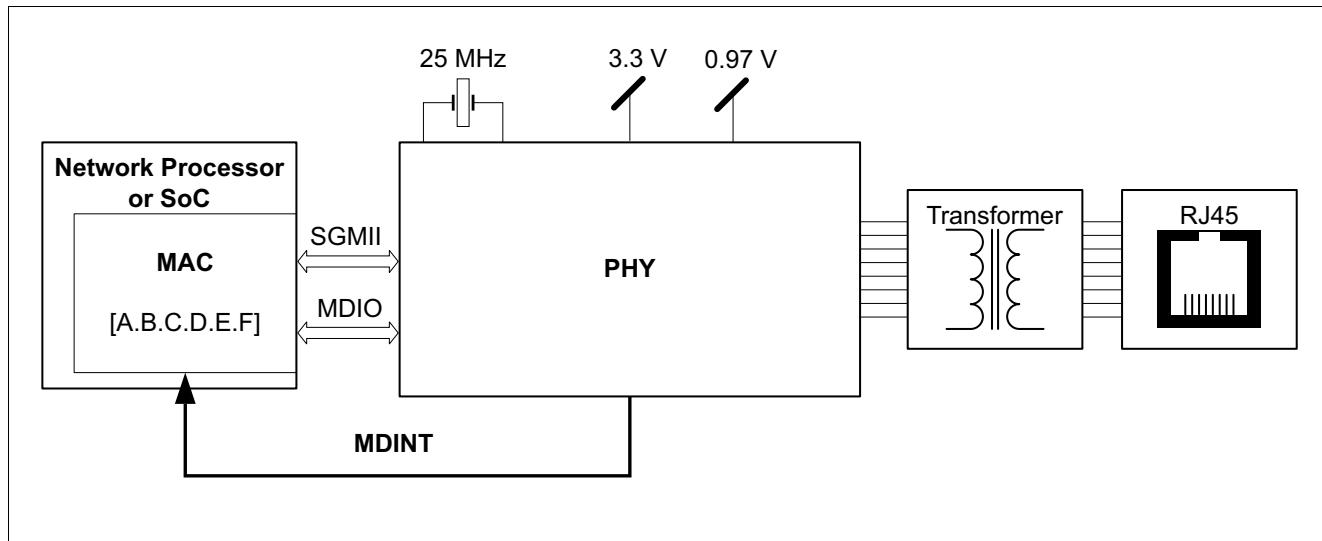


Figure 7 RJ45 Tab Up or Tab Down Configuration

### 3.3.8 Wake-on-LAN

The MxL86112C supports Wake-on-LAN. It generates an interrupt to an external controller when it detects special WoL Ethernet packets. This allows the controller to enter sleep mode if there is no Ethernet traffic to process, and be woken up when traffic starts. WoL packets are detected for all link speeds. This scenario is shown in [Figure 8](#).



**Figure 8 Block Diagram of WoL Application**

The most commonly used WoL packet is called a magic packet. A magic packet contains the MAC address of the device to be woken up as well as, optionally, a password called SecureON. The MAC address and the optional SecureON password relevant for the WoL logic inside the MxL86112C can be configured in the WOL MDIO registers in "Vendor Specific 2" VSPEC2 MMD device described in [Chapter 4](#). When such a configured magic packet is received by the MxL86112C, an MDINT interrupt is issued.

An example programming sequence for these configuration registers is given in [Table 13](#).

**Table 13 Programming Sequence for the Wake-on-LAN Functionality**

Step	Register Access	Remark
1	$\text{MDIO.MMD.WOLAD01} = \text{EEFF}_H$	Program the fifth and sixth MAC address bytes
2	$\text{MDIO.MMD.WOLAD23} = \text{CCDD}_H$	Program the third and fourth MAC address bytes
3	$\text{MDIO.MMD.WOLAD45} = \text{AABB}_H$	Program the first and second MAC address bytes
4	$\text{MDIO.MMD.WOLPW01} = \text{4455}_H$	Program the fifth and sixth SecureON password bytes
5	$\text{MDIO.MMD.WOLPW23} = \text{2233}_H$	Program the third and fourth SecureON password bytes
6	$\text{MDIO.MMD.WOLPW45} = \text{0011}_H$	Program the first and second SecureON password bytes
7	$\text{MDIO.PHY.IMASK.WOL} = 1_B$	Enable the Wake-on-LAN interrupt mask
8	$\text{MDIO.MMD.WOLCTRL.WOL.EN} = 1_B$	Enable Wake-on-LAN functionality

### 3.4 SGMII Interface

The MxL86112C implements a serial data interface, called SGMII or SerDes, to connect to another chip implementing the MAC layer (MAC SoC). The data rates supported by the SGMII interface are the same as for the TPI (10 Mbit/s, 100 Mbit/s, or 1 Gbit/s). These rates correspond to baud rates of 1.25 Gbaud (for 10/100/1000 Mbit/s using data repetition).

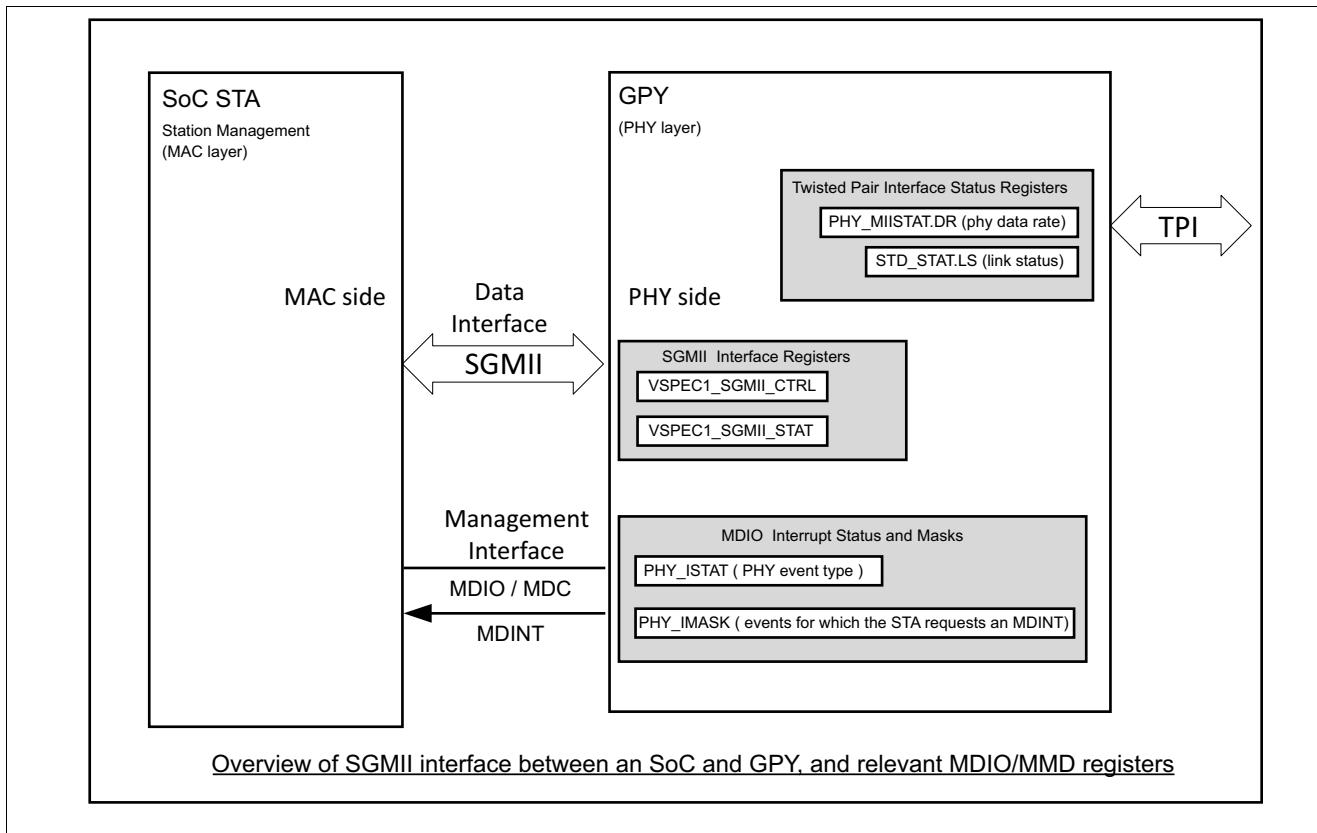
#### 3.4.1 SGMII Control and Status Registers

The MxL86112C API describing the driver software executed on the MAC SoC must be followed to configure the SGMII interface.

The MAC SoC can use MDIO registers to retrieve the MxL86112C TPI and SGMII status.

The API controls the SGMII interface using 2 MDIO registers described, as shown in [Figure 9](#):

- VSPEC1\_SGMII\_CTRL is used to enable and configure the SGMII auto-negotiation or force a link configuration. Programming this register is optional as the SGMII interface comes up in a default configuration after reset that does not need any additional control from the STA. The STA can also control the SGMII reset, SGMII powerdown or SGMII loop back using this register. Until SGMII is in powerdown (VSPEC1\_SGMII\_CTRL.PD = 1) state, programming to other bits on VSPEC1\_SGMII\_CTRL register is ignored.
- VSPEC1\_SGMII\_STAT is a read-only register that can be used by the STA to retrieve the SGMII link status, data rate and auto-negotiation completion status.



#### Operating Procedure

SoC is responsible for monitoring PHY\_ISTAT events, TPI data rate and link status:

LSTC: PHY link status change with new status indicated in STD\_STAT.LS

LSPC: PHY link speed change with new TPI speed indicated in PHY\_MIISTAT.DR

The GPY PHY side SGMII is set up by the GPY at the same speed as the TPI link.

The MAC SoC is responsible for programming the MAC side SGMII at the matching speed.

#### PHY\_ISTAT event fields in PHY\_ISTAT MDIO register:

- LSTC: Link state change
- LSPC: Link speed change
- DXMC: Duplex mode change
- MDIXC: MDIX change, polarity change
- ADSC: Auto-downspeed event
- TEMP: PVT Sensor Event
- LP: Low Power Event
- LOR: Sync E loss of reference
- ANCE: ANEG complete or ANEG Error
- NPRX/NPTX: ANEG Next Page RX or TX
- MSRE: Master Slave Resolution Error
- WOL: Wake-on-LAN event

Figure 9 MxL86112C SGMII Configuration and Status Registers

### 3.4.2 SGMII Configuration at Power Up

The MxL86112C SGMII interface is configured to operate automatically after reset. The STA does not have to change the register VSPEC1\_SGMII\_CTRL to operate in this default mode:

- SGMII auto-negotiation is enabled
- The TPI configuration after link up defines the SGMII PHY side configuration. The MAC side SoC must configure its SGMII MAC side interface to match the MxL86112C PHY side configuration, as explained in [Chapter 3.4.3](#) and [Chapter 3.4.4](#)

### 3.4.3 SGMII PHY Side Setup According to TPI Setup

The MxL86112C PHY side SGMII is set up by the MxL86112C at the same speed as the twisted pair interface (TPI) link.

When a link status changes on the TPI (up/down and speed change), the MxL86112C reconfigures its SGMII automatically.

### 3.4.4 SGMII MAC Side Setup by MAC SoC

The MAC SoC (STA) is responsible for monitoring the PHY\_STAT events, which indicate TPI data rate and link status. The MAC SoC can monitor link status or link speed changes using the following three possible methods:

- Using the MDIO interface MDINT interrupt and reading the associated event
- Using the MDIO interface polling (reading) of the link status register STD\_STAT.LS
- Using the restart of the SGMII ANEG which conveys the new link parameters. In this case, the SGMII Cisco ANEG must be enabled after power up.

In all three cases:

- The MxL86112C reconfigures the PHY side SGMII to match the TPI setup
- The MAC SoC must set up the MAC side SGMII to match the PHY side SGMII

### 3.4.5 SGMII Link Monitoring by MAC SoC

The MxL86112C indicates its interface status using the following registers, as indicated in [Figure 9](#):

- MDIO register PHY\_MIISTAT to indicate the TPI status
- MDIO register SGMII\_STAT to indicate the SGMII status

A change of status on the TPI can be indicated by the MDIO interrupt MDINT. MDINT is generated if the STA has programmed the event mask in the PHY\_IMASK register corresponding to any of the following events occurring on the TPI:

- LSTC: Link state change
- LSPC: Link speed change
- DXMC: Duplex mode change
- MDIXC: MDIX change, polarity
- ADSC: Auto-downspeed event
- TEMP: PVT Sensor Event
- LP: Low Power Event
- LOR: Sync E loss of reference
- ANCE: ANEG complete or ANEG error
- NPRX/NPTX: ANEG next page RX or TX
- MSRE: Master Slave Resolution Error
- WOL: Wake-on-LAN

The MDINT signal is deasserted by the MxL86112C when the MAC SoC STA performs a READ access to the MDIO register PHY\_ISTAT.

The events relevant to the TPI status that are useful for monitoring SGMII are LSTC and LSPC.

#### 3.4.5.1 Actions on TPI Link Down / Link Up Status Change

The MxL86112C does not systematically bring the SGMII link down when the TPI link is down.

The STA can read the status on each side (SGMII and TPI) and make the appropriate decision about the SGMII link down.

For example, if the TPI status is in link down for too long, the STA can take the decision to also power down the SGMII.

#### 3.4.5.2 New TPI Link Up at Same Speed

The following scenario describes a transition on TPI that does not require any restart or change of mode on SGMII:

- SGMII is set to a specific speed and SGMII link is up
- TPI goes to link down – and link up
- When TPI is down, the SGMII side is transmitting Idle packets
- TPI links up at the same speed as before

In these cases, the MxL86112C does not reprogram the PHY side SGMII.

#### 3.4.5.3 Change of Speed After a New Link Up on TPI

The following scenario describes a transition on TPI that requires a change of mode on SGMII:

As a PHY side SGMII controller, the MxL86112C enforces the speed on the MAC side SGMII.

For a change in TPI speed within the [10/100/1000 Mbit/s] rate subset, there is no change in baud speed on SGMII:

- New TPI configuration is reflected in the MDIO status registers and the MDINT interrupt is triggered to indicate the change as explained in [Chapter 3.4.5](#).
- MxL86112C programs its SGMII to the new speed. In particular, for speeds 10 and 100 Mbit/s, the MxL86112C SGMII PCS performs data repetition by 100x and 10 x respectively.

---

Functional Description

- SGMII lane clock remains unchanged at 1.25 Gbaud clock speed.
- If Cisco ANEG is enabled, the MxL86112C conveys the changed speed parameters by restarting SGMII ANEG.
- If Cisco ANEG is disabled, the MxL86112C changes the SGMII configuration immediately and expects the MAC SoC to monitor the link change and match the same configuration.

### 3.4.6 Auto-negotiation Modes Supported by SGMII

Two modes are supported for the SGMII auto-negotiation protocol:

- Cisco Serial-GMII Specification 1.8 [\[2\]](#)
- 1000BX IEEE 802.3 following IEEE Clause 37 [\[1\]](#)

The information exchange mechanism of ANEG is the same in both modes, but the parameters communicated are slightly different. The 1000BX scheme allows for some parameters to be aligned with the highest common capability between the two sides of the SerDes. The Cisco SGMII scheme uses the protocol to communicate the configuration requested by the PHY side SGMII to the MAC side SGMII (e.g. speed request); it is a one-way request.

The parameters communicated by the Cisco ANEG protocol [\[2\]](#) from SGMII-PHY to SGMII-MAC are:

- Link Up or Link Down indication (reflects the TPI status)
- Half Duplex or Full Duplex mode
- Data rate (standard only supports 10 Mbit/s to 1000 Mbit/s)
- EEE capability support
- EEE Clock Stop capability support

The parameters exchanged by the 1000BX ANEG protocol [\[1\]](#) are:

- Remote fault
- Pause support and mode (symmetrical or asymmetrical)
- Half Duplex or Full Duplex

The Cisco ANEG protocol is recommended for a standard application.

#### 3.4.6.1 Enabling SGMII Auto-negotiation Mode

SGMII auto-negotiation is ON at power up. ANEG can be enabled/disabled by setting register field VSPEC1\_SGMII\_CTRL.ANEN. In the default case:

- MxL86112C PHY side SGMII is configured by MxL86112C to match the TPI link configuration.
- MxL86112C uses ANEG to convey the new link parameters to the MAC SoC.
- MAC SoC MAC side SGMII must be configured by the MAC SoC to match the MxL86112C PHY side SGMII configuration.

### 3.5 LED Interface

#### 3.5.1 LED

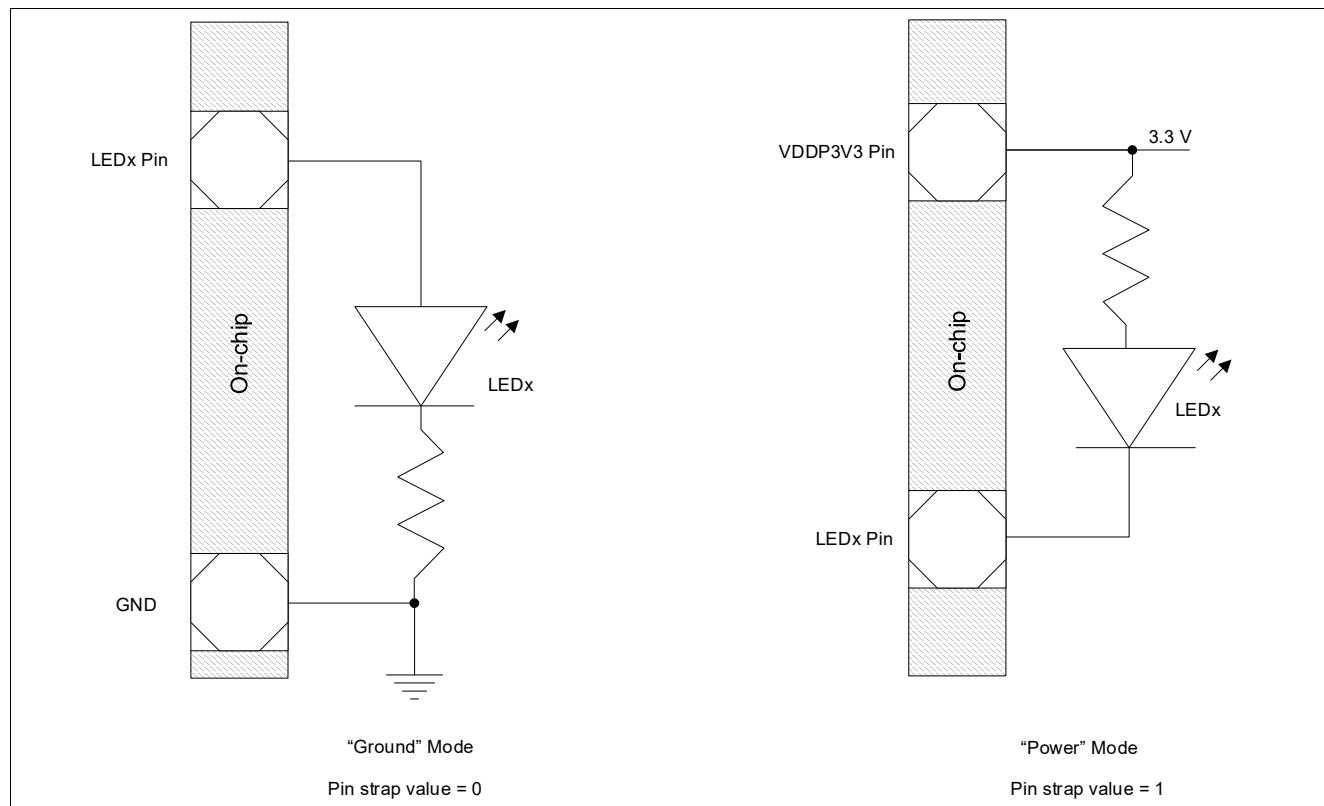
The MxL86112C allows 3 LEDs to be used for visual status indication. Each pin can drive a single color LED.

#### 3.5.2 LED Configuration

The MxL86112C API describing the driver software executed on the MAC SoC must be followed to configure this interface.

The external LED can be connected to either the ground or to power as shown in [Figure 10](#). The LEDx pin represents one of the available LED interface pins at the device. The GND signal represents the common ground EPAD. The pin strap value of the LEDx pin depends on the mode of the LED, as shown in [Figure 10](#).

*Note: This figure does not show the full recommended circuits with all the necessary components. Refer to the relevant HDK/EVK PCB design documentation for more details.*



**Figure 10** LED Connection Options to Ground or Power Supply

### 3.5.3 LED Brightness Control

There are two LED brightness modes configurable by the GPY API, based on the system requirement.

- LED Brightness Level Max Mode  
Fixed level signal (no pulses) for maximum brightness which can also be used as control signal for other purposes.
- LED Brightness Level Control Mode (Constant Mode)  
Allows the configuration of 16 levels of LED brightness as described in [Brightness Control](#).

#### Brightness Control

This block controls the brightness of the LED by way of controlling the time duration the LED is ON/OFF, and due to persistence of the eye, LED brightness will be perceived. When LED is off, the output is disabled. When LED is on, the output is enabled. Brightness control controls the LED output enable directly.

As shown in [Figure 11](#), brightness control frequency is 81.25 Hz. Each period is divided into 64 slots.

When LED brightness control is disabled, LED is enabled in all 64 slots.

When LED brightness control is enabled, LED is enabled for consecutive n slots. n is determined by brightness level configured. LED output is disabled in the 64th slot.

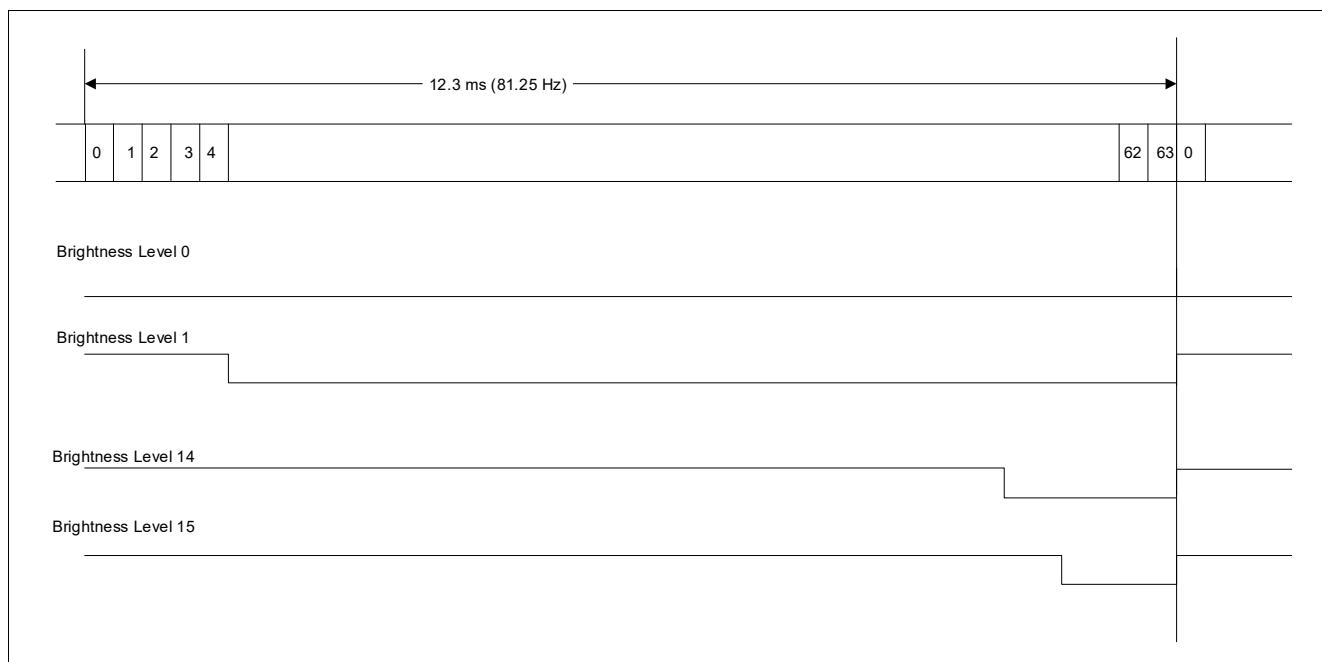


Figure 11 LED Brightness Control By Controlling LED Output Enable/Disable

### 3.6 Smart-AZ Feature

The Smart-AZ feature is relevant when the MxL86112C is connected to a MAC SoC that does not implement the EEE feature in its MAC layer. In this case, the MAC SoC cannot initiate a transition to the low-power idle state.

To alleviate the limitation of such a MAC SoC, the MxL86112C detects the conditions that may lead to low-power idle and generates the control messages to enter EEE mode in accordance with the IEEE 802.3az standard.

The Smart-AZ feature is enabled by default. It can be disabled by programming VSPEC1\_PM\_CTRL.PM\_EN to 0.

### 3.7 Power Management

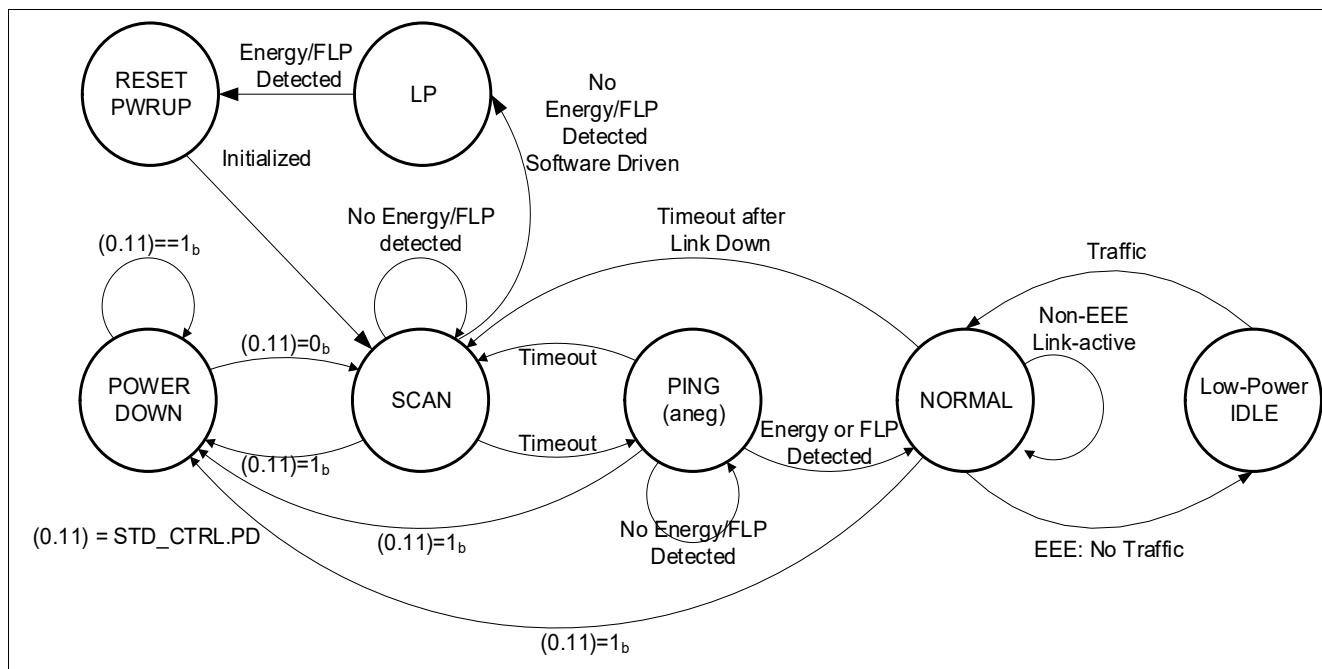
This chapter describes the power management functions of the MxL86112C.

#### 3.7.1 Power States

**Figure 12** illustrates the power states and transition of the MxL86112C. In this state diagram, the (0.11) syntax corresponds to the value of bit 11 from register 0 in device 0. This is the “PD” power down bit in MDIO STD\_CTRL described in [Chapter 4](#). The station management can use this STD\_CTRL.PD field to bring the physical interface to POWER DOWN state.

The other states are automatically entered by the MxL86112C depending on the context, and following the Energy Efficient Ethernet protocol. This is done without need for any intervention from STA.

Acronyms “NLP” and “FLP” respectively mean “Normal Link Pulse” and “Fast Link Pulse”. These pulses are received on the twisted pair interface from a link partner and used to wake up the MxL86112C and enter auto-negotiation.



**Figure 12** State Diagram for Power Down State Management

#### 3.7.2 RESET Power Up

This is the state in which the MxL86112C starts up after either a hardware reset or power up.

Once initialized, the MxL86112C will always transition to SCAN state.

#### 3.7.3 POWER DOWN State

The POWER DOWN state is entered by setting “power down” bit 11 of the MDIO standard register STD\_CTRL (0.11) to logic 1, regardless of the current state of the device. The POWER DOWN state corresponds to power down as specified in IEEE 802.3, Clause 22.2.4.1.5. Some signal processing blocks are stopped to save energy, but the MxL86112C still responds to MDIO messages. The SGMII interface to the MAC SoC is switched off as well.

The POWER DOWN state exit is triggered by setting the MDIO standard register (0.11), which generates a transition to SCAN state.

### 3.7.4 SCAN State

The SCAN state differs from the POWER DOWN state because the receiver periodically scans for signal energy or FLP bursts on the TPI. There is no transmission in this state. When a FLP burst is received, the MxL86112C enters the auto-negotiation protocol to exchange capabilities with the link partner and establish a data link in the NORMAL state.

### 3.7.5 PING State

The PING state is similar to the SCAN state except that the transceiver transmits an FLP burst onto the TPI for a programmable amount of time. This is used to wake potential link partners from the POWER DOWN state. This state corresponds to the state of “ANEG” described in Clause 28 of the IEEE standard [\[1\]](#).

### 3.7.6 LP State

The Low Power (LP) state in MxL86112C is enabled by configuring MDIO register PHY\_CTL2.LP. The LP state is entered automatically when there is no Ethernet cable connected to the MxL86112C. The MxL86112C firmware detects this condition when no energy or FLP is present on the TPI and enters the LP state. It is intended to set the MxL86112C into its maximum power saving state. In this state, most digital domains are in reset. Only a minimal amount of circuitry (analog/digital) operates to detect signal energy on the receiver of a TPI and trigger a wake-up.

When the MxL86112C is in LP state, the STA does not have access to the MDIO/MMD registers.

The LP state is exited upon detection of signal energy on the twisted pair (either NLP or FLP). The MxL86112C transitions to the RESET Power Up state automatically.

It is possible for the STA host to be informed of the LP entry condition and can choose to acknowledge it before granting LP entry. By setting PHY\_IMASK.LP bit to ACTIVE, the STA requests the MDINT interrupt from MxL86112C when the entry conditions are met. If PHY\_CTL2.LP\_STA\_BLOCK is ON then MxL86112C will enter LP only after STA reads the interrupt status register PHY\_ISTAT else the entry to LP is unconditional. All the LP related control bits and communication mechanism between STA and GPY is shown in the flowchart in [Figure 13](#).

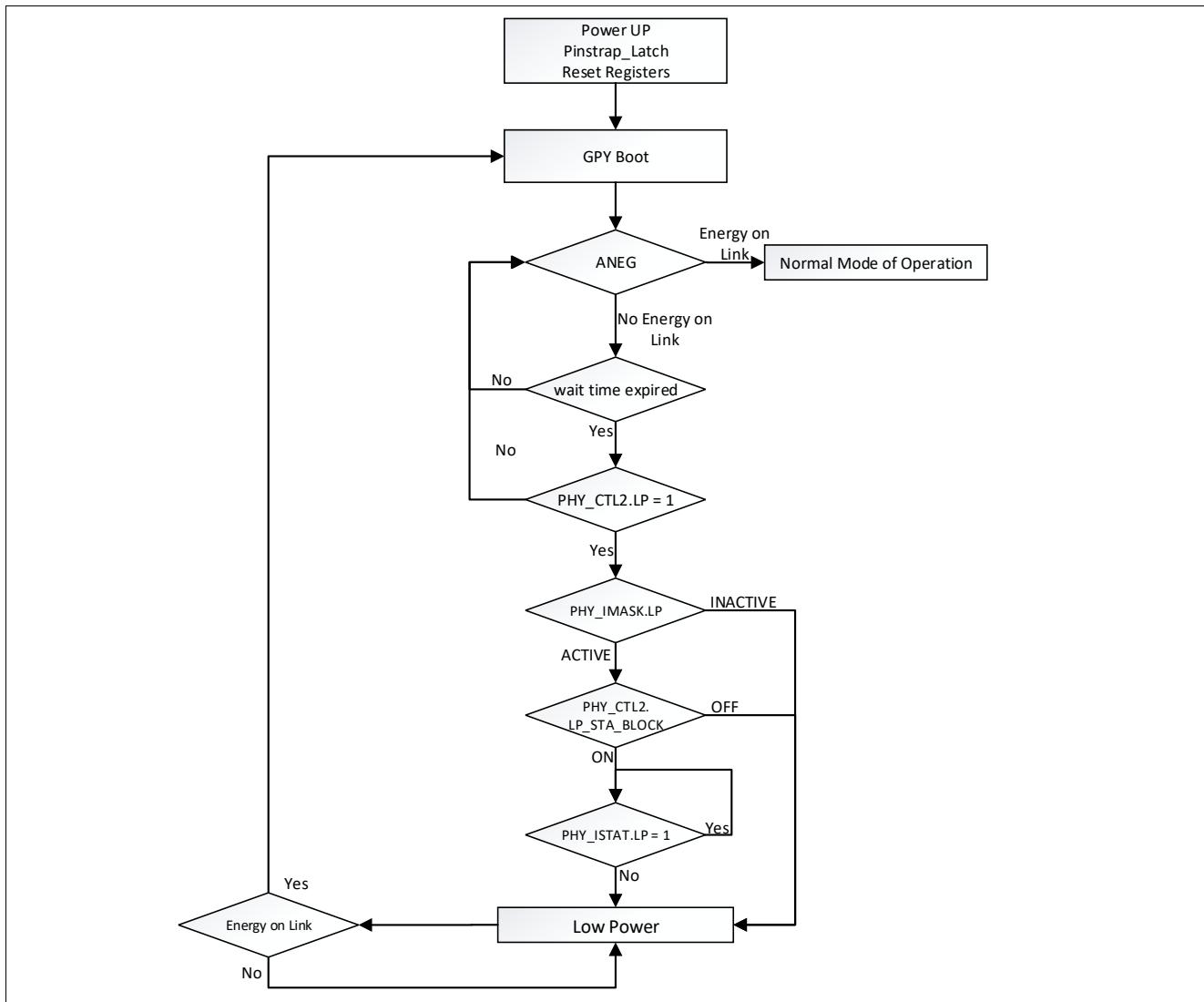


Figure 13 LP Sequence

Table 14 LP State Entry and Exit Sequence

Step	State	Remark
1	ACTIVE, the LP feature is enabled by programming PHY_CTL2.LP = 1.	Use MDIO register PHY_CTL2.LP to enable / disable the LP feature.
2	ANEGR, Ability Detect	The firmware detects no energy on the cable when no FLP is received for a long period of time. This time can be configured with register: VSPEC1_NBT_DS_CTRL.NRG_RST_CNT (value to program = time in seconds). Default time is 4 seconds (VSPEC1_NBT_DS_CTRL.NRG_RST_CNT = 4).
3	LP Entry	MxL86112C saves MDIO LP persistent registers.

## Functional Description

**Table 14 LP State Entry and Exit Sequence (cont'd)**

Step	State	Remark
4	LP	Power consumption is saved in this state. MxL86112C listen to energy pulses from Link Partner ANEG as a condition to trigger LP exit. Only a minimal amount of circuitry operates to detect signal energy on TPI and trigger a wake-up. MxL86112C GPIOs, LEDs and MDIO interface are disabled.
5	LP Exit, based on Energy detected on cable.	MxL86112C restores the MDIO LP persistent registers. The STA is responsible to restore any custom MDIO information that were not saved in the group of LP persistent registers.
6	ANEG, LINK-UP and ACTIVE	MxL86112C operates in Normal Power Modes.

These are persistent MDIO registers saved and restored during LP entry-exit.

1. STD\_CTRL.SSM
2. STD\_CTRL.COL
3. STD\_CTRL.DPLX
4. STD\_CTRL.ISOL
5. STD\_CTRL.ANEN
6. STD\_CTRL.SSL
7. STD\_AN\_ADV.TAF
8. STD\_AN\_ADV.XNP
9. STD\_GCTRL.MBTHD
10. STD\_GCTRL.MBTFD
11. STD\_GCTRL.MSPT
12. STD\_GCTRL.MS
13. STD\_GCTRL.MSEN
14. PHY\_IMASK
15. PHY\_CTL1.AMDIX
16. PHY\_CTL1.MDIAB
17. PHY\_CTL1.MDICD
18. PHY\_CTL1.POLA
19. PHY\_CTL1.POLB
20. PHY\_CTL1.POLC
21. PHY\_CTL1.POLD
22. PHY\_CTL2.LPI
23. PHY\_CTL2.ANPD
24. PHY\_CTL2.PSCL
25. PHY\_CTL2.LP
26. PHY\_CTL2.LP\_STA\_BLOCK
27. PHY\_CTL2.STICKY
28. PHY\_CTL2.SDETP
29. PHY\_LED
30. ANEG\_CTRL.ANEG\_ENAB
31. ANEG\_MGBT\_AN\_CTRL.LDL
32. ANEG\_MGBT\_AN\_CTRL.FR
33. ANEG\_MGBT\_AN\_CTRL.FR2G5BT
34. ANEG\_MGBT\_AN\_CTRL.AB2G5BT
35. ANEG\_MGBT\_AN\_CTRL.PT
36. ANEG\_MGBT\_AN\_CTRL.MS\_MAN\_EN
37. ANEG\_MGBT\_AN\_CTRL.MSCV
38. ANEG\_EEE\_AN\_ADV1.EEE\_100BTX
39. ANEG\_EEE\_AN\_ADV1.EEE\_1000BT
40. ANEG\_EEE\_AN\_ADV2.EEE2G5
41. VSPEC1\_NBT\_DS\_CTRL.NO\_NRG\_RST
42. VSPEC1\_NBT\_DS\_CTRL.DOWNSHIFTEN
43. VSPEC1\_NBT\_DS\_CTRL.DOWNSHIFT\_THR
44. VSPEC1\_NBT\_DS\_CTRL.NRG\_RST\_CNT
45. VSPEC1\_NBT\_DS\_CTRL.FORCE\_RST
46. VSPEC1\_LED0
47. VSPEC1\_LED1
48. VSPEC1\_LED2
49. VSPEC1\_SGMII\_CTRL
50. VSPEC1\_PM\_CTRL

## 51. VSPEC1\_IMASK

**3.7.7 NORMAL State**

The NORMAL state is used to establish and maintain a link connection. If a connection is dropped, the MxL86112C moves back into SCAN state.

**3.7.8 Low-Power IDLE State: Energy-Efficient Ethernet**

The IEEE 802.3 standard [1] describes the Energy-Efficient Ethernet (EEE) operation that is supported by the MxL86112C. EEE is supported in the various speeds of 10BASE-T, 100BASE-TX, and 1000BASE-T. The general idea of EEE is to save power during periods of low link utilization. Instead of sending active idle data, the transmitters are switched off for a short period of time. This is called the quiet period in the standard. The link is kept active by means of a frequent refresh cycle initiated by the PHY itself during low power state. This sequence is repeated until a wake request is generated by one of the link partner MACs. MxL86112C follows the IEEE 802.3 standard regarding EEE. The principle is shown in [Figure 14](#). This state is entered automatically when the low-power idle conditions are met.

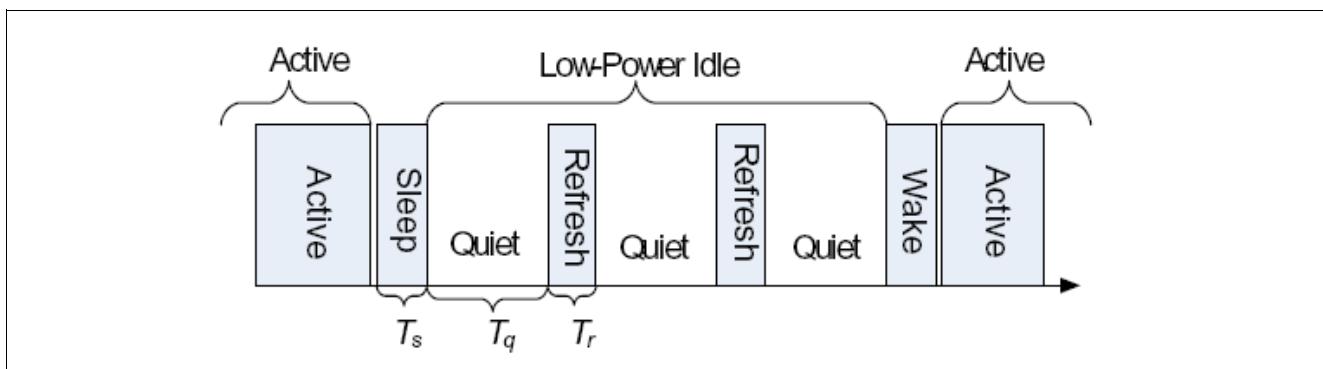


Figure 14 EEE Low-Power Idle Sequence

### 3.8 Firmware Upgrade

The MxL86112C provides a firmware upgrade feature, that allows feature and functional enhancements of the MxL86112C in the field.

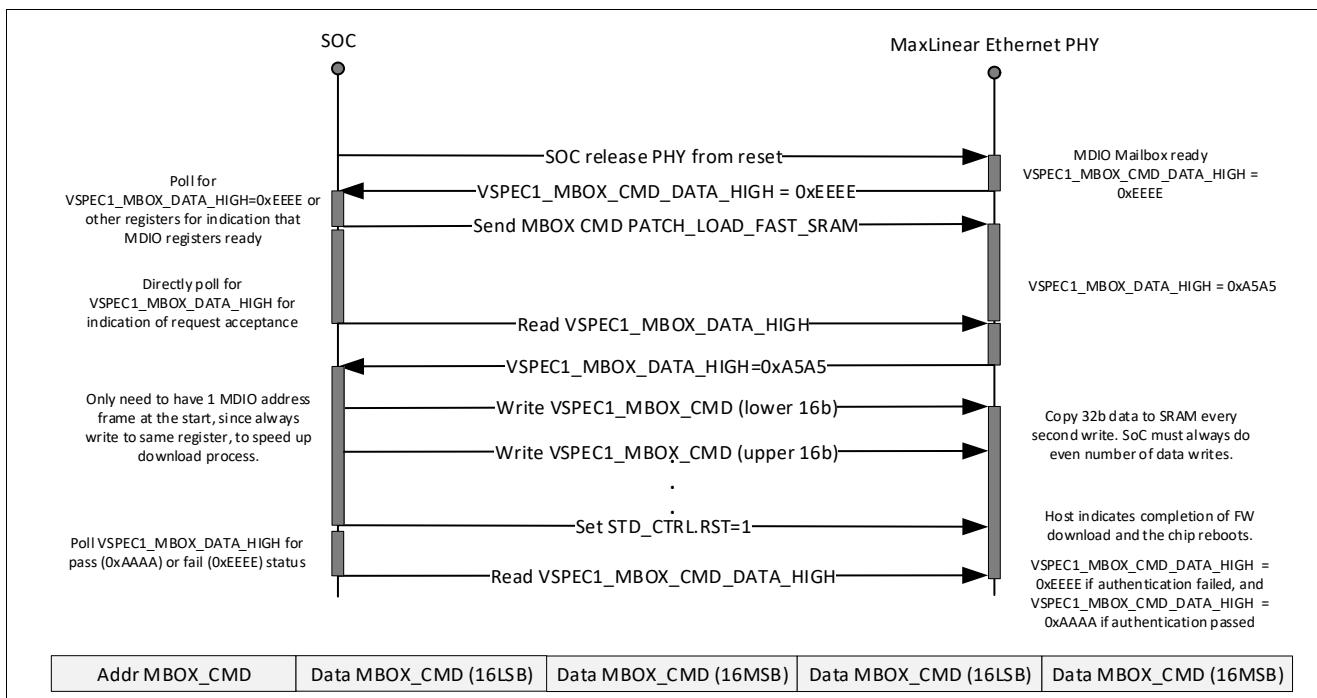
Initially, the MxL86112C is provided with a permanent on-chip firmware image in the ROM.

A new firmware image can be downloaded into an on-chip memory and the MxL86112C can fetch the upgraded firmware from this memory after a reboot.

The host MAC SoC can initiate the firmware upgrade process any time after the MDIO interface is ready. MaxLinear provides an API to facilitate the firmware upgrade. To upgrade the MxL86112C's firmware image, the device must be put into the reset state and restarted. This allows the usual **Power-On Sequence** to occur and allows the download of a MaxLinear signed firmware image into the on-chip SRAM using the MDIO slave interface. The **Super Isolate** mode can be used to prevent MxL86112C from executing the internal firmware image in the ROM, before the firmware upgrade process is started.

Once the firmware image has been transferred to the MxL86112C's on-chip memory, it is authenticated. For security reasons, the MxL86112C will only accept firmware images, which are electronically signed by MaxLinear. In case the downloaded image cannot be authenticated by the MxL86112C or the image download is aborted or fails, the MxL86112C will default to run from the internal firmware image in the ROM.

The MAC SoC interaction with the MxL86112C for the FW download to SRAM is described in [Figure 15](#).



**Figure 15 Firmware upgrade**

The GPY API describing the driver software executed on the MAC SoC must be followed to execute this feature. It provides information on the update process and which actions are required in the MAC SoC application.

Security feature to prevent rollback of image to a previous version (Anti-Rollback) is not supported within the MxL86112C. If the system (SoC) to which the MxL86112C is attached, mandates such features, they can be supported by the system. The host software is expected to verify a firmware before downloading it to the SRAM, and that the version number of the new firmware is higher than the one installed.

## 4 MDIO and MMD Register Interface Description

The following sections describe the MDIO and MMD registers, which are standardized by IEEE 802.3 [1], and available to support the MxL86112C feature set. These registers can be accessed by an external management entity (also called STA in IEEE) to control, configure or read the status of the MxL86112C. After power-on, the MxL86112C resets the MDIO and MMD registers to default values that are sufficient to operate without specific programming.

All the register definitions, behaviors and fields are strictly compliant with the IEEE 802.3 [1]. Refer to IEEE 802.3 for more detailed explanations of the registers. The only registers that are not referenced in IEEE 802.3 are two register groups that are “vendor specific”: VSPEC1 and VSPEC2. These allow custom functions related to the MxL86112C. In the register descriptions, the section or table references refer to the IEEE 802.3 [1] documents.

### 4.1 Definitions

The following acronyms are used in the IEEE 802.3 standard and commonly used in the Ethernet technical domain:

- **STA:** Station Management. A host connected to the MDIO interface. STAs are generally Media Access Controllers (MACs). The STA drives the MDIO bus as a clock master and the MxL86112C is MDIO slave.
- **Host:** Used as a synonym of STA in this document.
- **PHY:** Physical Layer. In the MxL86112C this encompasses Analog Signal Processing, Digital Signal Processing, PCS. The PHY contains several sub-layers that are individually manageable entities known as MDIO manageable devices (MMDs).
- **MMD:** MDIO Manageable Device. The list of MMDs available in the MxL86112C is in [Chapter 4.3](#).
- **Device:** In the context of MDIO/MMD registers, a device is a register bank grouped by logical sub-layers of the PHY layer.
- **Clause:** Refers to a particular section of the IEEE 802.3 standard [1]. In particular Clause 22 describes MDIO device 0, and Clause 45 describes the other MMDs.
- **MII:** Media Independent Interface. This encompasses the MDIO as well as the (G)MII as described in Clause 22. STD registers in device 0 are also called MII registers.

## 4.2 Register Naming and Numbering

The register numbering convention in this document is similar to that of IEEE 802.3:

The numbering syntax uses 3 numbers “a.b.c” as specified in IEEE 802.3 paragraph 45.1, and the notation is generalized to Clause 22 registers in device 0 “STD”. The alphanumeric syntax also uses the same structure and uses the names of the MMD devices, registers and register fields separated by underscore and dot as described below.

### 4.2.1 Register Numbering

The syntax is as follows, with a, b, c written as decimal numbers:

a.b.c = <DEVICE\_NUMBER>.<REGISTER\_NUMBER>.<FIELD\_NUMBER>

When the last indicator (c) is omitted, the register numbering refers to the full register.

When a field is more than a single bit, the bit range is indicated using a semicolon (e.g. 1:3 is the field of bits 1 to 3). In an MDIO register, the least significant bit is bit 0 and most significant bit is bit 15. All MDIO registers are 16 bit wide.

### 4.2.2 Register Naming

The syntax is as follows, with AA, BB, CC written as alphanumeric strings:

AA.BB.CC = <DEVICE\_NAME>\_<REGISTER\_NAME>.<FIELD\_NAME>

When the last indicator (CC) is omitted, the register naming refers to the full register.

The fields named Res, RES1, and RES2 refer to reserved fields as per IEEE 802.3 documents.

### 4.2.3 Examples

STD\_STAT.ANOK is the name of the field 0.1.5, which indicates auto-negotiation complete.

ANEG\_CTRL.ANEG\_RESTART is the name of the field 7.0.9, which allows the STA to restart the Ethernet ANEG procedure.

ANEG\_PHYID1 is the complete 16-bit register number 7.2, for the PHY identifier 1 number.

VSPEC1\_LED1.BLINKS is the 4-bit wide field number 30.2.15:12, which contains LED1 slow blinking configuration.

#### 4.3 MMD Devices Present in MxL86112C

The MMD devices implement groups of standardized registers under the management of the STA. They are defined in IEEE 802.3.

**Table 15 MDIO / MMD Devices Present in MxL86112C**

MDIO / MMD Name	Device Number (decimal)	Description
STD	0	MDIO Standard Device as described in Clause 22. This also contains a number of PHY registers that are MxL86112C specific.
PMAPMD	1	Control and status registers related to PMA/PMD signal processing modules.
PCS	3	Control and status registers related to PCS encoding/decoding device.
ANEG	7	Control and status registers related to auto-negotiation device.
VSPEC1	30	MxL86112C-specific LED control and MxL86112C SGMII control.
VSPEC2	31	MxL86112C-specific Wake-on-LAN control.

#### 4.4 Responsibilities of the STA

The MxL86112C responds to all published register addresses for the device and returns a value of zero for undefined and unsupported registers.

As per IEEE 802.3 guidelines, it is the responsibility of the STA entity to ensure that mutually acceptable speeds are applied consistently across all the MMDs of the MxL86112C.

The MxL86112C ignores writes to the PMA/PMD speed selection bits that select speeds which are not advertised in the PMA/PMD speed ability register. The PMA/PMD speed selection defaults to a supported ability.

#### 4.5 MDIO Access Protocols to Read / Write Registers

All the MDIO/MMD registers can be accessed from an external chip connected to the MDIO bus on the MDIO and MDC pins. The MxL86112C supports several MDIO frame protocols:

- Clause 22: To access Device 0
- Clause 22 Extended: To access other devices (Dev 1: PMAPMD, Dev 3: PCS, Dev7: ANEG, Dev 30: VSPEC1, DEV 31: VSPEC2) using the indirection scheme specified by IEEE 802.3.
- Clause 45: to access all devices

Both Clause 22 Extended and Clause 45 can be used to access MMD devices. However, the mechanism implemented in the MxL86112C provides faster speeds using Clause 45, so there are some differences in latencies in the MDIO reply:

- Protocol "Clause 22 Extended" involves the MxL86112C an indirection mechanism.
- Protocol "Clause 45" provides faster replies.

The Clause 22 registers can be accessed using the Clause 45 electrical interface and the Clause 22 management frame structure [IEEE 802.3 section 45.2].

## 5 MDIO Registers Detailed Description

**Table 16 Register Access Type**

Mode	Symbol
Status Register, (Status, or Ability Register)	RO
Read-Write Register, (e.g. MDIO Register)	RW
Read-Write, Self-Clearing Register (bit is cleared after read from MDIO)	RWSC
Read-Only, Self-Clearing Register (bit is cleared after read from MDIO)	ROSC
Read-Only Latching Low Register	ROLL
Read-Only Latching High Register	ROLH

**Attention:** As MxL86112C is a 1G speed product, the maximum speed capability available in the registers is 1G. Any speed request higher than 1G (2.5G, 5G, 10G) defaults to 1G.

## 5.1 Standard Management Registers

This section describes the IEEE 802.3 standard management registers corresponding to Clause 22.

**Table 17 Registers Overview**

Register Short Name	Register Long Name	Reset Value
<b>STD_CTRL</b>	STD Control (Register 0.0)	3040 <sub>H</sub>
<b>STD_STAT</b>	Status Register (Register 0.1)	7949 <sub>H</sub>
<b>STD_PHYID1</b>	PHY Identifier 1 (Register 0.2)	C133 <sub>H</sub>
<b>STD_PHYID2</b>	PHY Identifier 2 (Register 0.3)	5400 <sub>H</sub> <sup>1)</sup>
<b>STD_AN_ADV</b>	Auto-Negotiation Advertisement (Register 0.4)	91E1 <sub>H</sub>
<b>STD_AN_LPA</b>	Auto-Negotiation Link Partner Ability (Register 0.5)	0000 <sub>H</sub>
<b>STD_AN_EXP</b>	Auto-Negotiation Expansion (Register 0.6)	0064 <sub>H</sub>
<b>STD_AN_NPTX</b>	Auto-Negotiation Next Page Transmit Register (Register 0.7)	2001 <sub>H</sub>
<b>STD_AN_NPRX</b>	Auto-Negotiation Link Partner Received Next Page Register (Register 0.8)	0000 <sub>H</sub>
<b>STD_GCTRL</b>	Gigabit Control Register (Register 0.9)	0200 <sub>H</sub>
<b>STD_GSTAT</b>	Gigabit Status Register (Register 0.10)	0000 <sub>H</sub>
<b>STD_MMDCTRL</b>	MMD Access Control Register (Register 0.13)	0000 <sub>H</sub>
<b>STD_MMDDATA</b>	MMD Access Data Register (Register 0.14)	0000 <sub>H</sub>
<b>STD_XSTAT</b>	Extended Status Register (Register 0.15)	2000 <sub>H</sub>

1) For the device specific reset value, refer to the Product Naming table in the [Package Outline](#) chapter.

### 5.1.1 Standard Management Registers

This chapter describes all registers of STD in detail.

#### STD Control (Register 0.0)

This register controls the main functions of the PHY.

IEEE Standard Register=0.0

													Reset Value
STD Control (Register 0.0)													3040 <sub>H</sub>
15	14	13	12	11	10	9	8	7	6	5			0
RST	LB	SSL	ANEN	PD	ISOL	ANRS	DPLX	COL	SSM			RES	
rwsc	rw	rw	rw	rw	rw	rwsc	rw	rw	rw			ro	

Field	Bits	Type	Description
RST	15	RWSC	<p><b>Reset</b>            Resets the PHY to its default state. Active links are terminated. Note that this is a self-clearing bit which is set to zero by the hardware after reset has been done. See also IEEE 802.3 22.2.4.1.1.</p> <p>0<sub>B</sub> <b>NORMAL</b> Normal operational mode            1<sub>B</sub> <b>RESET</b> Resets the device</p>
LB	14	RW	<p><b>Loop-Back on GMII</b>            This mode enables looping back of MII data (SGMII) from the transmit to the receive direction. No data is transmitted to the Ethernet PHY. The device operates at the selected speed. The collision signal remains de-asserted unless otherwise forced by the collision test.</p> <p>0<sub>B</sub> <b>NORMAL</b> Normal operational mode            1<sub>B</sub> <b>ENABLE</b> Closes the loop-back from TX to RX at xMII</p>
SSL	13	RW	<p><b>Forced Speed Selection LSB</b>            This bit only takes effect when the auto-negotiation process is disabled, that is, bit ANEN is set to zero.</p> <p>This is the lower bit (LSB) of the forced speed selection. In conjunction with the higher bit (MSB) , the following encoding is valid:</p> <p>MSB LSB bit values:</p> <p>0 0 = 10 Mbit/s            0 1 = 100 Mbit/s            1 0 = 1000 Mbit/s            1 1 = Reserved, defaults to 2500 Mb/s if the PMA_CTRL register 1.0.5:2 is equal to [0 1 1 0 ]</p> <p>The standard procedure to force the 2500 Mb/s (when ANEG is disabled) is to program PMA_CTRL with 1.0.6 = 1.0.13 = 1 and 1.0.5:2 = [0 1 1 0 ] GPY PHY mirrors 1.0.6, 1.0.13 and 0.0.6 , 0.0.13</p>
ANEN	12	RW	<p><b>Auto-Negotiation Enable</b>            Allows enabling and disabling of the auto-negotiation process capability of the PHY. If enabled, the force bits for duplex mode (CTRL.DPLX) and the speed selection (CTRL.SSM, CTRL.SSL) become inactive. Otherwise, the force bits define the PHY operation. See also IEEE 802.3 22.2.4.1.4.</p> <p>0<sub>B</sub> <b>DISABLE</b> Disable the auto-negotiation protocol            1<sub>B</sub> <b>ENABLE</b> Enable the auto-negotiation protocol</p>
PD	11	RW	<p><b>Power Down</b>            Forces the device into a power down state (SLEEP) in which power consumption is the bare minimum required to still maintain the MII management interface communication. When activating the power down functionality, the PHY terminates active data links. The MII interface is also stopped in power down mode. See also IEEE 802.3 22.2.4.1.5.</p> <p>0<sub>B</sub> <b>NORMAL</b> Normal operational mode            1<sub>B</sub> <b>POWERDOWN</b> Forces the device into power down mode</p>

Field	Bits	Type	Description (cont'd)
ISOL	10	RW	<p><b>Isolate</b>            The isolation mode isolates the PHY from the MAC. MAC interface inputs are ignored, whereas MAC interface outputs are set to tristate (high-impedance). See also IEEE 802.3 22.2.4.1.6.</p> <p>0<sub>B</sub> <b>NORMAL</b> Normal operational mode            1<sub>B</sub> <b>ISOLATE</b> Isolates the PHY from the MAC</p>
ANRS	9	RWSC	<p><b>Restart Auto-Negotiation</b>            Restarts the auto-negotiation process on the MDI. This bit does not take any effect when auto-negotiation is disabled using (CTRL.ANEN). Note that this bit is self-clearing after the auto-negotiation process is initiated. See also IEEE 802.3 22.2.4.1.7.</p> <p>0<sub>B</sub> <b>NORMAL</b> Stay in current mode            1<sub>B</sub> <b>RESTART</b> Restart auto-negotiation</p>
DPLX	8	RW	<p><b>Forced Duplex Mode</b>            Note that this bit only takes effect when the auto-negotiation process is disabled, that is, bit CTRL.ANEN is set to zero. This bit controls the forced duplex mode. It allows forcing of the PHY into full or half-duplex mode. Note that this bit does not take effect in loop-back mode, that is, when bit CTRL.LB is set to "1". See also IEEE 802.3 22.2.4.1.8.</p> <p>The Duplex mode can only be forced to Half Duplex in 10BT and 100BT speed modes. This field is ignored for higher speeds.</p> <p>0<sub>B</sub> <b>HD</b> Half duplex            1<sub>B</sub> <b>FD</b> Full duplex</p>
COL	7	RW	<p><b>Collision Test</b>            Allows testing of the COL signal at the xMII interface. When the collision test is enabled, the state of the TX_EN signal is looped back to the COL signal within a minimum latency.</p> <p>See also IEEE 802.3 22.2.4.1.9.</p> <p>0<sub>B</sub> <b>DISABLE</b> Normal operational mode            1<sub>B</sub> <b>ENABLE</b> Activates the collision test</p>
SSM	6	RW	<p><b>Forced Speed Selection MSB</b>            This bit only takes effect when the auto-negotiation process is disabled, that is, bit ANEN is set to zero.</p> <p>This is the most significant bit (MSB) of the forced speed selection. In conjunction with the lower bit, (LSB), the following encoding is valid:</p> <p>MSB LSB:</p> <p>0 0 = 10 Mbit/s            0 1 = 100 Mbit/s            1 0 = 1000 Mbit/s            1 1 = Reserved, defaults to 2500 Mb/s if the PMA_CTRL (1.0.5:2 = [0 1 0])</p> <p>The preferred way to force the 2500 Mb/s (when ANEG is disabled) is to program PMA_CTRL with 1.0.6 = 1.0.13 = 1 and 1.0.5:2 = [0 1 1 0] GPY mirrors 1.06, 1.0.13 and 0.0.6 , 0.0.13</p>
RES	5:0	RO	<p><b>Reserved</b>            Write as zero, ignore on read.</p>

### Status Register (Register 0.1)

This register contains status and capability information about the device. Note that all bits are read-only. A write access by the MAC does not have any effect. See also IEEE 802.3 22.2.4.2.

IEEE Standard Register=0.1

STD_STAT																Reset Value
Status Register (Register 0.1)																7949 <sub>H</sub>

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
<b>CBT4</b>	<b>CBTXF</b>	<b>CBTXH</b>	<b>XBTF</b>	<b>XBTH</b>	<b>CBT2F</b>	<b>CBT2H</b>	<b>EXT</b>	<b>RES</b>	<b>MFPS</b>	<b>ANOK</b>	<b>RF</b>	<b>ANAB</b>	<b>LS</b>	<b>JD</b>	<b>XCAP</b>	
ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	rolh	ro	roll	rolh	ro	

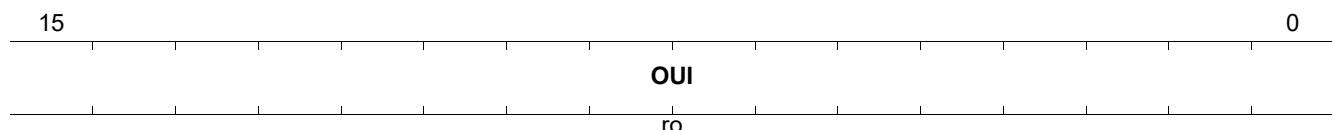
Field	Bits	Type	Description
CBT4	15	RO	<b>IEEE 100BASE-T4</b> Specifies the 100BASE-T4 ability. 0 <sub>B</sub> <b>DISABLED</b> PHY does not support this mode 1 <sub>B</sub> <b>ENABLED</b> PHY supports this mode
CBTXF	14	RO	<b>IEEE 100BASE-TX Full-Duplex</b> Specifies the 100BASE-TX full-duplex ability. 0 <sub>B</sub> <b>DISABLED</b> PHY does not support this mode 1 <sub>B</sub> <b>ENABLED</b> PHY supports this mode
CBTXH	13	RO	<b>IEEE 100BASE-TX Half-Duplex</b> Specifies the 100BASE-TX half-duplex ability. 0 <sub>B</sub> <b>DISABLED</b> PHY does not support this mode 1 <sub>B</sub> <b>ENABLED</b> PHY supports this mode
XBTF	12	RO	<b>IEEE 10BASE-T Full-Duplex</b> Specifies the 10 BASE-T full-duplex ability. 0 <sub>B</sub> <b>DISABLED</b> PHY does not support this mode 1 <sub>B</sub> <b>ENABLED</b> PHY supports this mode
XBTH	11	RO	<b>IEEE 10BASE-T Half-Duplex</b> Specifies the 10BASE-T half-duplex ability. 0 <sub>B</sub> <b>DISABLED</b> PHY does not support this mode 1 <sub>B</sub> <b>ENABLED</b> PHY supports this mode
CBT2F	10	RO	<b>IEEE 100BASE-T2 Full-Duplex</b> Specifies the 100BASE-T2 full-duplex ability. 0 <sub>B</sub> <b>DISABLED</b> PHY does not support this mode 1 <sub>B</sub> <b>ENABLED</b> PHY supports this mode
CBT2H	9	RO	<b>IEEE 100BASE-T2 Half-Duplex</b> Specifies the 100BASE-T2 half-duplex ability. 0 <sub>B</sub> <b>DISABLED</b> PHY does not support this mode 1 <sub>B</sub> <b>ENABLED</b> PHY supports this mode

Field	Bits	Type	Description (cont'd)
EXT	8	RO	<p><b>Extended Status</b>            The extended status registers are used to specify 1000 Mbit/s speed capabilities in the register XSTAT. See also IEEE 802.3 Clause 22.2.4.2.16.</p> <p>0<sub>B</sub> <b>DISABLED</b> No extended status information available in register 15            1<sub>B</sub> <b>ENABLED</b> Extended status information available in register 15</p>
RES	7	RO	<p><b>Reserved</b>            Ignore when read.</p>
MFPS	6	RO	<p><b>Management Preamble Suppression</b>            Specifies the MF preamble suppression ability. See also IEEE 802.3 22.2.4.2.9.</p> <p>0<sub>B</sub> <b>DISABLED</b> PHY requires management frames with preamble            1<sub>B</sub> <b>ENABLED</b> PHY accepts management frames without preamble</p>
ANOK	5	RO	<p><b>Auto-Negotiation Completed</b>            Indicates whether the auto-negotiation process is completed or in progress. See also IEEE 802.3 22.2.4.2.10.</p> <p>0<sub>B</sub> <b>RUNNING</b> Auto-negotiation process is in progress            1<sub>B</sub> <b>COMPLETED</b> Auto-negotiation process is completed</p>
RF	4	ROLH	<p><b>Remote Fault</b>            Indicates the detection of a remote fault event. See also IEEE 802.3 22.2.4.2.11.</p> <p>0<sub>B</sub> <b>INACTIVE</b> No remote fault condition detected            1<sub>B</sub> <b>ACTIVE</b> Remote fault condition detected</p>
ANAB	3	RO	<p><b>Auto-Negotiation Ability</b>            Specifies the auto-negotiation ability. See also IEEE 802.3 22.2.4.2.12.</p> <p>0<sub>B</sub> <b>DISABLED</b> PHY is not able to perform auto-negotiation            1<sub>B</sub> <b>ENABLED</b> PHY is able to perform auto-negotiation</p>
LS	2	ROLL	<p><b>Link Status</b>            Indicates the link status of the PHY to the link partner. See also IEEE 802.3 22.2.4.2.13.</p> <p>0<sub>B</sub> <b>INACTIVE</b> The link is down. No communication with link partner possible.            1<sub>B</sub> <b>ACTIVE</b> The link is up. Data communication with link partner is possible.</p>
JD	1	ROLH	<p><b>Jabber Detect</b>            Indicates that a jabber event has been detected. See also IEEE 802.3 22.2.4.2.14.</p> <p>0<sub>B</sub> <b>NONE</b> No jabber condition detected            1<sub>B</sub> <b>DETECTED</b> Jabber condition detected</p>
XCAP	0	RO	<p><b>Extended Capability</b>            Indicates the availability and support of extended capability registers. See also IEEE 802.3 22.2.4.2.15.</p> <p>0<sub>B</sub> <b>DISABLED</b> Only base registers are supported            1<sub>B</sub> <b>ENABLED</b> Extended capability registers are supported</p>

**PHY Identifier 1 (Register 0.2)**

This code specifies the Organizationally Unique Identifier (OUI), and the vendor's model and revision number.  
IEEE Standard Register=0.2

STD_PHYID1	Reset Value
PHY Identifier 1 (Register 0.2)	C133 <sub>H</sub>

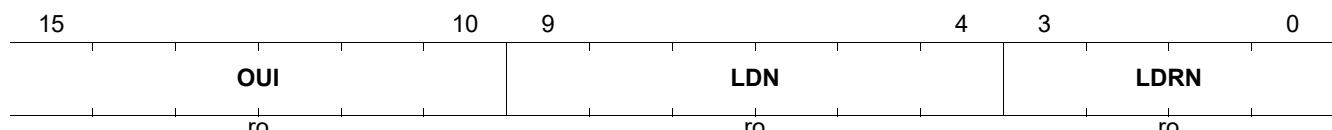


Field	Bits	Type	Description
OUI	15:0	RO	Organizationally Unique Identifier Bits 3:18

**PHY Identifier 2 (Register 0.3)**

IEEE Standard Register=0.3

STD_PHYID2	Reset Value
PHY Identifier 2 (Register 0.3)	5400 <sub>H</sub>



Field	Bits	Type	Description
OUI	15:10	RO	Organizationally Unique Identifier Bits 19:24
LDN	9:4	RO	<b>Device Number</b> Specifies the device number <sup>1)</sup> to distinguish between several products.
LDRN	3:0	RO	<b>Device Number</b> Specifies the device revision number <sup>1)</sup> to distinguish between several versions of this device.

1) For the device specific reset value, refer to Product Naming table in the [Package Outline](#) chapter.

**Auto-Negotiation Advertisement (Register 0.4)**

This register contains the advertised abilities of the PHY during auto-negotiation.

IEEE Standard Register=0.4

STD_AN_ADV										Reset Value
Auto-Negotiation Advertisement (Register 0.4)										91E1 <sub>H</sub>

15	14	13	12	11					5	4	0
NP	RES	RF	XNP		TAF				SF		

Field	Bits	Type	Description
NP	15	RW	<p><b>Next Page</b>            Next page indication is encoded in bit AN_ADV.NP regardless of the selector field value or link code word encoding. The PHY always advertises NP if a 1000BASE-T mode is advertised during auto-negotiation. See also IEEE 802.3 28.2.1.2.6.</p> <p>0<sub>B</sub> <b>INACTIVE</b> No next page(s) will follow            1<sub>B</sub> <b>ACTIVE</b> Additional next page(s) will follow</p>
RES	14	RO	<p><b>Reserved</b>            Write as zero, ignore on read.</p>
RF	13	RW	<p><b>Remote Fault</b>            The remote fault bit allows indication of a fault to the link partner. See also IEEE 802.3 28.2.1.2.4.</p> <p>0<sub>B</sub> <b>NONE</b> No remote fault is indicated            1<sub>B</sub> <b>FAULT</b> A remote fault is indicated</p>
XNP	12	RW	<p><b>Extended Next Page</b>            Indicates that GPY supports transmission of Extended Next Pages (XNP).</p> <p>0<sub>B</sub> <b>UNABLE</b> GPY is XNP unable            1<sub>B</sub> <b>ABLE</b> GPY is XNP able</p>
TAF	11:5	RW	<p><b>Technology Ability Field</b>            The technology ability field is an 7-bit wide field containing information indicating supported technologies. GPY supports 10BASE-T (Half and Full Duplex), 100BASE-TX (Half and Full Duplex) and both symmetric and asymmetric PAUSE.</p> <p>40<sub>H</sub> <b>PS_ASYM</b> Advertise asymmetric pause            20<sub>H</sub> <b>PS_SYM</b> Advertise symmetric pause            10<sub>H</sub> <b>DBT4</b> Advertise 100BASE-T4            08<sub>H</sub> <b>DBT_FDX</b> Advertise 100BASE-TX full duplex            04<sub>H</sub> <b>DBT_HDX</b> Advertise 100BASE-TX half duplex            02<sub>H</sub> <b>XBT_FDX</b> Advertise 10BASE-T full duplex            01<sub>H</sub> <b>XBT_HDX</b> Advertise 10BASE-T half duplex</p>

Field	Bits	Type	Description (cont'd)
SF	4:0	RW	<b>Selector Field</b> The selector field is a 5-bit wide field for encoding 32 possible messages. Selector field encoding definitions are shown in IEEE 802.3 Annex 28A. Combinations not specified are reserved for future use. Reserved combinations of the selector field are not to be transmitted. See also IEEE 802.3 28.2.1.2.1. $00001_B$ <b>IEEE802DOT3</b> Select the IEEE 802.3 technology

**Auto-Negotiation Link Partner Ability (Register 0.5)**

IEEE Standard Register=0.5

When the auto-negotiation is complete, this register contains the advertised ability of the link partner. The bit definitions are a direct representation of the received link code word.

STD_AN_LPA										Reset Value		
Auto-Negotiation Link Partner Ability (Register 0.5)										$0000_H$		
15	14	13	12	11	TAF					5	4	0
NP	ACK	RF	XNP							SF		
ro	ro	ro	rw							ro		

Field	Bits	Type	Description
NP	15	RO	<b>Next Page</b> Next page request indication from the link partner. See also IEEE 802.3 28.2.1.2.6. $0_B$ <b>INACTIVE</b> No next page(s) will follow $1_B$ <b>ACTIVE</b> Additional next pages will follow
ACK	14	RO	<b>Acknowledge</b> Acknowledgement indication from the link partner's link code word. See also IEEE 802.3 28.2.1.2.5. $0_B$ <b>INACTIVE</b> The device did not successfully receive its link partner's link code word $1_B$ <b>ACTIVE</b> The device has successfully received its link partner's link code word
RF	13	RO	<b>Remote Fault</b> Remote fault indication from the link partner. See also IEEE 802.3 28.2.1.2.4. $0_B$ <b>NONE</b> Remote fault is not indicated by the link partner $1_B$ <b>FAULT</b> Remote fault is indicated by the link partner
XNP	12	RW	<b>Extended Next Page</b> Indicates that GPY supports transmission of Extended Next Pages (XNP). $0_B$ <b>UNABLE</b> Link partner is XNP unable $1_B$ <b>ABLE</b> Link partner is XNP able

Field	Bits	Type	Description (cont'd)
TAF	11:5	RW	<b>Technology Ability Field</b> $40_H$ <b>PS_ASYM</b> Advertise asymmetric pause $20_H$ <b>PS_SYM</b> Advertise symmetric pause $10_H$ <b>DBT4</b> Advertise 100BASE-T4 $08_H$ <b>DBT_FDX</b> Advertise 100BASE-TX full duplex $04_H$ <b>DBT_HDX</b> Advertise 100BASE-TX half duplex $02_H$ <b>XBT_FDX</b> Advertise 10BASE-T full duplex $01_H$ <b>XBT_HDX</b> Advertise 10BASE-T half duplex
SF	4:0	RO	<b>Selector Field</b> $00001_B$ <b>IEEE802DOT3</b> Select the IEEE 802.3 technology

### Auto-Negotiation Expansion (Register 0.6)

This is the auto-negotiation expansion register indicating the status of the link partner's auto-negotiation. This register is valid only after the auto-negotiation is completed.

See also IEEE 802.3 28.2.4.1.5.

IEEE Standard Register=0.6

STD_AN_EXP										Reset Value		
Auto-Negotiation Expansion (Register 0.6)										$0064_H$		
15										0		
	RES											
	ro											
					7	6	5	4	3	0		
						<b>RNPL A</b>	<b>RNPS L</b>	<b>PDF</b>	<b>LPNP C</b>	<b>NPC</b>	<b>PR</b>	<b>LPAN C</b>
						ro	ro	rolh	ro	ro	rolh	ro

Field	Bits	Type	Description
RES	15:7	RO	<b>Reserved</b> Write as zero, ignore on read.
RNPLA	6	RO	<b>Receive Next Page Location Able</b> Per IEEE 802.3, indicate that the Rx NP location is indicated by field RNPSL $0_B$ <b>UNABLE</b> Received Next Page storage location is not specified by bit (6.5) $1_B$ <b>ABLE</b> Received Next Page storage location is specified by bit (6.5)
RNPSL	5	RO	<b>Receive Next Page Storage Location</b> Per IEEE 802.3, indicate that Rx NP is in register 0.8 for GPY $0_B$ <b>FIVE</b> Link partner Next Pages are stored in Register 5 $1_B$ <b>EIGHT</b> Link partner Next Pages are stored in Register 8
PDF	4	ROLH	<b>Parallel Detection Fault</b> $0_B$ <b>NONE</b> A fault has not been detected via the parallel detection function $1_B$ <b>FAULT</b> A fault has been detected via the parallel detection function

Field	Bits	Type	Description (cont'd)
LPNPC	3	RO	<b>Link Partner Next Page Capable</b> $0_B$ <b>UNABLE</b> Link partner is unable to exchange next pages $1_B$ <b>CAPABLE</b> Link partner is capable of exchanging next pages
NPC	2	RO	<b>Next Page Capable</b> $0_B$ <b>UNABLE</b> GPY is unable to exchange next pages $1_B$ <b>CAPABLE</b> GPY is capable of exchanging next pages
PR	1	ROLH	<b>Page Received</b> $0_B$ <b>NONE</b> A new page has not been received $1_B$ <b>RECEIVED</b> A new page has been received
LPANC	0	RO	<b>Link Partner Auto-Negotiation Capable</b> $0_B$ <b>UNABLE</b> Link partner is unable to auto-negotiate $1_B$ <b>CAPABLE</b> Link partner is auto-negotiation capable

#### Auto-Negotiation Next Page Transmit Register (Register 0.7)

The auto-negotiation next page transmit register contains the next page link code word to be transmitted when next page ability is supported. See also IEEE 802.3 28.2.4.1.6.

IEEE Standard Register=0.7

STD_AN_NPTX							Reset Value
Auto-Negotiation Next Page Transmit Register (Register 0.7)							$2001_H$
15	14	13	12	11	10		0
NP	RES	MP	ACK2	TOGG		MCF	
RW	ro	RW	RW	ro		RW	

Field	Bits	Type	Description
NP	15	RW	<b>Next Page</b> $0_B$ <b>INACTIVE</b> Last page $1_B$ <b>ACTIVE</b> Additional next page(s) will follow
RES	14	RO	<b>Reserved</b> Write as zeroes, ignore on read.
MP	13	RW	<b>Message Page</b> Indicates that the content of MCF is either an unformatted page or a formatted message. $0_B$ <b>UNFOR</b> Unformatted page $1_B$ <b>MESSG</b> Message page
ACK2	12	RW	<b>Acknowledge 2</b> $0_B$ <b>INACTIVE</b> Device cannot comply with message $1_B$ <b>ACTIVE</b> Device will comply with message

Field	Bits	Type	Description (cont'd)
TOGG	11	RO	<b>Toggle</b> This bit always takes the opposite value of the Toggle bit in the previously exchanged link code word. See also IEEE 802.3-2008 28.2.3.4. 0 <sub>B</sub> <b>ZERO</b> Previous value of the transmitted link code word was ONE 1 <sub>B</sub> <b>ONE</b> Previous value of the transmitted link code word was ZERO
MCF	10:0	RW	<b>Message or Unformatted Code Field</b> When Message Page bit is set to 1 (0.7.13), this field is the Message Code Field of a message page used in Next Page exchange. The message codes are described in IEEE 802.3 Appendix 28C. It is used to indicate the type of message in UCF1 and UCF2. 0x0 = Reserved 0x1 = Null message 0x2 = One Unformatted Page (UP) with TAF follows 0x3 = Two UPs with TAF follows 0x4 = Remote fault details message 0x5 = OUI message 0x6 = PHY ID message 0x7 = 100BASE-T2 message 0x8 = 1000BASE-T message 0x9 = MULTIGBASE-T message 0xA = EEE technology capability follows in next UP 0xB = OUI XNP

#### Auto-Negotiation Link Partner Received Next Page Register (Register 0.8)

The auto-negotiation link partner received next page register contains the next page link code word received from the link partner. See also IEEE 802.3 28.2.4.1.7.

IEEE Standard Register=0.8

						Reset Value
Auto-Negotiation Link Partner Received Next Page Register (Register 0.8)						0000 <sub>H</sub>

15	14	13	12	11	10	0
NP	ACK	MP	ACK2	TOGG	MCF	
ro	ro	ro	ro	ro		rw

Field	Bits	Type	Description
NP	15	RO	<b>Next Page</b> See IEEE 802.3 28.2.3.4. 0 <sub>B</sub> <b>INACTIVE</b> No next pages to follow 1 <sub>B</sub> <b>ACTIVE</b> Additional next page(s) will follow

Field	Bits	Type	Description (cont'd)
ACK	14	RO	<p><b>Acknowledge</b> See also IEEE 802.3 28.2.3.4.</p> <p>0<sub>B</sub> <b>INACTIVE</b> The device did not successfully receive its link partner's link code word</p> <p>1<sub>B</sub> <b>ACTIVE</b> The device has successfully received its link partner's link code word</p>
MP	13	RO	<p><b>Message Page</b> Indicates that the content of MCF is either an unformatted page or a formatted message. See also IEEE 802.3 28.2.3.4.</p> <p>0<sub>B</sub> <b>UNFOR</b> Unformatted page</p> <p>1<sub>B</sub> <b>MESSG</b> Message page</p>
ACK2	12	RO	<p><b>Acknowledge 2</b> See also IEEE 802.3 28.2.3.4.</p> <p>0<sub>B</sub> <b>INACTIVE</b> Device cannot comply with message</p> <p>1<sub>B</sub> <b>ACTIVE</b> Device will comply with message</p>
TOGG	11	RO	<p><b>Toggle</b> This bit always takes the opposite value of the Toggle bit in the previously exchanged link code word. See also IEEE 802.3 28.2.3.4.</p> <p>0<sub>B</sub> <b>ZERO</b> Previous value of the transmitted link code word was equal to ONE</p> <p>1<sub>B</sub> <b>ONE</b> Previous value of the transmitted link code word was equal to ZERO</p>
MCF	10:0	RW	<p><b>Message or Unformatted Code Field</b> This field is the Message Code Field of a message page used in Next Page exchange. The message codes are described in IEEE 802.3 Appendix 28C. It is used to indicate the type of message in UCF1 and UCF2.</p> <p>0x0 = Reserved 0x1 = Null message 0x2 = One Unformatted Page (UP) with TAF follows 0x3 = Two UPs with TAF follows 0x4 = Remote fault details message 0x5 = OUI message 0x6 = PHY ID message 0x7 = 100BASE-T2 message 0x8 = 1000BASE-T message 0x9 = MULTIGBASE-T message 0xA = EEE technology capability follows in next UP 0xB = OUI XNP</p>

**Gigabit Control Register (Register 0.9)**

This is the control register used to configure the Gigabit Ethernet behavior of the PHY. See also IEEE 802.3 40.5.1.1.

IEEE Standard Register=0.9

STD_GCTRL								Reset Value
Gigabit Control Register (Register 0.9)								0200 <sub>H</sub>

15	13	12	11	10	9	8	7	0
	TM	MSEN	MS	MSPT	MBTF D	MBTH D		RES
rw	rw	rw	rw	rw	rw	rw		ro

Field	Bits	Type	Description
TM	15:13	RW	<b>Transmitter Test Mode</b> This register field allows enabling of the standard transmitter test modes. See also IEEE 802.3 Table 40-7. 000 <sub>B</sub> <b>NOP</b> Normal operation 001 <sub>B</sub> <b>WAV</b> Test mode 1 transmit waveform test 010 <sub>B</sub> <b>JITM</b> Test mode 2 transmit jitter test in MASTER mode 011 <sub>B</sub> <b>JITS</b> Test mode 3 transmit jitter test in SLAVE mode 100 <sub>B</sub> <b>DIST</b> Test mode 4 transmitter distortion test
MSEN	12	RW	<b>Master/Slave Manual Configuration Enable</b> See also IEEE 802.3 40.5.1.1. 0 <sub>B</sub> <b>DISABLED</b> Disable master/slave manual configuration value 1 <sub>B</sub> <b>ENABLED</b> Enable master/slave manual configuration value
MS	11	RW	<b>Master/Slave Config Value</b> Allows forcing of master or slave mode manually when AN_GCTRL.MSEN is set to logical one. See also IEEE 802.3 40.5.1.1. 0 <sub>B</sub> <b>SLAVE</b> Configure PHY as SLAVE during master/slave negotiation 1 <sub>B</sub> <b>MASTER</b> Configure PHY as MASTER during master/slave negotiation
MSPT	10	RW	<b>Master/Slave Port Type</b> Defines whether the PHY advertises itself as a multi- or single-port device, which in turn impacts the master/slave resolution function. See also IEEE 802.3 40.5.1.1. 0 <sub>B</sub> <b>SPD</b> Single-port device 1 <sub>B</sub> <b>MPD</b> Multi-port device
MBTFD	9	RW	<b>1000BASE-T Full-Duplex</b> Advertises the 1000BASE-T full-duplex capability; always forced to 1 in converter mode. See also IEEE 802.3 40.5.1.1. 0 <sub>B</sub> <b>DISABLED</b> Advertise PHY as not 1000BASE-T full-duplex capable 1 <sub>B</sub> <b>ENABLED</b> Advertise PHY as 1000BASE-T full-duplex capable

Field	Bits	Type	Description (cont'd)
MBTHD	8	RW	<b>1000BASE-T Half-Duplex</b> Always advertises the 1000BASE-T half-duplex capability as disabled; GPY do not support 1000BASE-T Half-Duplex capability 0 <sub>B</sub> <b>DISABLED</b> Advertise PHY as not 1000BASE-T half-duplex capable 1 <sub>B</sub> <b>ENABLED</b> Advertise PHY as 1000BASE-T half-duplex capable
RES	7:0	RO	<b>Reserved</b> Write as zero, ignore on read.

### Gigabit Status Register (Register 0.10)

This is the status register used to reflect the Gigabit Ethernet status of the PHY. See also IEEE 802.3 40.5.1.1. IEEE Standard Register=0.10

STD_GSTAT										Reset Value
Gigabit Status Register (Register 0.10)										0000 <sub>H</sub>
15	14	13	12	11	10	9	8	7	0	
MSFA ULT	MSRE S	LRXS TAT	RRXS TAT	MBTF D	MBTH D	RES				IEC
rwsc	ro	ro	ro	ro	ro	ro				rwsc

Field	Bits	Type	Description
MSFAULT	15	RWSC	<b>Master/Slave Manual Configuration Fault</b> This bit will be set if the number of failed MASTER-SLAVE resolutions reaches 7 It is cleared upon each read of GSTAT. This bit self clears on auto-negotiation enable or auto-negotiation complete. 0 <sub>B</sub> <b>OK</b> Master/slave manual configuration resolved successfully 1 <sub>B</sub> <b>NOK</b> Master/slave manual configuration resolved with a fault
MSRES	14	RO	<b>Master/Slave Configuration Resolution</b> 0 <sub>B</sub> <b>SLAVE</b> Local PHY configuration resolved to SLAVE 1 <sub>B</sub> <b>MASTER</b> Local PHY configuration resolved to MASTER
LRXSTAT	13	RO	<b>Local Receiver Status</b> Indicates the status of the local receiver. See also IEEE 802.3 40.5.1.1 register 10 in Table 40-3. 0 <sub>B</sub> <b>NOK</b> Local receiver not OK 1 <sub>B</sub> <b>OK</b> Local receiver OK
RRXSTAT	12	RO	<b>Remote Receiver Status</b> Indicates the status of the remote receiver. See also IEEE 802.3 40.5.1.1 register 10 in Table 40-3. 0 <sub>B</sub> <b>NOK</b> Remote receiver not OK 1 <sub>B</sub> <b>OK</b> Remote receiver OK

Field	Bits	Type	Description (cont'd)
MBTFD	11	RO	<b>Link Partner Capable of Operating 1000BASE-T Full-Duplex</b> See also IEEE 802.3 40.5.1.1 register 10 in Table 40-3. 0 <sub>B</sub> <b>DISABLED</b> Link partner is not capable of operating 1000BASE-T full-duplex 1 <sub>B</sub> <b>ENABLED</b> Link partner is capable of operating 1000BASE-T full-duplex
MBTHD	10	RO	<b>Link Partner Capable of Operating 1000BASE-T Half-Duplex</b> See also IEEE 802.3 40.5.1.1 register 10 in Table 40-3. 0 <sub>B</sub> <b>DISABLED</b> Link partner is not capable of operating 1000BASE-T half-duplex 1 <sub>B</sub> <b>ENABLED</b> Link partner is capable of operating 1000BASE-T half-duplex
RES	9:8	RO	<b>Reserved</b> Write as zero, ignore on read.
IEC	7:0	RWSC	<b>Idle Error Count</b> Indicates the idle error count. This field contains a cumulative count of the errors detected when the receiver is receiving idles .

### MMD Access Control Register (Register 0.13)

The MMD access control register is used in conjunction with the MMDDATA register to access the MMD register space. This uses address directing as specified in IEEE 802.3 Clause 22 Extended.

IEEE Standard Register=0.13

STD_MMDCTRL								Reset Value
MMD Access Control Register (Register 0.13)								0000 <sub>H</sub>
15	14	13		8	7	5	4	0
<b>ACTYPE</b>	<b>RESH</b>			<b>RESL</b>	<b>DEVAD</b>			
rw		ro		ro		ro	rw	

Field	Bits	Type	Description
ACTYPE	15:14	RW	<b>Access Type Function</b> If the access of register MMDDATA is an address access (ACTYPE=0) then it is directed to the address register within the MMD associated with the value in the DEVAD field. Otherwise, both the DEVAD field and the MMD's address register direct the register MMDDATA data accesses to the appropriate registers within that MMD. 00 <sub>B</sub> <b>ADDRESS</b> Accesses to register MMDDATA access the MMD individual address register 01 <sub>B</sub> <b>DATA</b> Accesses to register MMDDATA access the register within the MMD selected 10 <sub>B</sub> <b>DATA_PI</b> Accesses to register MMDDATA access the register within the MMD selected 11 <sub>B</sub> <b>DATA_PIWR</b> Accesses to register MMDDATA access the register within the MMD selected

Field	Bits	Type	Description (cont'd)
RESH	13:8	RO	<b>Reserved</b> Write as zero, ignored on read.
RESL	7:5	RO	<b>Reserved</b> Write as zero, ignored on read.
DEVAD	4:0	RW	<b>Device Address</b> The DEVAD field directs any accesses of register MMDDATA to the appropriate MMD as described in IEEE 802.3 Clause 45.2.

#### MMD Access Data Register (Register 0.14)

The MMD access data register is used in conjunction with the MMD access control (MMDCTRL) register to access the MMD register space. For more information on MMD access, refer to IEEE 802.3 Clause 22.2.4.3.12, Clause 45.2 and Annex 22D.

IEEE Standard Register=0.14

STD_MMDDATA		Reset Value
MMD Access Data Register (Register 0.14)		0000 <sub>H</sub>
15		0
	ADDR_DATA	
		RW

Field	Bits	Type	Description
ADDR_DATA	15:0	RW	<b>Address or Data Register</b> This register accesses either a specific MMD address register or the data content of the MMD register to which this address register points. Which of the functions is currently valid is defined by the MMDCTRL register.

#### Extended Status Register (Register 0.15)

This register contains extended status and capability information about the PHY. Note that all bits are read-only. A write access does not have any effect.

IEEE Standard Register=0.15

STD_XSTAT		Reset Value
Extended Status Register (Register 0.15)		2000 <sub>H</sub>
15	14	0
13	12	0
11	8	0
MBXF	MBXH	RESL
ro	ro	ro
ro	ro	ro
ro	ro	ro

Field	Bits	Type	Description
MBXF	15	RO	<b>1000BASE-X Full-Duplex Capability</b> Specifies whether the PHY is capable of operating 1000BASE-X full-duplex. 0 <sub>B</sub> <b>DISABLED</b> PHY does not support this mode 1 <sub>B</sub> <b>ENABLED</b> PHY supports this mode
MBXH	14	RO	<b>1000BASE-X Half-Duplex Capability</b> Specifies whether the PHY is capable of operating 1000BASE-X half-duplex. 0 <sub>B</sub> <b>DISABLED</b> PHY does not support this mode 1 <sub>B</sub> <b>ENABLED</b> PHY supports this mode
MBTF	13	RO	<b>1000BASE-T Full-Duplex Capability</b> Specifies whether the PHY is capable of operating 1000BASE-T full-duplex. 0 <sub>B</sub> <b>DISABLED</b> PHY does not support this mode 1 <sub>B</sub> <b>ENABLED</b> PHY supports this mode
MBTH	12	RO	<b>1000BASE-T Half-Duplex Capability</b> GPY do not support 1000BASE-T Half-Duplex capability. 0 <sub>B</sub> <b>DISABLED</b> PHY does not support this mode 1 <sub>B</sub> <b>ENABLED</b> PHY supports this mode
RESH	11:8	RO	<b>Reserved</b> Ignore when read.
RESL	7:0	RO	<b>Reserved</b> Ignore when read.

## 5.2 GPY-specific Management Registers

This section describes the GPY specific management registers in device 0.

**Table 18 Registers Overview**

Register Short Name	Register Long Name	Reset Value
<b>PHY_STAT1</b>	Physical Layer Status 1 (Register 0.17)	0000 <sub>H</sub>
<b>PHY_CTL1</b>	Physical Layer Control 1 (Register 0.19)	0001 <sub>H</sub>
<b>PHY_CTL2</b>	Physical Layer Control 2 (Register 0.20)	0006 <sub>H</sub>
<b>PHY_ERRCNT</b>	Error Counter (Register 0.21)	0000 <sub>H</sub>
<b>PHY_MIISTAT</b>	Media-Independent Interface Status (Register 0.24)	0000 <sub>H</sub>
<b>PHY_IMASK</b>	Interrupt Mask Register (Register 0.25)	0000 <sub>H</sub>
<b>PHY_ISTAT</b>	Interrupt Status Register (Register 0.26)	0000 <sub>H</sub>
<b>PHY_LED</b>	LED Control Register (Register 0.27)	FF00 <sub>H</sub>
<b>PHY_FWV</b>	Firmware Version Register (Register 0.30)	8CB6 <sub>H</sub>
<b>PHY_TEST</b>	Internal Test Mode ABIST (Register 0.31)	0000 <sub>H</sub>

### 5.2.1 GPY-specific Management Registers

This chapter describes all registers of PHY in detail.

#### Physical Layer Status 1 (Register 0.17)

This register reports PHY link information, for example link-up, polarity reversals and port mapping. The content of this register is only valid when the link is up.

IEEE Standard Register=0.17

PHY_STAT1	Physical Layer Status 1 (Register 0.17)	Reset Value
		0000 <sub>H</sub>

15	9	8	7	4	3	2	1	0
	RES2		LSAD S		Res		FW_MEM	RES1
ro		rosc				rw		ro

Field	Bits	Type	Description
RES2	15:9	RO	<b>Reserved</b> Write as zero, ignored on read.
LSADS	8	ROSC	<b>Link Speed Auto-Downspeed Status</b> Monitors the status of the auto-downspeed. 0 <sub>B</sub> <b>NORMAL</b> Did not perform any link speed auto-downspeed 1 <sub>B</sub> <b>DETECTED</b> Detected an auto-downspeed

Field	Bits	Type	Description (cont'd)
FW_MEM	3:2	RW	<b>Firmware Memory Location</b> Indicate memory target used for firmware execution 00 <sub>B</sub> <b>ROM</b> Firmware is executed from ROM 11 <sub>B</sub> <b>RAM</b> Firmware is executed from SRAM Others: Reserved.
RES1	1:0	RO	<b>Reserved</b> Write as zero, ignored on read.

### Physical Layer Control 1 (Register 0.19)

This register controls the PHY functions.

IEEE Standard Register=0.19

PHY_CTL1															Reset Value
Physical Layer Control 1 (Register 0.19)															0001 <sub>H</sub>
15	13	12	11		8	7	6	5	4	3	2	1	0		
	TLOOP		Res		TXADJ		POLD	POLC	POLB	POLA	MDIC D	MDIA B	RES	AMDIX	
rw				rw		rw	rw	rw	rw	rw	rw	rw	ro	rw	

Field	Bits	Type	Description
TLOOP	15:13	RW	<b>Test Loop</b> Configures predefined test loops. 000 <sub>B</sub> <b>OFF</b> Test loops are switched off - normal operation. 001 <sub>B</sub> <b>NETL</b> Near-end test loop 010 <sub>B</sub> <b>FETL</b> Far-end test loop Others: Reserved.
TXADJ	11:8	RW	<b>Transmit Level Adjustment</b> Transmit-level adjustment is used to fine tune the transmit amplitude of the PHY. The amplitude adjustment is valid for all supported speed modes. The adjustment is performed in digits. One digit represents 3.125 percent of the nominal amplitude. The scaling factor is gain = 1 + signed(TXADJ)*2 <sup>-7</sup> .
POLD	7	RW	<b>Polarity Inversion Control on Port D</b> 0 <sub>B</sub> <b>NORMAL</b> Polarity normal 1 <sub>B</sub> <b>INVERTED</b> Polarity inversion
POLC	6	RW	<b>Polarity Inversion Control on Port C</b> 0 <sub>B</sub> <b>NORMAL</b> Polarity normal 1 <sub>B</sub> <b>INVERTED</b> Polarity inversion
POLB	5	RW	<b>Polarity Inversion Control on Port B</b> 0 <sub>B</sub> <b>NORMAL</b> Polarity normal 1 <sub>B</sub> <b>INVERTED</b> Polarity inversion

Field	Bits	Type	Description (cont'd)
POLA	4	RW	<b>Polarity Inversion Control on Port A</b> 0 <sub>B</sub> <b>NORMAL</b> Polarity normal 1 <sub>B</sub> <b>INVERTED</b> Polarity inversion
MDICD	3	RW	<b>Mapping of MDI Ports C and D</b> Used when Auto-MDIX is OFF, to force the MDIX cable crossover configuration 0 <sub>B</sub> <b>MDI</b> Normal MDI mode 1 <sub>B</sub> <b>MDIX</b> Crossover MDI-X mode
MDIAB	2	RW	<b>Mapping of MDI Ports A and B</b> Used when Auto-MDIX is OFF, to force the MDIX cable crossover configuration 0 <sub>B</sub> <b>MDI</b> Normal MDI mode 1 <sub>B</sub> <b>MDIX</b> Crossover MDI-X mode
RES	1	RO	<b>Reserved</b>
AMDIX	0	RW	<b>PHY Performs Auto-MDI/MDI-X or Uses Manual MDI/MDI-X</b> 0 <sub>B</sub> <b>MANUAL</b> PHY uses manual MDI/MDI-X 1 <sub>B</sub> <b>AUTO</b> PHY performs Auto-MDI/MDI-X

### Physical Layer Control 2 (Register 0.20)

This register controls the PHY functions.

IEEE Standard Register=0.20

PHY_CTL2	Reset Value
<b>Physical Layer Control 2 (Register 0.20)</b>	<b>0006<sub>H</sub></b>

15	Res	10	9	8	7	5	4	3	2	1	0
			SDET P	STICKY	RES1	LP_ST A*	LP	PSCL	ANPD	LPI	
			rw	rw	ro	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
SDETP	9	RW	<b>Signal Detection Polarity for the 1000BASE-X PHY</b> This field is reserved as 1000BASE-X is not supported on this PHY port.
STICKY	8	RW	<b>Sticky-Bit Handling</b> Setting this bit to 1 ensures that all the vendor specific registers (of type RW) in PHY ( device 0 ), VSPEC1 ( device 30 ) and VSPEC2 ( device 31 ) are not changed during a MDIO reset or software reset of GPY. This allows the STA to keep the configurations chosen before reset. 0 <sub>B</sub> <b>OFF</b> Sticky-bit handling is disabled 1 <sub>B</sub> <b>ON</b> Sticky-bit handling is enabled
RES1	7:5	RO	<b>Reserved</b> Write as zero, ignored on read.

Field	Bits	Type	Description (cont'd)
LP_STA_BLO CK	4	RW	<p><b>Low Power Mode entry block by acknowledgment from STA</b>  Low Power Mode entry block by acknowledgment from STA  When PHY_IMASK.LP = ACTIVE, intent to LP entry is indicated to STA. For the GPY to enter unconditionally without acknowledgment from STA, set PHY_CTL2.LP_STA_BLOCK = OFF.  For blocking LP entry till the acknowledgment is received from STA, set PHY_CTL2.LP_STA_BLOCK = ON.  This bit has no effect when PHY_IMASK.LP = INACTIVE.  0<sub>B</sub> <b>OFF</b> LP Entry without the role of STA. GPY will enter LP unconditionally without acknowledgment from STA  1<sub>B</sub> <b>ON</b> LP Entry Blocked by STA. GPY will enter LP only after STA reads the LP interrupt status register PHY_ISTAT</p>
LP	3	RW	<p><b>Low Power Mode</b>  Low Power Mode (LP) allows GPY to save energy by disabling most of the digital logic to reduce power consumption to its lowest level. The entry to LP is triggered when the PHY does not sense any energy on the cable and that no Link pulses (NLP, FLP, Beacons) are received. After spending VSPEC1_NBT_DS_CTRL.NRG_RST_CNT without energy in the ABILITY_DETECT state defined by IEEE 802.3 Clause 28, the PHY enters LP.  0<sub>B</sub> <b>OFF</b> LP is Disabled. GPY will not never enter LP.  1<sub>B</sub> <b>ON</b> LP is Enabled. GPY will enter LP is no energy</p>
PSCL	2	RW	<p><b>Power Consumption Scaling Depending on Link Quality</b>  Allows enabling/disabling of the power consumption scaling dependent on the link quality.  0<sub>B</sub> <b>OFF</b> PSCL is disabled  1<sub>B</sub> <b>ON</b> PSCL is enabled</p>
ANPD	1	RW	<p><b>Auto-Negotiation Power Down</b>  Allows enabling/disabling of the power down modes during auto-negotiation looking for a link partner.  0<sub>B</sub> <b>OFF</b> ANPD is disabled  1<sub>B</sub> <b>ON</b> ANPD is enabled</p>
LPI	0	RW	<p><b>Assert LPI via MDIO</b>  Controls Asserts/de-asserts of LPI by MDIO instead of following (X)GMII LPI  Used to force the EEE on the TPI (ignoring the LPI indication from MAC)  0<sub>B</sub> <b>DEASSERT</b> LPI is de-asserted TPI  1<sub>B</sub> <b>ASSERT</b> LPI is asserted on TPI</p>

## Error Counter (Register 0.21)

This register controls the error counter. It allows the number of errors detected in the PHY to be counted for monitoring purposes.

IEEE Standard Register=0.21

PHY_ERRCNT	Reset Value
Error Counter (Register 0.21)	$0000_H$
15	
12	
11	
SEL	
8	
7	
0	
RES	
r0	
rw	
COUNT	
rosc	

Field	Bits	Type	Description
RES	15:12	RO	<b>Reserved</b> Write as zero, ignored on read.
SEL	11:8	RW	<b>Select Error Event</b> Configures which error type the error counter counts $0000_B$ <b>RXERR</b> Receive errors are counted $0001_B$ <b>RXACT</b> Receive frames are counted $0010_B$ <b>ESDERR</b> ESD errors are counted $0011_B$ <b>SSDERR</b> SSD errors are counted $0100_B$ <b>TXERR</b> Transmit errors are counted $0101_B$ <b>TXACT</b> Transmit frames events get counted $0110_B$ <b>COL</b> Collision events get counted $1000_B$ <b>NLD</b> Number of Link Down events get counted $1001_B$ <b>NDS</b> Number of auto-downspeed events get counted $1010_B$ <b>CRC</b> CRC counter $1011_B$ <b>TTL</b> Time to Link
COUNT	7:0	ROSC	<b>Counter Value</b> This counter value is updated each time the selected error event has been detected. The counter value is reset every time a read operation on this register is performed or the error event is changed. The counter saturates at value 0xFF.

**Media-Independent Interface Status (Register 0.24)**

This register contains status information on the Ethernet link, concatenated in a single register to allow concise status read by the STA in a single register.

IEEE Standard Register=0.24

PHY_MIISTAT	Reset Value
<b>Media-Independent Interface Status (Register 0.24)</b>	<b>0000<sub>H</sub></b>

15	11	10	9	8	7	6	5	4	3	2	0
			<b>RES2</b>	<b>LS</b>	<b>MSRES</b>	<b>EEE</b>	<b>RES1</b>		<b>PS</b>	<b>DPX</b>	<b>SPEED</b>
ro		roll	ro	ro	ro	ro	ro	ro	ro	ro	ro

Field	Bits	Type	Description
RES2	15:11	RO	<b>Reserved</b> Write as zero, ignored on read.
LS	10	ROLL	<b>Link Status at which GPY Ethernet PHY Operates</b> Indicates the link status of the PHY 0 <sub>B</sub> <b>INACTIVE</b> The link is down.No communication with link partner possible. 1 <sub>B</sub> <b>ACTIVE</b> The link is up.Data communication with link partner is possible.
MSRES	9	RO	<b>Master/Slave Configuration</b> Master/Slave Configuration 0 <sub>B</sub> <b>SLAVE</b> Local PHY configuration is SLAVE after ANEG 1 <sub>B</sub> <b>MASTER</b> Local PHY configuration is MASTER after ANEG
EEE	8	RO	<b>Energy-Efficient Ethernet Mode</b> 0 <sub>B</sub> <b>OFF</b> EEE is disabled after auto-negotiation resolution 1 <sub>B</sub> <b>ON</b> EEE is enabled after auto-negotiation resolution
RES1	7:6	RO	<b>Reserved</b>
PS	5:4	RO	<b>Pause Status for Flow Control</b> 00 <sub>B</sub> <b>NONE</b> No PAUSE 01 <sub>B</sub> <b>TX</b> Transmit PAUSE 10 <sub>B</sub> <b>RX</b> Receive PAUSE 11 <sub>B</sub> <b>TXRX</b> Both transmit and receive PAUSE
DPX	3	RO	<b>GPY Ethernet PHY Duplex Mode</b> 0 <sub>B</sub> <b>HDX</b> Half duplex 1 <sub>B</sub> <b>FDX</b> Full duplex
SPEED	2:0	RO	<b>GPY Ethernet PHY Speed</b> GPY doesn't support 2.5G speed as this is 1G product 000 <sub>B</sub> <b>TEN</b> 10 Mbit/s 001 <sub>B</sub> <b>FAST</b> 100 Mbit/s 010 <sub>B</sub> <b>GIGA</b> 1000 Mbit/s 011 <sub>B</sub> <b>ANEG</b> Autonegotiation mode 100 <sub>B</sub> <b>BZ2G5</b> 2.5Gbit/s

### Interrupt Mask Register (Register 0.25)

This register defines the mask for the Interrupt Status Register (ISTAT) which contains the event source for the MDINT interrupt sent from GPY to an external chip.

The information about the interrupt source is indicated in the ISTAT register.

IEEE Standard Register=0.25

PHY_IMASK																	Reset Value
Interrupt Mask Register (Register 0.25)																	0000 <sub>H</sub>

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
WOL	MSRE	NPRX	NPTX	ANE	ANC	Res	Res	LP	TEMP	ADSC	MDIPC	MDIXC	DXMC	LSPC	LSTC	
rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

Field	Bits	Type	Description
WOL	15	RW	<b>Wake-on-LAN Event Mask</b> When active and masked in IMASK, the MDINT is activated upon detection of a valid Wake-on-LAN event. 0 <sub>B</sub> <b>INACTIVE</b> Interrupt is masked out 1 <sub>B</sub> <b>ACTIVE</b> Interrupt is activated
MSRE	14	RW	<b>Master/Slave Resolution Error Mask</b> When active, MDINT is activated upon detection of a master/slave resolution error during a 1000BASE-T auto-negotiation. 0 <sub>B</sub> <b>INACTIVE</b> Interrupt is masked out 1 <sub>B</sub> <b>ACTIVE</b> Interrupt is activated
NPRX	13	RW	<b>Next Page Received Mask</b> When active, MDINT is activated upon reception of a next page in STD.AN_NPRX. 0 <sub>B</sub> <b>INACTIVE</b> Interrupt is masked out 1 <sub>B</sub> <b>ACTIVE</b> Interrupt is activated
NPTX	12	RW	<b>Next Page Transmitted Mask</b> When active, MDINT is activated upon transmission of the currently stored next page in STD.AN_NPTX. 0 <sub>B</sub> <b>INACTIVE</b> Interrupt is masked out 1 <sub>B</sub> <b>ACTIVE</b> Interrupt is activated
ANE	11	RW	<b>Auto-Negotiation Error Mask</b> When active, MDINT is activated upon detection of an auto-negotiation error. 0 <sub>B</sub> <b>INACTIVE</b> Interrupt is masked out 1 <sub>B</sub> <b>ACTIVE</b> Interrupt is activated
ANC	10	RW	<b>Auto-Negotiation Complete Mask</b> When active, MDINT is activated upon completion of the auto-negotiation process. 0 <sub>B</sub> <b>INACTIVE</b> Interrupt is masked out 1 <sub>B</sub> <b>ACTIVE</b> Interrupt is activated

Field	Bits	Type	Description (cont'd)
LP	7	RW	<p><b>LP Entry Indication Mask</b></p> <p>0<sub>B</sub> <b>INACTIVE</b> Interrupt is masked out. STA does not need to be informed of the event</p> <p>1<sub>B</sub> <b>ACTIVE</b> Interrupt is activated. STA receives MDINT when PHY is about to enter LP. Then the condition to LP Entry to is based on <b>PHY_CTL2.LP_STA_BLOCK</b>.</p>
TEMP	6	RW	<p><b>TEMP</b></p> <p>0<sub>B</sub> <b>INACTIVE</b> Interrupt is masked out. STA does not require to be informed of the event</p> <p>1<sub>B</sub> <b>ACTIVE</b> Interrupt is activated. Interrupt is raised when temperature goes beyond Normal Operating Range</p>
ADSC	5	RW	<p><b>Link Speed Auto-Downspeed Detect Mask</b></p> <p>When active, MDINT is activated upon detection of a link speed auto-downspeed event.</p> <p>0<sub>B</sub> <b>INACTIVE</b> Interrupt is masked out</p> <p>1<sub>B</sub> <b>ACTIVE</b> Interrupt is activated</p>
MDIPC	4	RW	<p><b>MDI Polarity Change Detect Mask</b></p> <p>When active, MDINT is activated upon detection of an MDI polarity change event.</p> <p>0<sub>B</sub> <b>INACTIVE</b> Interrupt is masked out</p> <p>1<sub>B</sub> <b>ACTIVE</b> Interrupt is activated</p>
MDIXC	3	RW	<p><b>MDIX Change Detect Mask</b></p> <p>When active, MDINT is activated upon detection of an MDI/MDIX cross-over change event.</p> <p>0<sub>B</sub> <b>INACTIVE</b> Interrupt is masked out</p> <p>1<sub>B</sub> <b>ACTIVE</b> Interrupt is activated</p>
DXMC	2	RW	<p><b>Duplex Mode Change Mask</b></p> <p>When active, MDINT is activated upon detection of full- or half-duplex change.</p> <p>0<sub>B</sub> <b>INACTIVE</b> Interrupt is masked out</p> <p>1<sub>B</sub> <b>ACTIVE</b> Interrupt is activated</p>
LSPC	1	RW	<p><b>Link Speed Change Mask</b></p> <p>When active, MDINT is activated upon detection of link speed change.</p> <p>0<sub>B</sub> <b>INACTIVE</b> Interrupt is masked out</p> <p>1<sub>B</sub> <b>ACTIVE</b> Interrupt is activated</p>
LSTC	0	RW	<p><b>Link State Change Mask</b></p> <p>When active, MDINT is activated upon detection of link status change.</p> <p>0<sub>B</sub> <b>INACTIVE</b> Interrupt is masked out</p> <p>1<sub>B</sub> <b>ACTIVE</b> Interrupt is activated</p>

**Interrupt Status Register (Register 0.26)**

This register defines the event source for the MDINT interrupt sent from GPY to an external chip.

PHY\_ISTAT is a cleared on read by the STA.

IEEE Standard Register=0.26

PHY_ISTAT																	Reset Value
Interrupt Status Register (Register 0.26)																	0000 <sub>H</sub>

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
WOL	MSRE	NPRX	NPTX	ANE	ANC	Res	Res	LP	TEMP	ADSC	MDIPC	MDIXC	DXMC	LSPC	LSTC	

Field	Bits	Type	Description
WOL	15	ROSC	<b>Wake-on-LAN Interrupt Status</b> When bit is set, the MDINT is activated upon detection of a valid Wake-on-LAN event. 0 <sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source 1 <sub>B</sub> <b>ACTIVE</b> WoL event is the source of the interrupt
MSRE	14	ROSC	<b>Master/Slave Resolution Error Interrupt Status</b> When bit is set, the MDINT is activated upon detection of a master/slave resolution error during a 1000BASE-T auto-negotiation. 0 <sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source 1 <sub>B</sub> <b>ACTIVE</b> MSRE event is the source of the interrupt
NPRX	13	ROSC	<b>Next Page Received Interrupt Status</b> When bit is set, the MDINT is activated upon reception of a next page in STD.AN_NPRX. 0 <sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source 1 <sub>B</sub> <b>ACTIVE</b> NPRX event is the source of the interrupt
NPTX	12	ROSC	<b>Next Page Transmitted Interrupt Status</b> When bit is set, the MDINT is activated upon transmission of the currently stored next page in STD.AN_NPTX. 0 <sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source 1 <sub>B</sub> <b>ACTIVE</b> NPTX event is the source of the interrupt
ANE	11	ROSC	<b>Auto-Negotiation Error Interrupt Status</b> When bit is set, the MDINT is activated upon detection of an auto-negotiation error. 0 <sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source 1 <sub>B</sub> <b>ACTIVE</b> ANEG error event is the source of the interrupt
ANC	10	ROSC	<b>Auto-Negotiation Complete Interrupt Status</b> When bit is set, the MDINT is activated upon completion of the auto-negotiation process. 0 <sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source 1 <sub>B</sub> <b>ACTIVE</b> ANEG complete event is the source of the interrupt

Field	Bits	Type	Description (cont'd)
LP	7	ROSC	<p><b>LP Entry Indication</b></p> <p>0<sub>B</sub> <b>INACTIVE</b> No indication of LP entry</p> <p>1<sub>B</sub> <b>ACTIVE</b> Indication of LP Entry. Entry to LP is delayed until the STA has read PHY_ISTAT or not is based on PHY_CTL2.LP_STA_BLOCK.</p>
TEMP	6	ROSC	<p><b>TEMP</b></p> <p>Indicate a Thermal Mitigation action must be taken when the temperature goes beyond Operating Range. It is recommended that the SoC initiates a link-down and change speed capability to reduce go back to normal thermal Range. When the temperature reaches the Maximum Absolute Ratings, the GPY resets for safety purpose. Thermal mitigation must ensure that the temperature maximum absolute ratings are never reached.</p> <p>0<sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source</p> <p>1<sub>B</sub> <b>ACTIVE</b> TEMP Change event is the source of the interrupt</p>
ADSC	5	ROSC	<p><b>Link Speed Auto-Downspeed Detect Interrupt Status</b></p> <p>When bit is set, the MDINT is activated upon detection of a link speed auto-downspeed event.</p> <p>0<sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source</p> <p>1<sub>B</sub> <b>ACTIVE</b> ADSC Change event is the source of the interrupt</p>
MDIPC	4	ROSC	<p><b>MDI Polarity Change Detect Interrupt Status</b></p> <p>When bit is set, the MDINT is activated upon detection of an MDI polarity change event.</p> <p>0<sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source</p> <p>1<sub>B</sub> <b>ACTIVE</b> MDIPC Change event is the source of the interrupt</p>
MDIXC	3	ROSC	<p><b>MDIX Change Detect Interrupt Status</b></p> <p>When bit is set, the MDINT is activated upon detection of an MDI/MDIX cross-over change event.</p> <p>0<sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source</p> <p>1<sub>B</sub> <b>ACTIVE</b> MDIX Change event is the source of the interrupt</p>
DXMC	2	ROSC	<p><b>Duplex Mode Change Interrupt Status</b></p> <p>When bit is set, the MDINT is activated upon detection of a full or half-duplex change.</p> <p>0<sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source</p> <p>1<sub>B</sub> <b>ACTIVE</b> Duplex Mode Change event is the source of the interrupt</p>
LSPC	1	ROSC	<p><b>Link Speed Change Interrupt Status</b></p> <p>When bit is set, the MDINT is activated upon detection of link speed change.</p> <p>0<sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source</p> <p>1<sub>B</sub> <b>ACTIVE</b> Link Speed Change event is the source of the interrupt</p>
LSTC	0	ROSC	<p><b>Link State Change Interrupt Status</b></p> <p>When bit is set, the MDINT is activated upon detection of link status change.</p> <p>0<sub>B</sub> <b>INACTIVE</b> This event is not the interrupt source</p> <p>1<sub>B</sub> <b>ACTIVE</b> Link State Change event is the source of the interrupt</p>

**LED Control Register (Register 0.27)**

This register contains control bits for direct access to the LEDs by setting the on/off LEDxA bits ( with x from 0 to 4).

To directly control the LED, the integrated LED functions must be disabled by the LEDxEN bit in this register.

The integrated LED functions are specified in the more sophisticated LED control registers in MMD device VSPEC1.

IEEE Standard Register=0.27

PHY_LED														Reset Value
LED Control Register (Register 0.27)														FF00 <sub>H</sub>
15	12	11	10	9	8	7		4	3	2	1	0		
RES	RES	RES	LED2E N	LED1E N	LED0E N		RES1		RES	LED2 DA	LED1 DA	LED0 DA		
rw	rw	rw	rw	rw	rw		ro		rw	rw	rw	rw		

Field	Bits	Type	Description
LED2EN	10	RW	<b>Enable Integrated Function of LED2</b> Write a 0 to this bit to disable the pre-configured integrated function for this LED. The LED remains off unless directly accessed via LED2DA. 0 <sub>B</sub> <b>DISABLE</b> Disables the integrated LED function 1 <sub>B</sub> <b>ENABLE</b> Enables the integrated LED function
LED1EN	9	RW	<b>Enable Integrated Function of LED1</b> Write a 0 to this bit to disable the pre-configured integrated function for this LED. The LED remains off unless directly accessed via LED1DA. 0 <sub>B</sub> <b>DISABLE</b> Disables the integrated LED function 1 <sub>B</sub> <b>ENABLE</b> Enables the integrated LED function
LED0EN	8	RW	<b>Enable Integrated Function of LED0</b> Write a 0 to this bit to disable the pre-configured integrated function for this LED. The LED remains off unless directly accessed via LED0DA. 0 <sub>B</sub> <b>DISABLE</b> Disables the integrated LED function 1 <sub>B</sub> <b>ENABLE</b> Enables the integrated LED function
RES1	7:4	RO	<b>Reserved</b> Write as zero, ignored on read.
LED2DA	2	RW	<b>Direct Access to LED2</b> Write a 1 to this bit to illuminate the LED. Note that LED2EN must be set to zero. 0 <sub>B</sub> <b>OFF</b> Switch off the LED 1 <sub>B</sub> <b>ON</b> Switch on the LED
LED1DA	1	RW	<b>Direct Access to LED1</b> Write a 1 to this bit to illuminate the LED. Note that LED1EN must be set to zero. 0 <sub>B</sub> <b>OFF</b> Switch off the LED 1 <sub>B</sub> <b>ON</b> Switch on the LED

Field	Bits	Type	Description (cont'd)
LED0DA	0	RW	<p><b>Direct Access to LED0</b></p> <p>Write a 1 to this bit to illuminate the LED. Note that LED0EN must be set to zero.</p> <p><math>0_B</math> <b>OFF</b> Switch off the LED</p> <p><math>1_B</math> <b>ON</b> Switch on the LED</p>

## Firmware Version Register (Register 0.30)

This register contains the version of the PHY firmware. The version number is initialized at boot time by the firmware with its current software version. This register is read-only by the external STA.

IEEE Standard Register=0.30

PHY_FWV	Reset Value
Firmware Version Register (Register 0.30)	8CB6 <sub>H</sub>

15 14 MAJOR 8 7 MINOR 0

REL RO RO RO

Field	Bits	Type	Description
REL	15	RO	<p><b>Release Indication</b></p> <p>This parameter indicates either a test or a release version.</p> <p><math>0_B</math> <b>TEST</b> Indicates a test version</p> <p><math>1_B</math> <b>RELEASE</b> Indicates a released version</p>
MAJOR	14:8	RO	<p><b>Major Version Number</b></p> <p>Specifies the main version release number of the firmware.</p>
MINOR	7:0	RO	<p><b>Minor Version Number</b></p> <p>Specifies the sub-version release number of the firmware.</p>

## Internal Test Mode ABIST (Register 0.31)

This is the control register used to configure the Gigabit Ethernet behavior of the PHY. See also IEEE 802.3 40.5.1.1.

## IEEE Standard Register=0.31

PHY_TEST										Reset Value
Internal Test Mode ABIST (Register 0.31)										0000 <sub>H</sub>
15	13	12	RES	8	7	6	5	4	3	0
TM				ABUA RT	ABRE T		ABSEL			ABOPT
RW			RW	RW	RW	RW	RW			RW

Field	Bits	Type	Description
TM	15:13	RW	<b>Proprietary Test Mode ABIST</b> Enter the test mode. Any value different from 7 has no effect. $111_B$ <b>ABIST</b> GPY specific Analog build in self-test Others: Reserved.
RES	12:8	RW	<b>Reserved</b>
ABUART	7	RW	<b>ABIST UART output for debug</b> If set to 1, enable detail report on the debug UART output. This is used to debug the feature and not in production mode, because in that case the 2 LED signals are not used to indicate completion or pass fail. An alternative to UART is to read the STB via MDIO commands. $0_B$ <b>NORMAL</b> ABIST normal output $1_B$ <b>UART</b> ABIST output to UART
ABRET	6	RW	<b>ABIST ReTrig</b> If set to 1, enable restart of the selected ABIST test. This is used to debug the feature and not in production mode $0_B$ <b>NORMAL</b> Normal Mode $1_B$ <b>RETRIG</b> Restart the current ABIST Test
ABSEL	5:4	RW	<b>ABIST sub-mode selection</b> $00_B$ , ABIST Analog Tests $01_B$ , ABIST DC tests $10_B$ , reserved $11_B$ , reserved $00_B$ <b>ANALOG</b> ABIST Analog Tests $01_B$ <b>DC</b> ABIST DC Tests
ABOPT	3:0	RW	<b>ABIST Option for DC test</b> In ABIST DC test $0000$ , ABIST DC test for 10BT mode LD, max positive differential level $0001$ , ABIST DC test for 1000BT mode LD, max positive differential level $0010$ , ABIST DC test for 10BT mode LD, 0 differential level $0011$ , ABIST DC test for 1000BT mode LD, 0 differential level $0100$ , ABIST DC test for 10BT mode LD, max negative differential level $0101$ , ABIST DC test for 1000BT mode LD, max negative differential level $0110$ , ABIST DC test for 2500BT mode LD, max positive differential level $0111$ , ABIST DC test for 2500BT mode LD, 0 differential level $1000$ , ABIST DC test for 2500BT mode LD, max negative differential level

## 6 MMD Registers Detailed Description

**Table 19 Register Access Type**

Mode	Symbol
Status Register, (Status, or Ability Register)	RO
Read-Write Register, (e.g. MDIO Register)	RW
Read-Write, Self-Clearing Register (bit is cleared after read from MDIO)	RWSC
Read-Only, Self-Clearing Register (bit is cleared after read from MDIO)	ROSC

**Attention: As MxL86112C is a 1G speed product, the maximum speed capability available in the registers is 1G. Any speed request higher than 1G (2.5G, 5G, 10G) defaults to 1G.**

## 6.1 Standard PMAPMD Registers for MMD=0x01

Table 20 Registers Overview

Register Short Name	Register Long Name	Reset Value
PMA_CTRL1	PMA/PMD Control 1 (Register 1.0)	2058 <sub>H</sub>
PMA_STAT1	PMA/PMD status 1 (Register 1.1)	0000 <sub>H</sub>
PMA_DEVID1	PHY Identifier 1 (Register 1.2)	C133 <sub>H</sub>
PMA_DEVID2	PHY Identifier 2 (Register 1.3)	5400 <sup>1)</sup> <sub>H</sub>
PMA_SPEED_ABILITY	PMA/PMD speed ability (Register 1.4)	0070 <sub>H</sub>
PMA_DIP1	Devices in package 1 (Register 1.5)	008B <sub>H</sub>
PMA_DIP2	Devices in package 2 (Register 1.6)	C000 <sub>H</sub>
PMA_CTL2	PMA/PMD control 2 (Register 1.7)	0030 <sub>H</sub>
PMA_STAT2	PMA/PMD status 2 (Register 1.8)	8200 <sub>H</sub>
PMA_EXT_ABILITY	PMA/PMD Extended Ability (Register 1.11)	01A0 <sub>H</sub>
PMA_PACKID1	AN package identifier (Register 1.14)	C133 <sub>H</sub>
PMA_PACKID2	AN package identifier (Register 1.15)	5400 <sup>1)</sup> <sub>H</sub>
PMA_MGBT_EXTAB	PMAPMD Extended Ability (Register 1.21)	0000 <sub>H</sub>
PMA_MGBT_POLARITY	MULTIGBASE-T pair swap and polarity (Register 1.130)	0003 <sub>H</sub>
PMA_MGBT_TX_PBO	MULTIGBASE-T TX power backoff and PHY short reach setting (Register 1.131)	0000 <sub>H</sub>
PMA_MGBT_TEST_MODE	MULTIGBASE-T test mode (Register 1.132)	0000 <sub>H</sub>
PMA_MGBT_SNR_OPMARGIN_A	MULTIGBASE-T SNR Margin Channel A (Register 1.133)	0000 <sub>H</sub>
PMA_MGBT_SNR_OPMARGIN_B	MULTIGBASE-T SNR Margin Channel B (Register 1.134)	0000 <sub>H</sub>
PMA_MGBT_SNR_OPMARGIN_C	MULTIGBASE-T SNR Margin Channel C (Register 1.135)	0000 <sub>H</sub>
PMA_MGBT_SNR_OPMARGIN_D	MULTIGBASE-T SNR Margin Channel D (Register 1.136)	0000 <sub>H</sub>
PMA_MGBT_MINMARGIN_A	MULTIGBASE-T SNR Min Margin Channel A (Register 1.137)	0000 <sub>H</sub>
PMA_MGBT_MINMARGIN_B	MULTIGBASE-T SNR Min Margin Channel B (Register 1.138)	0000 <sub>H</sub>
PMA_MGBT_MINMARGIN_C	MULTIGBASE-T SNR Min Margin Chan C (Register 1.139)	0000 <sub>H</sub>
PMA_MGBT_MINMARGIN_D	MULTIGBASE-T SNR Min Margin Chan D (Register 1.140)	0000 <sub>H</sub>
PMA_MGBT_POWER_A	MULTIGBASE-T Rx Power Channel A (Register 1.141)	0000 <sub>H</sub>
PMA_MGBT_POWER_B	MULTIGBASE-T Rx Power Channel B (Register 1.142)	0000 <sub>H</sub>
PMA_MGBT_POWER_C	MULTIGBASE-T Rx Power Chan C (Register 1.143)	0000 <sub>H</sub>
PMA_MGBT_POWER_D	MULTIGBASE-T Rx Power Chan D (Register 1.144)	0000 <sub>H</sub>

Table 20 Registers Overview (cont'd)

Register Short Name	Register Long Name	Reset Value
PMA_MGBT_SKEW_DELAY_0	MULTIGBASE-T skew delay 0 (Register 1.145)	0000 <sub>H</sub>
PMA_MGBT_SKEW_DELAY_1	MULTIGBASE-T skew delay 1 (Register 1.146)	0000 <sub>H</sub>
PMA_MGBT_FAST_RETRAIN_STA_CTRL	MULTIGBASE-T skew delay 2 (Register 1.147)	0000 <sub>H</sub>
PMA_TIMESYNC_CAP	PMA TimeSync Capability Indication (Register 1.1800)	0000 <sub>H</sub>

1) For the device specific reset value, refer to Product Naming table in the [Package Outline](#) chapter.

### 6.1.1 Standard PMAPMD Registers for MMD=0x01

This chapter describes all registers of PMAPMD in detail.

#### PMA/PMD Control 1 (Register 1.0)

IEEE Standard Register=1.0

PMA_CTRL1														Reset Value	
PMA/PMD Control 1 (Register 1.0)														2058 <sub>H</sub>	
15	14	13	12	11	10		7	6	5		2	1	0		
RST	Res	SSL	Res	LOW-POW*		Res		SSM		SPEED_SEL		NS1	NS2		
rw		rw		rw				rw		rw		ro	ro		

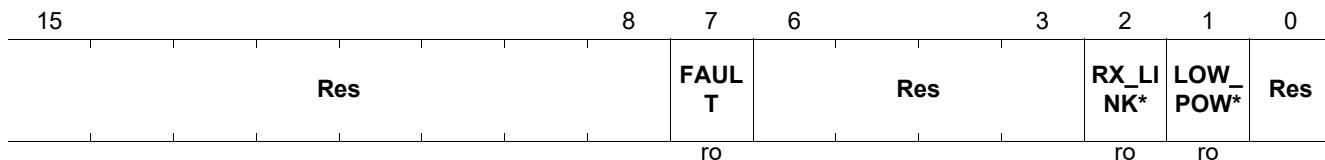
Field	Bits	Type	Description
RST	15	RW	<b>Reset</b> 1 = PMA/PMD reset 0 = Normal operation
SSL	13	RW	<b>Speed Selection (LSB)</b> Used in conjunction with field SPEED_SEL_MSB MSB LSB: 1 1 = bits 5:2 are used to select speed (SPEED_SEL field) 1 0 = 1000 Mb/s 0 1 = 100 Mb/s 0 0 = 10 Mb/s
LOW_POWER	11	RW	<b>Low power</b> 1 = Enter Low power mode 0 = Normal operation
SSM	6	RW	<b>Speed Selection (MSB)</b> Used in conjunction with field SPEED_SEL_LSB MSB LSB: 1 1 = bits 5:2 select speed (SPEED_SEL field) 1 0 = 1000 Mb/s 0 1 = 100 Mb/s 0 0 = 10 Mb/s

Field	Bits	Type	Description (cont'd)
SPEED_SEL	5:2	RW	<b>Speed Selection</b> Reserved
NS1	1	RO	<b>Not Supported</b> PMA remote loop-back mode is not supported by GPY
NS2	0	RO	<b>Not Supported</b> PMA local loop-back mode is not supported by GPY

**PMA/PMD status 1 (Register 1.1)**

IEEE Standard Register=1.1

<b>PMA_STAT1</b>	<b>Reset Value</b>
<b>PMA/PMD status 1 (Register 1.1)</b>	<b>0000<sub>H</sub></b>



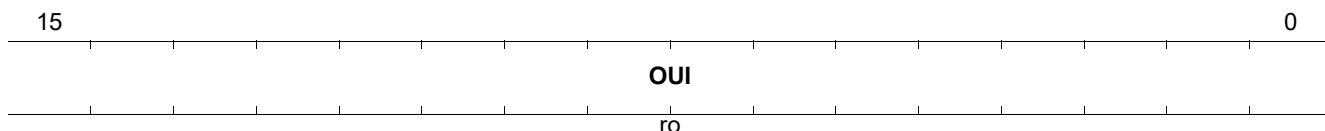
Field	Bits	Type	Description
FAULT	7	RO	<b>Fault</b> 1 = Fault condition detected 0 = Fault condition not detected
RX_LINK_STA	2	RO	<b>Receive Link Status</b> 1 = PMA/PMD receive link up 0 = PMA/PMD receive link down
LOW_POWER_ABILITY	1	RO	<b>Low Power Ability</b> 1 = PMA/PMD supports low power mode 0 = PMA/PMD does not support low power mode

**PHY Identifier 1 (Register 1.2)**

IEEE Standard Register=1.2

Bits 31 - 16 of Device ID

<b>PMA_DEVID1</b>	<b>Reset Value</b>
<b>PHY Identifier 1 (Register 1.2)</b>	<b>C133<sub>H</sub></b>



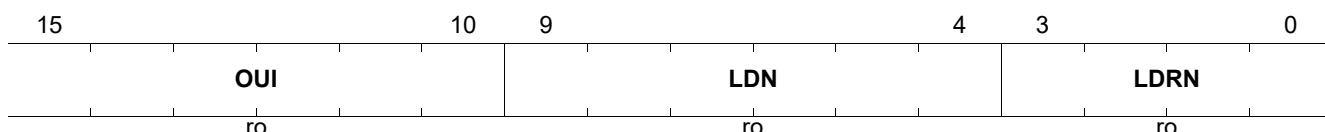
Field	Bits	Type	Description
OUI	15:0	RO	<b>Organizationally Unique Identifier</b> Organizationally Unique Identifier Bits 3:18

**PHY Identifier 2 (Register 1.3)**

IEEE Standard Register=1.3

Bits 15 - 0 of Device ID

PMA_DEVID2	Reset Value
<b>PHY Identifier 2 (Register 1.3)</b>	<b>5400<sub>H</sub></b>



Field	Bits	Type	Description
OUI	15:10	RO	<b>Organizationally Unique Identifier Bits 19:24</b>
LDN	9:4	RO	<b>Device Number</b> Specifies the device number <sup>1)</sup> to distinguish between several products.
LDRN	3:0	RO	<b>Device Number</b> Specifies the device revision number <sup>1)</sup> to distinguish between several versions of this device

1) For the device specific reset value, refer to Product Naming table in the [Package Outline](#) chapter.

## PMA/PMD speed ability (Register 1.4)

## IEEE Standard Register=1.4

## PMA\_SPEED\_ABILITY

## PMA/PMD speed ability (Register 1.4)

## Reset Value

0070\_H

Field	Bits	Type	Description
CAP_5G	14	RO	<b>Not Supported</b> 1 = PMA/PMD is capable of operating at 5 Gb/s 0 = PMA/PMD is not capable of operating as 5 Gb/s
CAP_2G5	13	RO	<b>2.5 G capable</b> 1 = PMA/PMD is capable of operating at 2.5 Gb/s 0 = PMA/PMD is not capable of operating as 2.5 Gb/s
RES2	12	RO	<b>Reserved</b> Value always 0
CAP_100G	9	RO	<b>Not Supported</b> 1 = PMA/PMD is capable of operating at 100 Gb/s 0 = PMA/PMD is not capable of operating as 100 Gb/s
CAP_40G	8	RO	<b>Not Supported</b> 1 = PMA/PMD is capable of operating at 40 Gb/s 0 = PMA/PMD is not capable of operating as 40 Gb/s
CAP_10_1G	7	RO	<b>Not Supported</b> 1 = PMA/PMD is capable of operating at 10 Gb/s downstream and 1 Gb/s upstream 0 = PMA/PMD is not capable of operating at 10 Gb/s downstream and 1 Gb/s upstream.
CAP_10M	6	RO	<b>10M capable</b> 1 = PMA/PMD is capable of operating at 10 Mb/s 0 = PMA/PMD is not capable of operating as 10 Mb/s
CAP_100M	5	RO	<b>100M capable</b> 1 = PMA/PMD is capable of operating at 100 Mb/s 0 = PMA/PMD is not capable of operating at 100 Mb/s
CAP_1000M	4	RO	<b>1000M capable</b> 1 = PMA/PMD is capable of operating at 1000 Mb/s 0 = PMA/PMD is not capable of operating at 1000 Mb/s
R10PASS_TS_CAPABLE	2	RO	<b>Not Supported</b> 1 = PMA/PMD is capable of operating as 10PASS-TS 0 = PMA/PMD is not capable of operating as 10PASS-TS

Field	Bits	Type	Description (cont'd)
CAP_2BASE_TL	1	RO	<b>Not Supported</b> 1 = PMA/PMD is capable of operating as 2BASE-TL 0 = PMA/PMD is not capable of operating as 2BASE-TL
CAP_10G_CA_P	0	RO	<b>Not Supported</b> 1 = PMA/PMD is capable of operating at 10 Gb/s 0 = PMA/PMD is not capable of operating at 10 Gb/s

**Devices in package 1 (Register 1.5)**

IEEE Standard Register=1.5

**PMA\_DIP1**

Reset Value

 008B<sub>H</sub>

15	12	11	10	9	8	7	6	5	4	3	2	1	0	
		RES	SEP_P MA*	SEP_P MA*	SEP_P MA*	SEP_P MA*	ANEG	TC	DTE_X S	PHY_XS	PCS	WIS	PMD_PMA	CLAU SE_*
ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro

Field	Bits	Type	Description
RES	15:12	RO	<b>Reserved</b> Ignore on Read
SEP_PMA_4	11	RO	<b>Separate PMA (4)</b> 1 = Separated PMA (4) present in package 0 = Separated PMA (4) not present in package
SEP_PMA_3	10	RO	<b>Separate PMA (3)</b> 1 = Separated PMA (3) present in package 0 = Separated PMA (3) not present in package
SEP_PMA_2	9	RO	<b>Separate PMA (2)</b> 1 = Separated PMA (2) present in package 0 = Separated PMA (2) not present in package
SEP_PMA_1	8	RO	<b>Separate PMA (1)</b> 1 = Separated PMA (1) present in package 0 = Separated PMA (1) not present in package
ANEG	7	RO	<b>Auto-Negotiation present</b> This bit is always set to 1 in GPY 1 = Auto-Negotiation present in package 0 = Auto-Negotiation not present in package
TC	6	RO	<b>TC present</b> 1 = TC present in package 0 = TC not present in package
DTE_XS	5	RO	<b>DTE XS present</b> 1 = DTE XS present in package 0 = DTE XS not present in package

Field	Bits	Type	Description (cont'd)
PHY_XS	4	RO	<b>PHY XS present</b> 1 = PHY XS present in package 0 = PHY XS not present in package
PCS	3	RO	<b>PCS present</b> This bit is always set to 1 in GPY 1 = PCS present in package 0 = PCS not present in package
WIS	2	RO	<b>WIS present</b> 1 = WIS present in package 0 = WIS not present in package
PMD_PMA	1	RO	<b>PMD/PMA present</b> This bit is always set to 1 in GPY 1 = PMA/PMD present in package 0 = PMA/PMD not present in package
CLAUSE_22	0	RO	<b>Clause 22 registers present</b> This bit is always set to 1 in GPY 1 = Clause 22 registers present in package 0 = Clause 22 registers not present in package

### Devices in package 2 (Register 1.6)

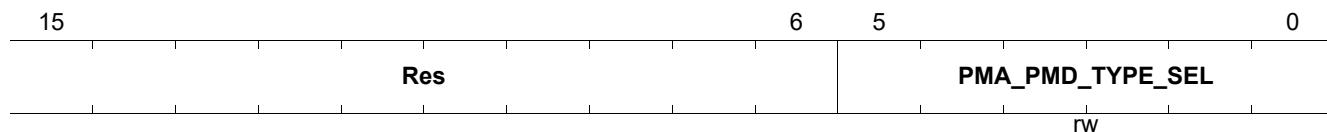
IEEE Standard Register=1.6

PMA_DIP2				Reset Value
Devices in package 2 (Register 1.6)				C000 <sub>H</sub>
15	14	13	12	0
VSPE C2	VSPE C1	CLA_2_2 <sup>*</sup>	RES	
ro	ro	ro	ro	ro

Field	Bits	Type	Description
VSPEC2	15	RO	<b>Vendor-specific device 2</b> This bit is always set to 1 in GPY 1 = Vendor-specific device 2 present in package 0 = Vendor-specific device 2 not present in package
VSPEC1	14	RO	<b>Vendor-specific device 1</b> This bit is always set to 1 in GPY 1 = Vendor-specific device 1 present in package 0 = Vendor-specific device 1 not present in package
CLA_22_EXT	13	RO	<b>Clause 22 extension</b> 1 = Clause 22 extension present in package 0 = Clause 22 extension not present in package
RES	12:0	RO	<b>Reserved</b> Ignore on read

**PMA/PMD control 2 (Register 1.7)**

IEEE Standard Register=1.7

**PMA\_CTL2****PMA/PMD control 2 (Register 1.7)****Reset Value****0030<sub>H</sub>**

Field	Bits	Type	Description
PMA_PMD_TY PE_SEL	5:0	RW	<b>PMA/PMD type selection</b> 5 4 3 2 1 0 0 0 1 1 1 1 = 10BASE-T PMA/PMD 0 0 1 1 1 0 = 100BASE-TX PMA/PMD 0 0 1 1 0 0 = 1000BASE-T PMA/PMD Others = Reserved

**PMA/PMD status 2 (Register 1.8)**

IEEE Standard Register=1.8

PMA_STAT2																Reset Value
PMA/PMD status 2 (Register 1.8)																8200 <sub>H</sub>

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
DEVICE_PRE SENT	TX_FA UL*	RX_F AUL*	TX_FA ULT	RX_F AULT	EXT_A BI*	PMD_TX_*	RMGB T_S*	RMGB T_L*	RMGB T_E*	RMGB T_L*	RMGB T_S*	RMGB T_L*	RMGB T_E*	RMGB T_L*	RMGB T_E*	PMA_LOC*
ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro

Field	Bits	Type	Description
DEVICE_PRE SENT	15:14	RO	<b>Device present</b> 1 0 = Device responding at this address 1 1 = No device responding at this address 0 1 = No device responding at this address 0 0 = No device responding at this address
TX_FAULT_A BILITY	13	RO	<b>Transmit fault ability</b> 1 = PMA/PMD has the ability to detect a fault condition on the transmit path 0 = PMA/PMD does not have the ability to detect a fault condition on the transmit path
RX_FAULT_A BILITY	12	RO	<b>Receive fault ability</b> 1 = PMA/PMD has the ability to detect a fault condition on the receive path 0 = PMA/PMD does not have the ability to detect a fault condition on the receive path
TX_FAULT	11	RO	<b>Transmit fault</b> 1 = Fault condition on transmit path 0 = No fault condition on transmit path
RX_FAULT	10	RO	<b>Receive fault</b> 1 = Fault condition on receive path 0 = No fault condition on receive path
EXT_ABILITIES	9	RO	<b>Extended abilities</b> 1 = PMA/PMD has extended abilities listed in register 1.11 0 = PMA/PMD does not have extended abilities
PMD_TX_DIS ABLE	8	RO	<b>PMD transmit disable</b> 1 = PMD has the ability to disable the transmit path 0 = PMD does not have the ability to disable the transmit path
RMGBT_SR_A BILITY	7	RO	<b>MULTIGBASE-SR ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-SR 0 = PMA/PMD is not able to perform MULTIGBASE-SR
RMGBT_LR_A BILITY	6	RO	<b>MULTIGBASE-LR ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-LR 0 = PMA/PMD is not able to perform MULTIGBASE-LR

Field	Bits	Type	Description (cont'd)
RMGBT_ER_ABILITY	5	RO	<b>MULTIGBASE-ER ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-ER 0 = PMA/PMD is not able to perform MULTIGBASE-ER
RMGBT_LX4_ABILITY	4	RO	<b>MULTIGBASE-LX4 ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-LX4 0 = PMA/PMD is not able to perform MULTIGBASE-LX4
RMGBT_SW_ABILITY	3	RO	<b>MULTIGBASE-SW ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-SW 0 = PMA/PMD is not able to perform MULTIGBASE-SW
RMGBT_LW_ABILITY	2	RO	<b>MULTIGBASE-LW ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-LW 0 = PMA/PMD is not able to perform MULTIGBASE-LW
RMGBT_EW_ABILITY	1	RO	<b>MULTIGBASE-EW ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-EW 0 = PMA/PMD is not able to perform MULTIGBASE-EW
PMA_LOCAL_LOOPBACK	0	RO	<b>PMA Local Loop-back</b> 1 = PMA has the ability to perform a local loop-back function 0 = PMA does not have the ability to perform a local loop-back function

### PMA/PMD Extended Ability (Register 1.11)

IEEE Standard Register=1.11

PMA_EXT_ABILITY																Reset Value
PMA/PMD Extended Ability (Register 1.11)																01A0 <sub>H</sub>

15	14	13	11	10	9	8	7	6	5	4	3	2	1	0		
Res	R2G5_EX*		Res	R40G_10*	P2MP_AB*	R10B ASE*	R100B AS*	R1000 BA*	R1000 BA*	RMGB T_K*	RMGB T_K*	RMGB T_A*	RMGB T_L*	RMGB T_C*		

Field	Bits	Type	Description
R2G5_EXT_ABILITIES	14	RO	<b>2.5G/5G extended abilities</b> 1 = PMA/PMD has 2.5G/5G extended abilities listed in register 1.21 0 = PMA/PMD does not have 2.5G/5G extended abilities
R40G_100G_EXT_ABILITIES	10	RO	<b>40G/100G extended abilities</b> 1 = PMA/PMD has 40G/100G extended abilities listed in register 1.13 0 = PMA/PMD does not have 40G/100G extended abilities
P2MP_ABILITY	9	RO	<b>P2MP ability</b> 1 = PMA/PMD has P2MP abilities listed in register 1.12 0 = PMA/PMD does not have P2MP abilities
R10BASE_T_ABILITY	8	RO	<b>10BASE-T ability</b> 1 = PMA/PMD is able to perform 10BASE-T 0 = PMA/PMD is not able to perform 10BASE-T

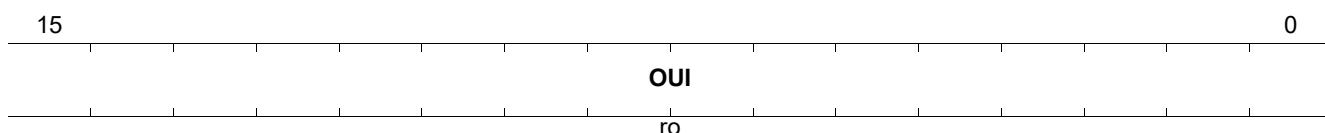
Field	Bits	Type	Description (cont'd)
R100BASE_T_X_ABILITY	7	RO	<b>100BASE-TX ability</b> 1 = PMA/PMD is able to perform 100BASE-TX 0 = PMA/PMD is not able to perform 100BASE-TX
R1000BASE_KX_ABILITY	6	RO	<b>1000BASE-KX ability</b> 1 = PMA/PMD is able to perform 1000BASE-KX 0 = PMA/PMD is not able to perform 1000BASE-KX
R1000BASE_T_ABILITY	5	RO	<b>1000BASE-T ability</b> 1 = PMA/PMD is able to perform 1000BASE-T 0 = PMA/PMD is not able to perform 1000BASE-T
RMGBT_KR_ABILITY	4	RO	<b>MULTIGBASE-KR ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-KR 0 = PMA/PMD is not able to perform MULTIGBASE-KR
RMGBT_KX4_ABILITY	3	RO	<b>MULTIGBASE-KX4 ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-KX4 0 = PMA/PMD is not able to perform MULTIGBASE-KX4
RMGBT_ABILITY	2	RO	<b>10GBASE-T ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-T 0 = PMA/PMD is not able to perform MULTIGBASE-T
RMGBT_LRM_ABILITY	1	ROR	<b>MULTIGBASE-LRM ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-LRM 0 = PMA/PMD is not able to perform MULTIGBASE-LRM
RMGBT_CX4_ABILITY	0	ROR	<b>MULTIGBASE-CX4 ability</b> 1 = PMA/PMD is able to perform MULTIGBASE-CX4 0 = PMA/PMD is not able to perform MULTIGBASE-CX4

**AN package identifier (Register 1.14)**

IEEE Standard Register=1.14

**PMA\_PACKID1**

Reset Value

**AN package identifier (Register 1.14)**C133<sub>H</sub>

Field	Bits	Type	Description
OUI	15:0	RO	<b>Organizationally Unique Identifier</b> Organizationally Unique Identifier Bits 3:18

**AN package identifier (Register 1.15)**

IEEE Standard Register=1.15

**PMA\_PACKID2****Reset Value****5400<sub>H</sub>**

15	10	9	4	3	0
	OUI		LDN		LDRN
	ro		ro		ro

Field	Bits	Type	Description
OUI	15:10	RO	<b>Organizationally Unique Identifier Bits 19:24</b>
LDN	9:4	RO	<b>Device Number</b> Specifies the device number <sup>1)</sup> to distinguish between several products.
LDRN	3:0	RO	<b>Device Number</b> Specifies the device revision number <sup>1)</sup> to distinguish between several versions of this device

1) For the device specific reset value, refer to Product Naming table in the [Package Outline](#) chapter.**PMAPMD Extended Ability (Register 1.21)**

Read only, write from STA has no effect

IEEE Standard Register=1.21

**PMA\_MGBT\_EXTAB****Reset Value****0000<sub>H</sub>**

15	2	1	0
RES			
ro	ro	ro	ro

Field	Bits	Type	Description
RES	15:2	RO	<b>Reserved</b> Value always 0
AB5G	1	RO	<b>PMA Ability to perform 5GBT</b> 0 <sub>B</sub> <b>UNABLE</b> PMA is not able to perform 5GBT 1 <sub>B</sub> <b>ABLE</b> PMA Able to perform 5GBT
AB2G5	0	RO	<b>PMA Ability to perform 2G5BT</b> 0 <sub>B</sub> <b>UNABLE</b> PMA is not able to perform 2G5BT 1 <sub>B</sub> <b>ABLE</b> PMA Able to perform 2G5BT

**MULTIGBASE-T pair swap and polarity (Register 1.130)**

IEEE Standard Register=1.130

**PMA\_MGBT\_POLARITY**
**MULTIGBASE-T pair swap and polarity (Register 1.130)**

Reset Value

 0003<sub>H</sub>

15	12	11	10	9	8	7		2	1	0
Res		PAIR_D_*	PAIR_C_*	PAIR_B_*	PAIR_A_*		Res		MDI_MDI_X	
	ro	ro	ro	ro	ro				ro	

Field	Bits	Type	Description
PAIR_D_POLARITY	11	RO	<b>Pair D polarity</b> 1 = Polarity of pair D is reversed 0 = Polarity of pair D is not reversed
PAIR_C_POLARITY	10	RO	<b>Pair C polarity</b> 1 = Polarity of pair C is reversed 0 = Polarity of pair C is not reversed
PAIR_B_POLARITY	9	RO	<b>Pair B polarity</b> 1 = Polarity of pair B is reversed 0 = Polarity of pair B is not reversed
PAIR_A_POLARITY	8	RO	<b>Pair A polarity</b> 1 = Polarity of pair A is reversed 0 = Polarity of pair A is not reversed
MDI_MDI_X	1:0	RO	<b>MDI/MDI-X</b> Indicates the status of pair swaps at the MDI / MD-X 00 <sub>B</sub> <b>ABCDCROSS</b> Pair AB and Pair CD crossover 01 <sub>B</sub> <b>CDCROSS</b> Pair CD crossover only 10 <sub>B</sub> <b>ABCROSS</b> Pair AB crossover only 11 <sub>B</sub> <b>NORMAL</b> No crossover

**MULTIGBASE-T TX power backoff and PHY short reach setting (Register 1.131)**

IEEE Standard Register=1.131

**PMA\_MGBT\_TX\_PBO**
**MULTIGBASE-T TX power backoff and PHY short reach setting (Register 1.131)**

Reset Value

 0000<sub>H</sub>

15	13	12	10	9		1	0
LP_TX		TX_POWER_BACKOFF			Res		SHOR_T_R*
ro		ro					ro

Field	Bits	Type	Description
LP_TX	15:13	RO	<p><b>Link partner TX</b></p> <p>The power backoff setting of the link partner</p> <p>Bit number assignment:</p> <p>15 14 13</p> <p>-----</p> <p>1 1 1 = 14 dB</p> <p>1 1 0 = 12 dB</p> <p>1 0 1 = 10 dB</p> <p>1 0 0 = 8 dB</p> <p>0 1 1 = 6 dB</p> <p>0 1 0 = 4 dB</p> <p>0 0 1 = 2 dB</p> <p>0 0 0 = 0 dB</p>
TX_POWER_BACKOFF	12:10	RO	<p><b>TX power backoff</b></p> <p>The power backoff of PHY211 PMA</p> <p>Bit number assignment:</p> <p>12 11 10</p> <p>-----</p> <p>1 1 1 = 14 dB</p> <p>1 1 0 = 12 dB</p> <p>1 0 1 = 10 dB</p> <p>1 0 0 = 8 dB</p> <p>0 1 1 = 6 dB</p> <p>0 1 0 = 4 dB</p> <p>0 0 1 = 2 dB</p> <p>0 0 0 = 0 dB</p>
SHORT_REACH_MODE	0	RO	<p><b>Short reach mode</b></p> <p>1 = PHY is operating in short reach mode (not supported)</p> <p>0 = PHY is not operating in short reach mode</p>

## MULTIGBASE-T test mode (Register 1.132)

IEEE Standard Register=1.132

## PMA MGBT TEST MODE

## Reset Value

## MULTIGBASE-T test mode (Register 1.132)

0000<sub>H</sub>

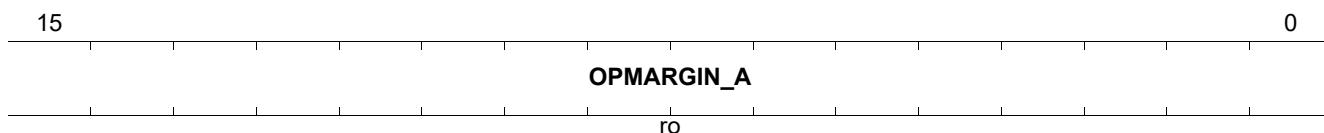
Field	Bits	Type	Description
TEST_MODE_CTL	15:13	RW	<b>Test mode control</b> 1 1 1 = Test mode 7 1 1 0 = Test mode 6 1 0 1 = Test mode 5 1 0 0 = Test mode 4 0 1 1 = Test mode 3 0 1 0 = Test mode 2 0 0 1 = Test mode 1 0 0 0 = Normal operation
TXTER_TEST	12:10	RW	<b>Transmitter test</b> Frequencies for tones used in Test Mode 4 1 1 1 = Reserved 1 1 0 = Dual tone 5 1 0 1 = Dual tone 4 1 0 0 = Dual tone 3 0 1 1 = Reserved 0 1 0 = Dual tone 2 0 0 1 = Dual tone 1 0 0 0 = Reserved

#### MULTIGBASE-T SNR Margin Channel A (Register 1.133)

Register 1.133 contains the current SNR operating margin measured at the slicer input for channel A for the MULTIGBASE-T PMA.

IEEE Standard Register=1.133

<b>PMA_MGBT_SNR_OPMARGIN_A</b>	<b>Reset Value</b>
<b>MULTIGBASE-T SNR Margin Channel A (Register 1.133)</b>	<b>0000<sub>H</sub></b>



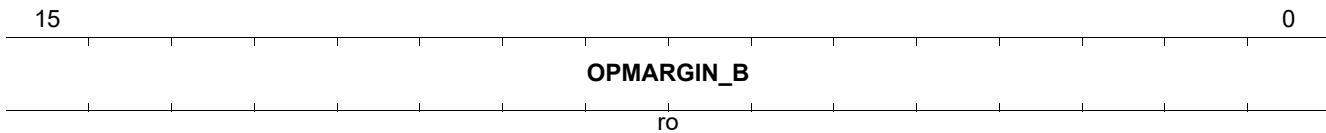
Field	Bits	Type	Description
OPMARGIN_A	15:0	RO	<b>OPMARGIN_A</b> SNR operating margin measured at the slicer input for channel A

#### MULTIGBASE-T SNR Margin Channel B (Register 1.134)

Register 1.134 contains the current SNR operating margin measured at the slicer input for channel B for the MULTIGBASE-T PMA.

IEEE Standard Register=1.134

<b>PMA_MGBT_SNR_OPMARGIN_B</b>	<b>Reset Value</b>
<b>MULTIGBASE-T SNR Margin Channel B (Register 1.134)</b>	<b>0000<sub>H</sub></b>



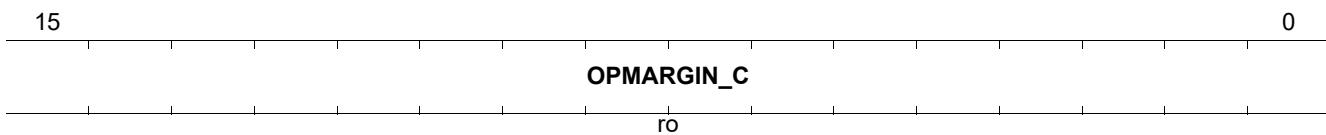
Field	Bits	Type	Description
OPMARGIN_B	15:0	RO	<b>OPMARGIN_B</b> SNR operating margin measured at the slicer input for channel B

#### **MULTIGBASE-T SNR Margin Channel C (Register 1.135)**

Register 1.135 contains the current SNR operating margin measured at the slicer input for channel C for the MULTIGBASE-T PMA.

IEEE Standard Register=1.135

**PMA\_MGBT\_SNR\_OPMARGIN\_C** Reset Value  
**0000<sub>H</sub>**  
**MULTIGBASE-T SNR Margin Channel C (Register 1.135)**



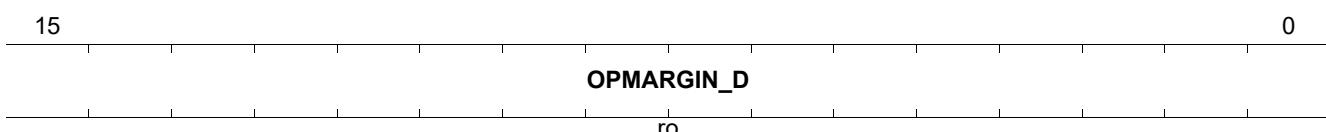
Field	Bits	Type	Description
OPMARGIN_C	15:0	RO	<b>OPMARGIN_C</b> SNR operating margin measured at the slicer input for channel C

#### **MULTIGBASE-T SNR Margin Channel D (Register 1.136)**

Register 1.136 contains the current SNR operating margin measured at the slicer input for channel D for the MULTIGBASE-T PMA.

IEEE Standard Register=1.136

**PMA\_MGBT\_SNR\_OPMARGIN\_D** Reset Value  
**0000<sub>H</sub>**  
**MULTIGBASE-T SNR Margin Channel D (Register 1.136)**



Field	Bits	Type	Description
OPMARGIN_D	15:0	RO	<b>OPMARGIN_D</b> SNR operating margin measured at the slicer input for channel D

## MULTIGBASE-T SNR Min Margin Channel A (Register 1.137)

The minimum margin channel A register contains a latched copy of the lowest value observed in the SNR operating margin channel A register (1.133) since the last read.

IEEE Standard Register=1.137

**PMA\_MGBT\_MINMARGIN\_A** **Reset Value**  
MULTIGBASE-T SNR Min Margin Channel A (Register 1.137) **0000\_H**



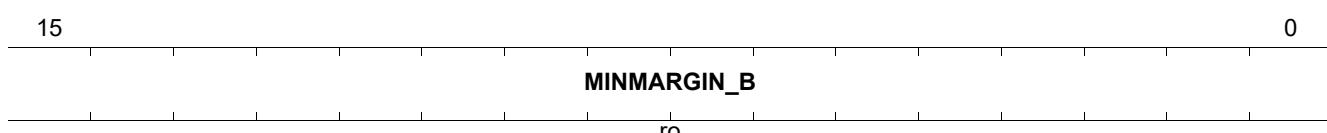
Field	Bits	Type	Description
MINMARGIN_A	15:0	RO	<b>MINMARGIN_A</b> Lowest value observed in the SNR operating margin channel A register (1.133) since the last read

#### MULTIGBASE-T SNR Min Margin Channel B (Register 1.138)

The minimum margin channel A register contains a latched copy of the lowest value observed in the SNR operating margin channel B register (1.134) since the last read.

IEEE Standard Register=1.138

**PMA\_MGBT\_MINMARGIN\_B** **Reset Value**  
MULTIGBASE-T SNR Min Margin Channel B (Register 1.138) **0000H**



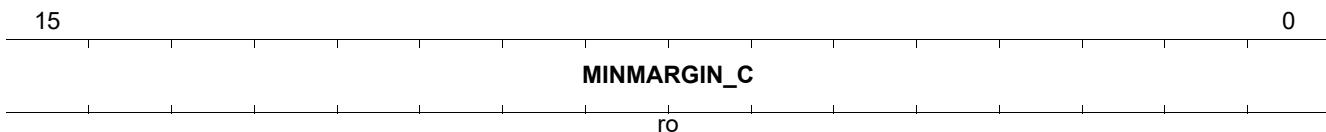
Field	Bits	Type	Description
MINMARGIN_B	15:0	RO	<b>MINMARGIN_B</b> Lowest value observed in the SNR operating margin channel B register (1.134) since the last read

#### MULTIGBASE-T SNR Min Margin Chan C (Register 1.139)

The minimum margin channel C register contains a latched copy of the lowest value observed in the SNR operating margin channel C register (1.135) since the last read.

IEEE Standard Register=1.139

**PMA\_MGBT\_MINMARGIN\_C** **Reset Value**  
**MULTIGBASE-T SNR Min Margin Chan C (Register 1.139)** **0000\_4**



Field	Bits	Type	Description
MINMARGIN_C	15:0	RO	<b>MINMARGIN_C</b> Lowest value observed in the SNR operating margin channel C register (1.135) since the last read

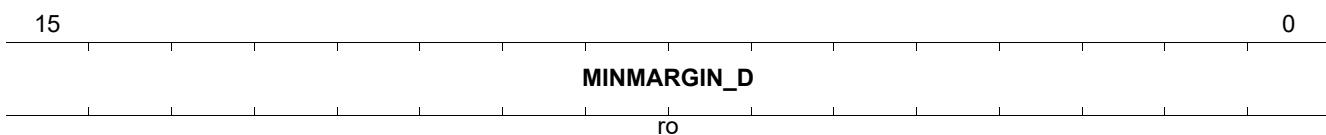
#### MULTIGBASE-T SNR Min Margin Chan D (Register 1.140)

The Minimum margin channel D register contains a latched copy of the lowest value observed in the SNR operating margin channel D register (1.136) since the last read.

IEEE Standard Register=1.140

**PMA\_MGBT\_MINMARGIN\_D** Reset Value  
0000<sub>H</sub>

**MULTIGBASE-T SNR Min Margin Chan D (Register 1.140)**



Field	Bits	Type	Description
MINMARGIN_D	15:0	RO	<b>MINMARGIN_D</b> Lowest value observed in the SNR operating margin channel D register (1.136) since the last read

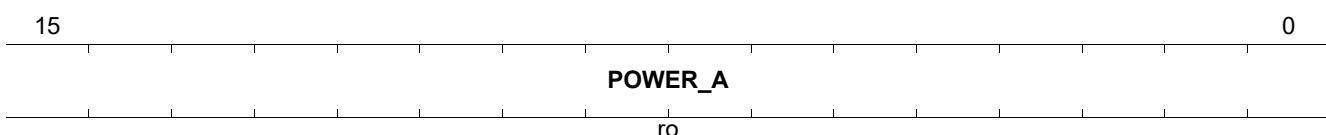
#### MULTIGBASE-T Rx Power Channel A (Register 1.141)

The RX signal power channel A register is read only and contains the receive signal power measured at the MDI during training as described in 55.4.3.1.

IEEE Standard Register=1.141

**PMA\_MGBT\_POWER\_A** Reset Value  
0000<sub>H</sub>

**MULTIGBASE-T Rx Power Channel A (Register 1.141)**



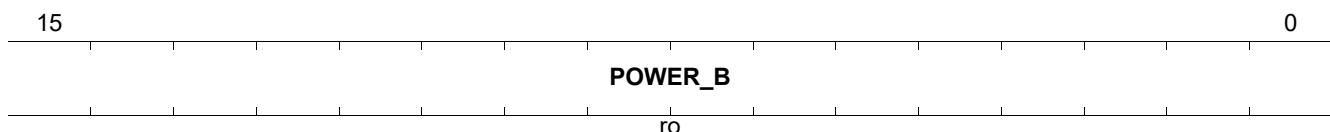
Field	Bits	Type	Description
POWER_A	15:0	RO	<b>POWER_A</b> Receive signal power measured at the MDI during training

**MULTIGBASE-T Rx Power Channel B (Register 1.142)**

The RX signal power channel B register is read only and contains the receive signal power measured at the MDI during training as described in 55.4.3.1.

IEEE Standard Register=1.142

**PMA\_MGBT\_POWER\_B** Reset Value  
**0000<sub>H</sub>**  
**MULTIGBASE-T Rx Power Channel B (Register 1.142)**



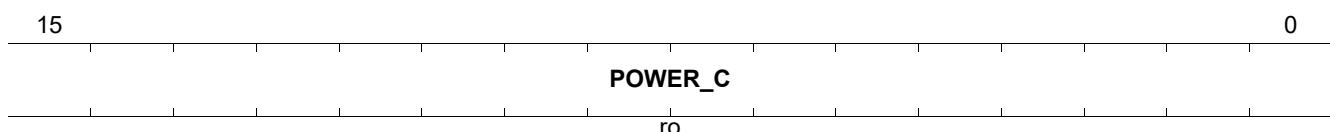
Field	Bits	Type	Description
POWER_B	15:0	RO	<b>POWER_B</b> Receive signal power measured at the MDI during training

**MULTIGBASE-T Rx Power Chan C (Register 1.143)**

The RX signal power channel C register is read only and contains the receive signal power measured at the MDI during training as described in 55.4.3.1.

IEEE Standard Register=1.143

**PMA\_MGBT\_POWER\_C** Reset Value  
**0000<sub>H</sub>**  
**MULTIGBASE-T Rx Power Chan C (Register 1.143)**



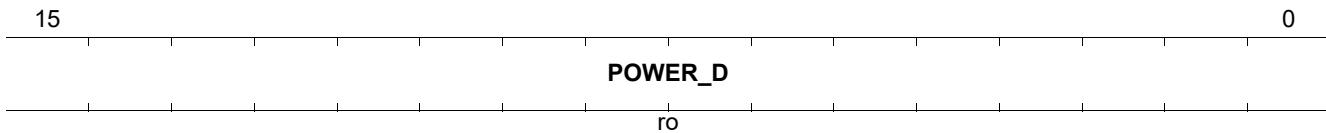
Field	Bits	Type	Description
POWER_C	15:0	RO	<b>POWER_C</b> Receive signal power measured at the MDI during training

**MULTIGBASE-T Rx Power Chan D (Register 1.144)**

The RX signal power channel D register is read only and contains the receive signal power measured at the MDI during training as described in 55.4.3.1.

IEEE Standard Register=1.144

**PMA\_MGBT\_POWER\_D** Reset Value  
**0000<sub>H</sub>**  
**MULTIGBASE-T Rx Power Chan D (Register 1.144)**



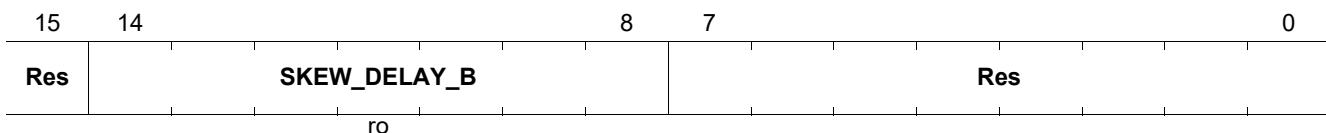
Field	Bits	Type	Description
POWER_D	15:0	RO	<b>POWER_D</b> Receive signal power measured at the MDI during training

#### MULTIGBASE-T skew delay 0 (Register 1.145)

IEEE Standard Register=1.145

The skew delay reports the current skew delay on each of the pairs with respect to physical pair A. It is reported with 1.25 ns resolution to an accuracy of 2.5 ns. The number is in two's complement notation with positive values representing delay and negative values representing advance with respect to physical pair A. If the delay exceeds the maximum amount that can be represented by the range (-80 ns to +78.75 ns), the field displays the maximum value.

PMA_MGBT_SKew_DELAY_0	Reset Value
<b>MULTIGBASE-T skew delay 0 (Register 1.145)</b>	<b>0000<sub>H</sub></b>



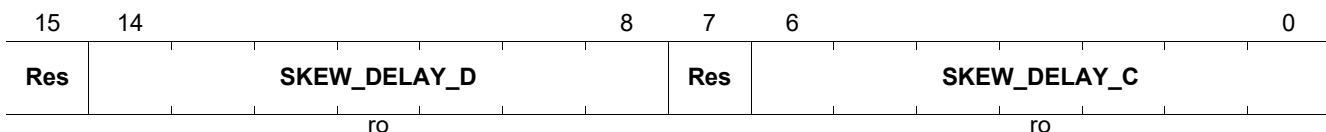
Field	Bits	Type	Description
SKEW_DELAY_B	14:8	RO	<b>Skew delay B</b> Skew delay for pair B

#### MULTIGBASE-T skew delay 1 (Register 1.146)

IEEE Standard Register=1.146

The skew delay reports the current skew delay on each of the pairs with respect to physical pair A. It is reported with 1.25 ns resolution to an accuracy of 2.5 ns. The number is in two's complement notation with positive values representing delay and negative values representing advance with respect to physical pair A. If the delay exceeds the maximum amount that can be represented by the range (-80 ns to +78.75 ns), the field displays the maximum value.

PMA_MGBT_SKew_DELAY_1	Reset Value
<b>MULTIGBASE-T skew delay 1 (Register 1.146)</b>	<b>0000<sub>H</sub></b>



Field	Bits	Type	Description
SKEW_DELAY_D	14:8	RO	<b>Skew delay D</b> Skew delay for pair D
SKEW_DELAY_C	6:0	RO	<b>Skew delay C</b> Skew delay for pair C

**MULTIGBASE-T skew delay 2 (Register 1.147)**

IEEE Standard Register=1.147

**PMA\_MGBT\_FAST\_RETRAIN\_STA\_CTRL** Reset Value  
**0000<sub>H</sub>**  
**MULTIGBASE-T skew delay 2 (Register 1.147)**

15	11	10	6	5	4	3	2	1	0
LP_FAST_RETRAIN_COUNT		LD_FAST_RETRAIN_COUNT		Res	FAST_RE*	FAST_RE*	FAST_RETRAIN_SI*	FAST_RE*	
ro		ro		ro	ro	ro	rw	rw	

Field	Bits	Type	Description
LP_FAST_RETRAIN_COUNT	15:11	RO	<b>LP fast retrain count</b> Counts the number of fast retrains requested by the link partner
LD_FAST_RETRAIN_SI_COUNT	10:6	RO	<b>LD fast retrain count</b> Counts the number of fast retrains requested by the local device
FAST_RETRAIN_ABILITY	4	RO	<b>Fast retrain ability</b> 1 = Fast retrain capability is supported 0 = Fast retrain capability is not supported
FAST_RETRAIN_NEGOTIATED	3	RO	<b>Fast retrain negotiated</b> 1 = Fast retrain capability was negotiated 0 = Fast retrain capability was not negotiated
FAST_RETRAIN_SIG_TYPE	2:1	RW	<b>Fast retrain signal type</b> 11 = Reserved 10 = PHY signals Link Interruption during fast retrain 01 = PHY signals Local Fault during fast retrain 00 = PHY signals IDLE during fast retrain
FAST_RETRAIN_ENABLE	0	RW	<b>Fast retrain enable</b> 1 = Fast retrain capability is enabled 0 = Fast retrain capability is disabled

**PMA TimeSync Capability Indication (Register 1.1800)**

PMA TimeSync Capability indication Register.

GPY does not support providing data path delay information.

IEEE Standard Register=1.1800

## PMA\_TIMESYNC\_CAP

## PMA TimeSync Capability Indication (Register 1.1800)

Reset Value

0000<sub>H</sub>

15	Res	2	1	0
			TXDE L ro	RXDE L ro

Field	Bits	Type	Description
TXDEL	1	RO	<b>Transmit Data Path Delay Information</b> Not supported by GPY 0 <sub>B</sub> <b>NONE</b> PHYs do not have this capability 1 <sub>B</sub> <b>CAPABLE</b> min and max TX data path delay available
RXDEL	0	RO	<b>Receive Data Path Delay Information</b> Not supported by GPY 0 <sub>B</sub> <b>NONE</b> PHYs do not have this capability 1 <sub>B</sub> <b>CAPABLE</b> min and max RX data path delay available

## 6.2 Standard PCS Registers for MMD=0x03

This section describes the PCS registers for MMD device 0x03.

**Table 21 Registers Overview**

Register Short Name	Register Long Name	Reset Value
<b>PCS_CTRL1</b>	PCS control 1 (Register 3.0)	205C <sub>H</sub>
<b>PCS_STAT1</b>	PCS status 1 (Register 3.1)	0000 <sub>H</sub>
<b>PCS_DEVID1</b>	PHY Identifier 1 (Register 3.2)	C133 <sub>H</sub>
<b>PCS_DEVID2</b>	PHY Identifier 2 (Register 3.3)	5400 <sub>H</sub> <sup>1)</sup>
<b>PCS_SPEED_ABILITY</b>	PCS speed ability (Register 3.4)	0000 <sub>H</sub>
<b>PCS_DIP1</b>	PCS Devices in package 1 (Register 3.5)	008B <sub>H</sub>
<b>PCS_DIP2</b>	PCS Devices in package 2 (Register 3.6)	C000 <sub>H</sub>
<b>PCS_STAT2</b>	PCS status 2 (Register 3.8)	8000 <sub>H</sub>
<b>PCS_PACKID1</b>	PCS package identifier 1 (Register 3.14)	C133 <sub>H</sub>
<b>PCS_PACKID2</b>	PCS package identifier 2 (Register 3.15)	5400 <sub>H</sub> <sup>1)</sup>
<b>PCS_EEE_CAP</b>	PCS EEE capability (Register 3.20)	0006 <sub>H</sub>
<b>PCS_EEE_CAP2</b>	EEE control and capability 2 (Register 3.21)	0000 <sub>H</sub>
<b>PCS_EEE_WAKERR</b>	PCS EEE Status Register 1 (Register 3.22)	0000 <sub>H</sub>
<b>PCS_TIMESYNC_CAP</b>	PCS TimeSync capability register (Register 3.1800)	0000 <sub>H</sub>

1) For the device specific reset value, refer to Product Naming table in the [Package Outline](#) chapter.

### 6.2.1 Standard PCS Registers for MMD=0x03

This chapter describes all registers of PCS in detail.

#### PCS control 1 (Register 3.0)

IEEE Standard Register=3.0

PCS_CTRL1													Reset Value
PCS control 1 (Register 3.0)													205C <sub>H</sub>
15	14	13	12	11	10	9	7	6	5	2	1	0	
RST	LOOP BACK	SSL	Res	LOW_	POW*	RXCK ST	Res	SSM	SPEED_SEL			Res	
rw	rw	rw		rw	rw			rw	rw				

Field	Bits	Type	Description
RST	15	RW	<b>Reset</b> 1 = PCS reset - Self Clearing 0 = Normal operation
LOOPBACK	14	RW	<b>Loopback</b> 1 = Enable loopback mode 0 = Disable loopback mode

Field	Bits	Type	Description (cont'd)
SSL	13	RW	<b>Forced Speed selection (LSB)</b> This bit is used in conjunction with SPEED_SEL_MSB MSB LSB 1 1 = bits 5:2 select speed 1 0 = 1000 Mb/s 0 1 = 100 Mb/s 0 0 = 10 Mb/s
LOW_POWER	11	RW	<b>Low power</b> 1 = Low-power mode 0 = Normal operation
RXCKST	10	RW	<b>Clock stop enable</b> 1 = The GPY will stop the (X)GMII clock during LPI 0 = Clock not stoppable The MAC can set this bit to active to allow the GPY to stop the clocking during the LPI_MODE.
SSM	6	RW	<b>Forced Speed selection (MSB)</b> This bit is used in conjunction with SPEED_SEL_MSB MSB LSB 1 1 = bits 5:2 select speed 1 0 = 1000 Mb/s 0 1 = 100 Mb/s 0 0 = 10 Mb/s
SPEED_SEL	5:2	RW	<b>Forced Speed selection Values</b> Reserved

## PCS status 1 (Register 3.1)

IEEE Standard Register=3.1

## PCS\_STAT1

PCS status 1 (Register 3.1) Reset Value0000<sub>H</sub>

15	12	11	10	9	8	7	6	5	3	2	1	0
		Res	TX_LP I <sub>1</sub> <sup>*</sup>	RX_LP I <sub>1</sub> <sup>*</sup>	TX_LP I <sub>1</sub> <sup>*</sup>	RX_LP I <sub>1</sub> <sup>*</sup>	FAULT	TXCKST	Res	PCS_RX_ I <sub>1</sub> <sup>*</sup>	LOW_ POW <sup>*</sup>	Res
			ro	ro	ro	ro	ro	ro		ro	ro	

Field	Bits	Type	Description
TX_LPI_RXD	11	RO	<b>Tx LPI received</b> 1 = Tx PCS has received LPI 0 = LPI not received
RX_LPI_RXD	10	RO	<b>Rx LPI received</b> 1 = Rx PCS has received LPI 0 = LPI not received
TX_LPI_INDICATION	9	RO	<b>Tx LPI indication</b> 1 = Tx PCS is currently receiving LPI 0 = PCS is not currently receiving LPI
RX_LPI_INDICATION	8	RO	<b>Rx LPI indication</b> 1 = Rx PCS is currently receiving LPI 0 = PCS is not currently receiving LPI
FAULT	7	RO	<b>Fault</b> 1 = Fault condition detected 0 = No fault condition detected
TXCKST	6	RO	<b>Clock stop capable</b> 1 = The MAC may stop the clock during LPI 0 = Clock not stoppable
PCS_RX_LINK_STATUS	2	RO	<b>PCS receive link status</b> 1 = PCS receive link up 0 = PCS receive link down
LOW_POWER_ABILITY	1	RO	<b>Low-power ability</b> 1 = PCS supports low-power mode 0 = PCS does not support low-power mode

## PHY Identifier 1 (Register 3.2)

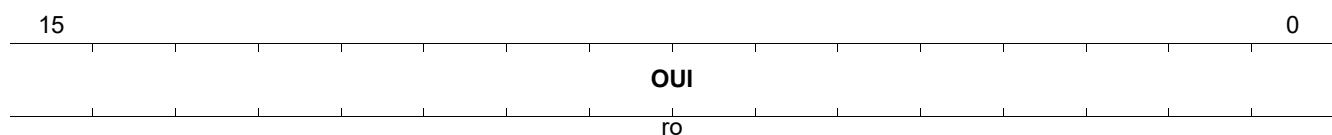
IEEE Standard Register=3.2

**PCS\_DEVID1**

## PHY Identifier 1 (Register 3.2)

### Reset Value

C133<sub>H</sub>



Field	Bits	Type	Description
OUI	15:0	RO	Organizationally Unique Identifier Bits 3:18

## PHY Identifier 2 (Register 3.3)

#### Organizationally Unique Identifier Bits 19:24

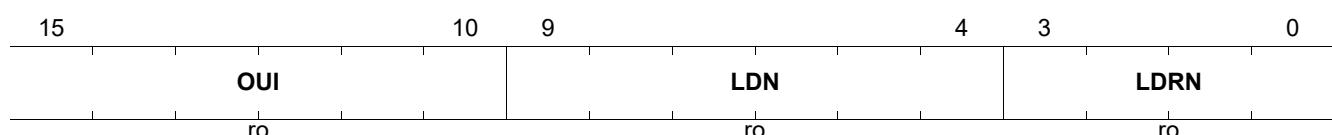
## IEEE Standard Register=3.3

PCS DEVID2

## PHY Identifier 2 (Register 3.3)

### Reset Value

5400<sub>H</sub>



Field	Bits	Type	Description
OUI	15:10	RO	<b>Organizationally Unique Identifier Bits 19:24</b>
LDN	9:4	RO	<b>Device Number</b> Specifies the device number <sup>1)</sup> to distinguish between several products.
LDRN	3:0	RO	<b>Device Number</b> Specifies the device revision number <sup>1)</sup> to distinguish between several versions of this device

1) For the device specific reset value, refer to Product Naming table in the [Package Outline](#) chapter.

**PCS speed ability (Register 3.4)**

IEEE Standard Register=3.4

PCS_SPEED_ABILITY										Reset Value	
PCS speed ability (Register 3.4)										0000 <sub>H</sub>	

15	Res						7	6	5	4	3	2	1	0
								R2G5_- CA*	ro	Res	R100G_- C*	R40G_- CA*	R10PA- SS*	R10G_- CA*

Field	Bits	Type	Description
R2G5_CAPAB LE	6	RO	<b>2G5 capable</b> Bit is always set to 0 because PCS is not capable of operating at 2.5 Gb/s
R100G_CAPA BLE	3	RO	<b>100G capable</b> 1 = PCS is capable of operating at 100 Gb/s 0 = PCS is not capable of operating at 100 Gb/s
R40G_CAPAB LE	2	RO	<b>40G capable</b> 1 = PCS is capable of operating at 40 Gb/s 0 = PCS is not capable of operating at 40 Gb/s
R10PASS_TS _2BASE_TL	1	RO	<b>10PASS-TS/2BASE-TL Capable</b> 1 = PCS is capable of operating as the 10P/2B PCS 0 = PCS is not capable of operating as the 10P/2B PCS
R10G_CAPAB LE	0	RO	<b>10G capable</b> 1 = PCS is capable of operating at 10 Gb/s 0 = PCS is not capable of operating at 10 Gb/s

**PCS Devices in package 1 (Register 3.5)**

IEEE Standard Register=3.5

PCS_DIP1															Reset Value	
PCS Devices in package 1 (Register 3.5)															008B <sub>H</sub>	

15	RES		12	11	10	9	8	7	6	5	4	3	2	1	0
				ro											

Field	Bits	Type	Description
RES	15:12	RO	<b>Reserved</b> Ignore on Read
SEPARATED_ PMA_4	11	RO	<b>Separate PMA (4)</b> 1 = Separate PMA (4) present in package

Field	Bits	Type	Description (cont'd)
SEP_PMA_3	10	RO	<b>Separate PMA (3)</b> 1 = Separate PMA (3) present in package 0 = Separate PMA (3) not present in package
SEPARATED_PMA_2	9	RO	<b>Separate PMA (2)</b> 1 = Separate PMA (2) present in package present 0 = Separate PMA (2) not present in package
SEPARATED_PMA_1	8	RO	<b>Separate PMA (1)</b> 1 = Separate PMA (1) present in package present 0 = Separate PMA (1) not present in package
ANEG	7	RO	<b>Auto-Negotiation present</b> 1 = Auto-Negotiation present in package 0 = Auto-Negotiation not present in package
TC	6	RO	<b>TC present</b> 1 = TC present in package 0 = TC not present in package
DTE_XS	5	RO	<b>DTE XS present</b> 1 = DTE XS present in package 0 = DTE XS not present in package
PHY_XS	4	RO	<b>PHY XS present</b> 1 = PHY XS present in package 0 = PHY XS not present in package
PCS	3	RO	<b>PCS present</b> 1 = PCS present in package 0 = PCS not present in package
WIS_PRESENT	2	RO	<b>WIS present</b> 1 = WIS present in package 0 = WIS not present in package
PMD_PMA	1	RO	<b>PMD/PMA present</b> 1 = PMA/PMD present in package 0 = PMA/PMD not present in package
CL22	0	RO	<b>Clause 22 registers present</b> 1 = Clause 22 registers present in package 0 = Clause 22 registers not present in package

## PCS Devices in package 2 (Register 3.6)

IEEE Standard Register=3.6

PCS DIP2

### Reset Value

### PCS Devices in package 2 (Register 3.6)

C000<sub>H</sub>

Field	Bits	Type	Description
VENDOR_SPECIFIC_DEVIC_2	15	RO	<b>Vendor-specific device 2</b> 1 = Vendor-specific device 2 present in package 0 = Vendor-specific device 2 not present in package
VENDOR_SPECIFIC_DEVIC_1	14	RO	<b>Vendor-specific device 1</b> 1 = Vendor-specific device 1 present in package 0 = Vendor-specific device 1 not present in package
CLAUSE_22_EXTENSION	13	RO	<b>Clause 22 extension</b> 1 = Clause 22 extension present in package 0 = Clause 22 extension not present in package
RES	12:0	RO	<b>Reserved</b> Ignore on read

**PCS status 2 (Register 3.8)**

IEEE Standard Register=3.8

**PCS\_STAT2**
**PCS status 2 (Register 3.8)** **Reset Value**
**8000<sub>H</sub>**

15	14	13	12	11	10	9			6	5	4	3	2	1	0					
<b>DEVICE_PRESENT</b>	Res	<b>R2G5_CAPABILE</b>	<b>TX_FAULT</b>	<b>RX_FAULT</b>			Res		<b>R100GBASE_R_CAPABLE</b>	<b>R40GBASE_R_CAPABLE</b>	<b>R10GBASE_T_CAPABLE</b>	<b>R10GBASE_W_CAPABLE</b>	<b>R10GBASE_X_CAPABLE</b>	<b>R10GBASE_R_CAPABLE</b>						
ro		ro	ro	ro	ro				ro	ro	ro	ro	ro	ro	ro					

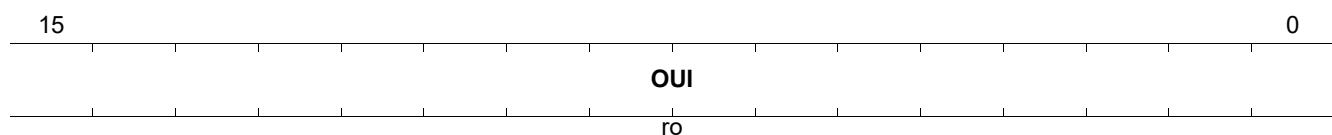
Field	Bits	Type	Description
DEVICE_PRESENT	15:14	RO	<b>Device present</b> 1 0 = Device responding at this address 1 1 = No device responding at this address 0 1 = No device responding at this address 0 0 = No device responding at this address
R2G5_CAPABILE	12	RO	<b>2G5BASE-T capable</b> 1 = PCS is able to support 2.5GBASE-T PCS Type 0 = Not able to support 2.5GBASE-T
TX_FAULT	11	RO	<b>Transmit fault</b> 1 = Fault condition on transmit path 0 = No fault condition on transmit path
RX_FAULT	10	RO	<b>Receive fault</b> 1 = Fault condition on the receive path 0 = No fault condition on the receive path
R100GBASE_R_CAPABLE	5	RO	<b>100GBASE-R capable</b> 1 = PCS is able to support 100GBASE-R PCS type 0 = PCS is not able to support 100GBASE-R PCS type
R40GBASE_R_CAPABLE	4	RO	<b>40GBASE-R capable</b> 1 = PCS is able to support 40GBASE-R PCS type 0 = PCS is not able to support 40GBASE-R PCS type
R10GBASE_T_CAPABLE	3	RO	<b>10GBASE-T capable</b> 1 = PCS is able to support 10GBASE-T PCS type 0 = PCS is not able to support 10GBASE-T PCS type
R10GBASE_W_CAPABLE	2	RO	<b>10GBASE-W capable</b> 1 = PCS is able to support 10GBASE-W PCS type 0 = PCS is not able to support 10GBASE-W PCS type
R10GBASE_X_CAPABLE	1	RO	<b>10GBASE-X capable</b> 1 = PCS is able to support 10GBASE-X PCS type 0 = PCS is not able to support 10GBASE-X PCS type
R10GBASE_R_CAPABLE	0	RO	<b>10GBASE-R capable</b> 1 = PCS is able to support 10GBASE-R PCS types 0 = PCS is not able to support 10GBASE-R PCS types

**PCS package identifier 1 (Register 3.14)**

IEEE Standard Register=3.14

**PCS\_PACKID1****PCS package identifier 1 (Register 3.14)**

**Reset Value**  
**C133<sub>H</sub>**



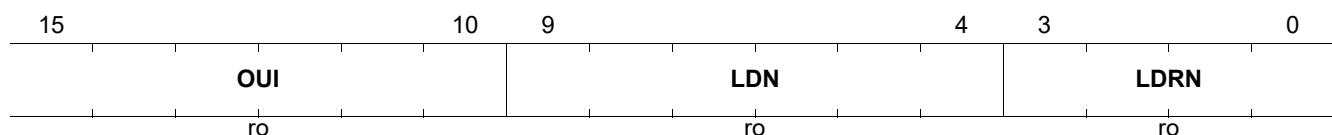
Field	Bits	Type	Description
OUI	15:0	RO	Organizationally Unique Identifier Bits 3:18

**PCS package identifier 2 (Register 3.15)**

IEEE Standard Register=3.15

**PCS\_PACKID2****PCS package identifier 2 (Register 3.15)**

**Reset Value**  
**5400<sub>H</sub>**



Field	Bits	Type	Description
OUI	15:10	RO	Organizationally Unique Identifier Bits 19:24
LDN	9:4	RO	<b>Device Number</b> Specifies the device number <sup>1)</sup> to distinguish between several products.
LDRN	3:0	RO	<b>Device Number</b> Specifies the device revision number <sup>1)</sup> to distinguish between several versions of this device

1) For the device specific reset value, refer to Product Naming table in the [Package Outline](#) chapter.

**PCS EEE capability (Register 3.20)**

IEEE Standard Register=3.20

<b>PCS_EEE_CAP</b>										Reset Value
<b>PCS EEE capability (Register 3.20)</b>										<b>0006<sub>H</sub></b>

15	Res	7	6	5	4	3	2	1	0	Res
			ro							

Field	Bits	Type	Description
R10GBASE_K_R_EEE	6	RO	<b>10GBASE-KR EEE</b> 1 = EEE is supported for 10GBASE-KR 0 = EEE is not supported for 10GBASE-KR
R10GBASE_KX4_EEE	5	RO	<b>10GBASE-KX4 EEE</b> 1 = EEE is supported for 10GBASE-KX4 0 = EEE is not supported for 10GBASE-KX4
R1000BASE_KX_EEE	4	RO	<b>1000BASE-KX EEE</b> 1 = EEE is supported for 1000BASE-KX 0 = EEE is not supported for 1000BASE-KX
R10GBASE_T_EEE	3	RO	<b>10GBASE-T EEE</b> 1 = EEE is supported for 10GBASE-T 0 = EEE is not supported for 10GBASE-T
R1000BASE_T_EEE	2	RO	<b>1000BASE-T EEE</b> 1 = EEE is supported for 1000BASE-T 0 = EEE is not supported for 1000BASE-T
R100BASE_TX_EEE	1	RO	<b>100BASE-TX EEE</b> 1 = EEE is supported for 100BASE-TX 0 = EEE is not supported for 100BASE-TX

**EEE control and capability 2 (Register 3.21)**

Read only, write from STA has no effect

IEEE Standard Register=3.21

<b>PCS_EEE_CAP2</b>										Reset Value
<b>EEE control and capability 2 (Register 3.21)</b>										<b>0000<sub>H</sub></b>

15	RES	ro	2	1	0	AB5G_EEE	AB2G_5EEE
						ro	ro

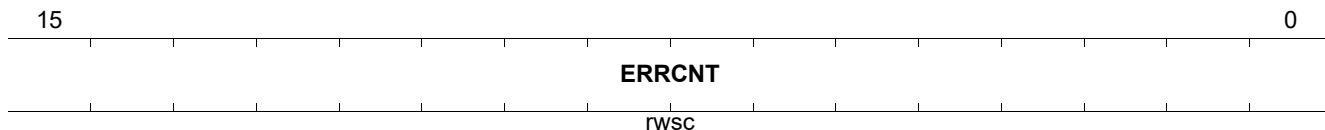
Field	Bits	Type	Description
RES	15:2	RO	<b>Reserved</b> Value always 0
AB5GEEE	1	RO	<b>EEE supported for 5GBT</b> 0 <sub>B</sub> <b>UNABLE</b> EEE supported for 5GBT 1 <sub>B</sub> <b>ABLE</b> EEE supported for 5GBT
AB2G5EEE	0	RO	<b>EEE supported for 2G5BT</b> 0 <sub>B</sub> <b>UNABLE</b> EEE not supported for 2G5BT 1 <sub>B</sub> <b>ABLE</b> EEE supported for 2G5BT

**PCS EEE Status Register 1 (Register 3.22)**

IEEE Standard Register=3.22

**PCS\_EEE\_WAKERR** Reset Value  
**0000<sub>H</sub>**

**PCS EEE Status Register 1 (Register 3.22)**



Field	Bits	Type	Description
ERRCNT	15:0	RWSC	<b>EEE Wake Error Counter</b> This is a 16-bit saturating counter indicating the number of times the GPHY fails to wake up within the EEE time. This counter is cleared upon read from the STA.

## PCS TimeSync capability register (Register 3.1800)

IEEE Standard Register=3.1800

**PCS\_TIMESYNC\_CAP** Reset Value  
**0000<sub>H</sub>**  
**PCS TimeSync capability register (Register 3.1800)**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Res														TIMES YN*	TIMES YN*
														ro	ro

Field	Bits	Type	Description
TIMESYNC_T_X_PATH_DELAY	1	RO	<b>TimeSync transmit path data delay</b> 1 = PCS provides information on transmit path data delay in registers 3.1801 through 3.1804 0 = PCS does not provide information on transmit path data delay - for GPY, the value is always zero
TIMESYNC_R_X_PATH_DELAY	0	RO	<b>TimeSync receive path data delay</b> 1 = PCS provides information on receive path data delay in registers 3.1805 through 3.1808 0 = PCS does not provide information on receive path data delay - for GPY, the value is always zero

### 6.3 Standard Auto-Negotiation Registers for MMD=0x07

This register file contains the auto-negotiation registers for MMD device 0x07.

**Table 22 Registers Overview**

Register Short Name	Register Long Name	Reset Value
<a href="#">ANEG_CTRL</a>	Auto-Negotiation Control (Register 7.0)	3000 <sub>H</sub>
<a href="#">ANEG_STAT</a>	Auto-Negotiation Status (Register 7.1)	0008 <sub>H</sub>
<a href="#">ANEG_DEVID1</a>	PHY Identifier 1 (Register 7.2)	C133 <sub>H</sub>
<a href="#">ANEG_DEVID2</a>	PHY Identifier 2 (Register 7.3)	5400 <sub>H</sub> <sup>1)</sup>
<a href="#">ANEG_DIP1</a>	Device in Package 1 (Register 7.5)	008B <sub>H</sub>
<a href="#">ANEG_DIP2</a>	Device in Package 2 (Register 7.6)	C000 <sub>H</sub>
<a href="#">ANEG_PACKID1</a>	AN package identifier (Register 7.14)	C133 <sub>H</sub>
<a href="#">ANEG_PACKID2</a>	AN package identifier (Register 7.15)	5400 <sub>H</sub> <sup>1)</sup>
<a href="#">ANEG_ADV</a>	ANEG Adv. for GPY (Register 7.16)	91E1 <sub>H</sub>
<a href="#">ANEG_LP_BP_AB</a>	AN Link Partner Base Page Ability (Register 7.19)	01E0 <sub>H</sub>
<a href="#">ANEG_XNP_TX1</a>	ANEG Local Dev XNP TX1 (Register 7.22)	0000 <sub>H</sub>
<a href="#">ANEG_XNP_TX2</a>	ANEG Local Dev XNP TX2 (Register 7.23)	0000 <sub>H</sub>
<a href="#">ANEG_XNP_TX3</a>	ANEG Local Dev XNP TX3 (Register 7.24)	0000 <sub>H</sub>
<a href="#">ANEG_LP_XNP_AB1</a>	ANEG Link Partner XNP RX (Register 7.25)	0000 <sub>H</sub>
<a href="#">ANEG_LP_XNP_AB2</a>	ANEG Link Partner XNP RX (Register 7.26)	0000 <sub>H</sub>
<a href="#">ANEG_LP_XNP_AB3</a>	ANEG Link Partner XNP RX (Register 7.27)	0000 <sub>H</sub>
<a href="#">ANEG_MGBT_AN_CTRL</a>	MULTI GBT AN Control Register (Register 7.32)	0002 <sub>H</sub>
<a href="#">ANEG_MGBT_AN_STA</a>	MultiGBASE-T AN Status register (Register 7.33)	0000 <sub>H</sub>
<a href="#">ANEG_EEE_AN_ADV1</a>	EEE Advertisement 1 (Register 7.60)	0006 <sub>H</sub>
<a href="#">ANEG_EEE_AN_LPAB1</a>	EEE Link Partner Ability 1 (Register 7.61)	0000 <sub>H</sub>
<a href="#">ANEG_EEE_AN_ADV2</a>	EEE Advertisement 2 (Register 7.62)	0000 <sub>H</sub>
<a href="#">ANEG_EEE_LP_AB2</a>	EEE Link Partner Ability 2 (Register 7.63)	0001 <sub>H</sub>

1) For the device specific reset value, refer to Product Naming table in the [Package Outline](#) chapter.

### 6.3.1 Standard Auto-Negotiation Registers for MMD=0x07

This chapter describes all registers of ANEG in detail.

#### Auto-Negotiation Control (Register 7.0)

The register controls the main function of Auto-Negotiation as defined in Clause 45. See IEEE 802.3 45.2.7.1.

This register mirrors register STD CTRL from Clause 22.

IEEE Standard Register=7.0

ANEGR_CTRL								Reset Value
Auto-Negotiation Control (Register 7.0)								3000 <sub>H</sub>

15	14	13	12	11	10	9	8	0
RST	RES3	XNP	ANEGR_EN*	RES2	ANEGR_RE*			RES1
rw	ro	rw	rw	ro	rw			ro

Field	Bits	Type	Description
RST	15	RW	<b>Reset</b> Resets entire PHY to its default state. Active links are terminated. This is a self-clearing bit: GPY firmware sets it to zero by the hardware after reset is completed. 0 <sub>B</sub> <b>NORMAL</b> GPY Normal Operation 1 <sub>B</sub> <b>RESET</b> GPY Reset
RES3	14	RO	<b>Reserved</b> Value always zero, writes ignored.
XNP	13	RW	<b>Extended Next Page Control</b> 0 <sub>B</sub> <b>ZERO</b> Extended Next Page is disabled 1 <sub>B</sub> <b>ONE</b> Extended Next Page is enabled
ANEGR_ENAB	12	RW	<b>Auto-Negotiation Enable</b> Enable the Auto-Negotiation process to determine the link configuration. Bit 7.0.12 is a copy of bit 0.12 in register 0 (STD_CTRL) (see 22.2.4.1.4). 0 <sub>B</sub> <b>ZERO</b> disable auto-negotiation process 1 <sub>B</sub> <b>ONE</b> enable auto-negotiation process
RES2	11:10	RO	<b>Reserved</b> Value always zero, writes ignored.
ANEGR_RSTA RT	9	RW	<b>Restart Auto-Negotiation</b> The Auto-Negotiation process is restarted by setting bit 7.0.9 to one. Bit 7.0.9 is a mirror of bit 0.9 in register 0 (STD_CTRL) (see IEEE 802.3 22.2.4.1.7). Completion of ANEG is indicated in bit 0.1.5 and 7.1.5. 0 <sub>B</sub> <b>ZERO</b> Normal Operation 1 <sub>B</sub> <b>RESTART</b> Restart Auto-Negotiation process
RES1	8:0	RO	<b>Reserved</b> Value always zero, writes ignored

**Auto-Negotiation Status (Register 7.1)**

All the bits in the ANEG\_STA status register are read only, and correspond to the outcome or current status of the Auto-Negotiation process.

IEEE Standard Register=7.1

ANEG_STAT													Reset Value
Auto-Negotiation Status (Register 7.1)													0008 <sub>H</sub>

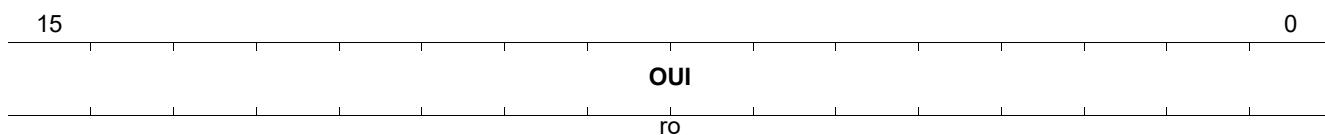
15	10	9	8	7	6	5	4	3	2	1	0		
												RES1	LP_A NEG*
												ro	ro

Field	Bits	Type	Description
RES3	15:10	RO	<b>Reserved</b> Value always zero, writes ignored.
PDF	9	RO	<b>Parallel detection fault</b> 0 <sub>B</sub> <b>NOFAULT</b> No fault was detected. 1 <sub>B</sub> <b>FAULT</b> Fault is detected via the parallel detection
RES2	8	RO	<b>Reserved</b> Value always zero, writes ignored
XNPS	7	RO	<b>Extended Next Page Status</b> When set to 1, bit 7.1.7 indicates that both the GPY and the link partner have indicated support for Extended Next Page. When set to 0, bit 7.1.7 indicates that Extended Next Page will not be used. 0 <sub>B</sub> <b>ZERO</b> Extended Next Page is not allowed. 1 <sub>B</sub> <b>ONE</b> Extended Next Page format is used.
PR	6	RO	<b>Page Received</b> The page received bit (7.1.6) is set to 1 to indicate that a new link codeword has been received and stored in the AN LP Base Page ability registers 7.19 or AN LP XNP ability registers 7.25 to 7.27. 0 <sub>B</sub> <b>ZERO</b> A page has not been received 1 <sub>B</sub> <b>ONE</b> A page has been received
ANEG_COMP LETE	5	RO	<b>Auto-Negotiation Complete</b> When read as a 1, bit 7.1.5 indicates that the Auto-Negotiation process has been completed, and that the contents of the Auto-Negotiation registers 7.16 and 7.19 are valid. When read as a zero, bit 7.1.5 indicates that the Auto-Negotiation process has not been completed, and that the contents of 7.19, 7.22 through 7.27, and 7.33 registers are as defined by the current state of the Auto-Negotiation protocol, or as written by manual configuration. 0 <sub>B</sub> <b>ZERO</b> Auto-Negotiation process has not completed 1 <sub>B</sub> <b>ONE</b> Auto-Negotiation process has completed

Field	Bits	Type	Description (cont'd)
ANEG_RF	4	ROSC	<b>Remote Fault</b> When read as one, bit 7.1.4 indicates that a remote fault condition has been detected. Bit 7.1.4 is a copy of bit 1.4 in register 1, device 0 (see 22.2.4). 0 <sub>B</sub> <b>NORMAL</b> No remote fault condition detected 1 <sub>B</sub> <b>FAULT</b> Remote fault condition detected
ANEG_ABLE	3	RO	<b>Auto-Negotiation Ability</b> Bit 7.1.3 is a copy of bit 1.3 in register 1 (see 22.2.4). This is the ANEG ability of the GPY. 0 <sub>B</sub> <b>UNABLE</b> PHY is not able to perform Auto-Negotiation 1 <sub>B</sub> <b>ABLE</b> PHY is able to perform Auto-Negotiation
LINKSTA	2	RO	<b>Link Status</b> When read as a one, bit 7.1.2 indicates that the PMA/PMD has determined that a valid link has been established. This bit is a duplicate of the PMA/PMD link status bit in 1.1.2. This bit latches low, so does not represent the current status but can be used to indicate link drop since the last read from the management interface. Reading this bit from MDIO resets the bit to the current value of the link. 0 <sub>B</sub> <b>DOWN</b> Link is down 1 <sub>B</sub> <b>UP</b> Link is Up
RES1	1	RO	<b>Value always zero, write ignored</b>
LP_ANEG_AB LE	0	RO	<b>Link partner auto-negotiation ability</b> 0 <sub>B</sub> <b>UNABLE</b> Link partner is not capable of auto-negotiation. 1 <sub>B</sub> <b>ABLE</b> Link partner is capable of auto-negotiation

**PHY Identifier 1 (Register 7.2)****ANEG\_DEVID1**

Reset Value

C133<sub>H</sub>

Field	Bits	Type	Description
OUI	15:0	RO	<b>Organizationally Unique Identifier</b>

**PHY Identifier 2 (Register 7.3)**

Organizationally Unique Identifier

IEEE Standard Register=7.3

**ANEG\_DEVID2****Reset Value****5400<sub>H</sub>**

15	10	9	4	3	0
OUI		LDN		LDRN	
ro		ro		ro	

Field	Bits	Type	Description
OUI	15:10	RO	<b>Organizationally Unique Identifier</b>
LDN	9:4	RO	<b>Device Number</b> Specifies the device number <sup>1)</sup> to distinguish between several products.
LDRN	3:0	RO	<b>Device Number</b> Specifies the device revision number <sup>1)</sup> to distinguish between several versions of this device

1) For the device specific reset value, refer to Product Naming table in the [Package Outline](#) chapter.

**Device in Package 1 (Register 7.5)**

IEEE Standard Register=7.5

**ANEG\_DIP1****Reset Value****008B<sub>H</sub>**

15	12	11	10	9	8	7	6	5	4	3	2	1	0
RES		PMA4	PMA3	PMA2	PMA1	ANEG	TC	DTEX S	PHYX S	PCS	WIS	PMAP MD	CL22
ro		ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro	ro

Field	Bits	Type	Description
RES	15:12	RO	<b>Reserved</b> Ignore on Read
PMA4	11	RO	<b>Separate PMA4 present in package</b> 0 <sub>B</sub> <b>ABSENT</b> Separate PMA4 not present in package 1 <sub>B</sub> <b>PRESENT</b> Separate PMA4 present in package
PMA3	10	RO	<b>Separate PMA3 present in package</b> 0 <sub>B</sub> <b>ABSENT</b> Separate PMA3 not present in package 1 <sub>B</sub> <b>PRESENT</b> Separate PMA3 present in package

Field	Bits	Type	Description (cont'd)
PMA2	9	RO	<b>Separate PMA2 present in package</b> $0_B$ <b>ABSENT</b> Separate PMA2 not present in package $1_B$ <b>PRESENT</b> Separate PMA2 present in package
PMA1	8	RO	<b>Separate PMA1 present in package</b> $0_B$ <b>ABSENT</b> Separate PMA1 not present in package $1_B$ <b>PRESENT</b> Separate PMA1 present in package
ANEG	7	RO	<b>Auto-negotiation present in package</b> $0_B$ <b>ABSENT</b> ANEG not present in package $1_B$ <b>PRESENT</b> ANEG present in package
TC	6	RO	<b>TC present in package</b> $0_B$ <b>ABSENT</b> TC registers not present in package $1_B$ <b>PRESENT</b> TC registers present in package
DTEXS	5	RO	<b>DTE XS present in package</b> $0_B$ <b>ABSENT</b> DTE XS registers not present in package $1_B$ <b>PRESENT</b> DTE XS registers present in package
PHYXS	4	RO	<b>PHYXS present in package</b> $0_B$ <b>ABSENT</b> PHYXS registers not present in package $1_B$ <b>PRESENT</b> PHYXS registers present in package
PCS	3	RO	<b>PCS present in package</b> $0_B$ <b>ABSENT</b> PCS registers not present in package $1_B$ <b>PRESENT</b> PCS registers present in package
WIS	2	RO	<b>WIS present in package</b> $0_B$ <b>ABSENT</b> WIS registers present in package $1_B$ <b>PRESENT</b> WIS registers present in package
PMAPMD	1	RO	<b>PMA PMD presence in package</b> $0_B$ <b>ABSENT</b> PMA PMD registers not present in package $1_B$ <b>PRESENT</b> PMA PMD registers present in package
CL22	0	RO	<b>Clause 22 register present in package</b> $0_B$ <b>ABSENT</b> Clause 22 registers not present in package $1_B$ <b>PRESENT</b> Clause 22 registers present in package

#### Device in Package 2 (Register 7.6)

IEEE Standard Register=7.6

#### ANEG\_DIP2

#### Device in Package 2 (Register 7.6)

Reset Value

**C000<sub>H</sub>**

15	14	13	12	RES	0
<b>VSPE C2</b>	<b>VSPE C1</b>	<b>CL22E XT</b>			

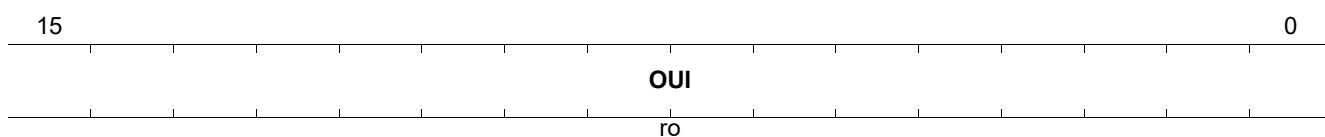
Field	Bits	Type	Description
VSPEC2	15	RO	<b>Vendor Specific Device 2 present in package</b> 0 <sub>B</sub> <b>ABSENT</b> Vendor Specific Device 2 not present in package 1 <sub>B</sub> <b>PRESENT</b> Vendor Specific Device 2 present in package
VSPEC1	14	RO	<b>Vendor Specific Device 1 present in package</b> 0 <sub>B</sub> <b>ABSENT</b> Vendor Specific Device 1 not present in package 1 <sub>B</sub> <b>PRESENT</b> Vendor Specific Device 1 present in package
CL22EXT	13	RO	<b>Clause 22 extension present in package</b> 0 <sub>B</sub> <b>ABSENT</b> Clause 22 extension not present in package 1 <sub>B</sub> <b>PRESENT</b> Clause 22 extension present in package
RES	12:0	RO	<b>Reserved</b> Ignore on read

**AN package identifier (Register 7.14)**

IEEE Standard Register=7.14

**ANEG\_PACKID1**

Reset Value

**AN package identifier (Register 7.14)**C133<sub>H</sub>

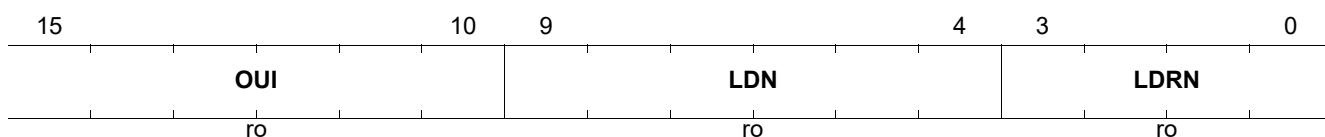
Field	Bits	Type	Description
OUI	15:0	RO	<b>Organizationally Unique Identifier</b> Organizationally Unique Identifier Bits 3:18

**AN package identifier (Register 7.15)**

IEEE Standard Register=7.15

**ANEG\_PACKID2**

Reset Value

**AN package identifier (Register 7.15)**5400<sub>H</sub>

Field	Bits	Type	Description
OUI	15:10	RO	<b>Organizationally Unique Identifier Bits 19:24</b>
LDN	9:4	RO	<b>Device Number</b> Specifies the device number <sup>1)</sup> to distinguish between several products.

Field	Bits	Type	Description (cont'd)
LDRN	3:0	RO	<b>Device Number</b> Specifies the device revision number <sup>1)</sup> to distinguish between several versions of this device

1) For the device specific reset value, refer to Product Naming table in the [Package Outline](#) chapter.

### ANEG Adv. for GPY (Register 7.16)

This register is a copy of the Auto-Negotiation advertisement register (Register 4). A read to the AN advertisement register (7.16) reports the value of the Auto-Negotiation advertisement register (Register 4); writes to the AN advertisement register (7.16) cause a write to occur to the Auto-Negotiation advertisement register (Register 4). IEEE Standard Register=7.16

ANEG_ADV								Reset Value		
ANEG Adv. for GPY (Register 7.16)								91E1 <sub>H</sub>		
15	14	13	12	11				5	4	0
NP	RES	RF	XNP		TAF				SF	
rw	ro	rw	rw		rw				rw	

Field	Bits	Type	Description
NP	15	RW	<b>Next Page Able</b> 0 <sub>B</sub> <b>INACTIVE</b> No Next page allowed 1 <sub>B</sub> <b>ACTIVE</b> Additional Next Page will follow.
RES	14	RO	<b>Reserved</b> Write as zero, ignore on read.
RF	13	RW	<b>Remote Fault</b> The remote fault bit allows indication of a fault to the link partner. See IEEE 802.3 28.2.1.2.4.
XNP	12	RW	<b>Indicates that GPY supports transmission of Extended Next Pages</b> 0 <sub>B</sub> <b>UNABLE</b> GPY is XNP unable 1 <sub>B</sub> <b>ABLE</b> GPY is XNP able
TAF	11:5	RW	<b>Technology Ability Field</b> The technology ability field is an 8-bit wide field containing information indicating supported technologies. GPY supports 10BASE-T (Half and Full Duplex), 100BASE-TX (Half and Full Duplex) and both symmetric and asymmetric PAUSE. 40 <sub>H</sub> <b>PS_ASYM</b> Advertise asymmetric pause 20 <sub>H</sub> <b>PS_SYM</b> Advertise symmetric pause 10 <sub>H</sub> <b>DBT4</b> Advertise 100BASE-T4 08 <sub>H</sub> <b>DBT_FDX</b> Advertise 100BASE-TX full duplex 04 <sub>H</sub> <b>DBT_HDX</b> Advertise 100BASE-TX half duplex 02 <sub>H</sub> <b>XBT_FDX</b> Advertise 10BASE-T full duplex 01 <sub>H</sub> <b>XBT_HDX</b> Advertise 10BASE-T half duplex

Field	Bits	Type	Description (cont'd)
SF	4:0	RW	<b>Selector Field</b> This field is always set to 1 because GPY only supports 802.3 Ethernet standard. $00001_B$ <b>IEEE8023</b> IEEE802.3 Select the IEEE 802.3 technology

**AN Link Partner Base Page Ability (Register 7.19)**

Register 7.19 is a copy of register 5 from Clause 28. It contains the Base Page received from the link partner.

All of the bits in the AN LP Base Page ability register are read only.

IEEE Standard Register=7.19

ANEG_LP_BP_AB	Reset Value
<b>AN Link Partner Base Page Ability (Register 7.19)</b>	<b>01E0<sub>H</sub></b>

15	14	13	12	11		5	4	0
NP	ACK	RF	XNP		TAF		SF	

Field	Bits	Type	Description
NP	15	RO	<b>Link Partner Next Page</b> Next page request indication from the link partner. See IEEE 802.3 28.2.1.2.6. $0_B$ <b>INACTIVE</b> No Next Page to Follow $1_B$ <b>ACTIVE</b> Additional Next Page will follow
ACK	14	RO	<b>Link Partner Acknowledge</b> Acknowledgement indication from the link partner's link code word. See IEEE 802.3 28.2.1.2.5. $0_B$ <b>INACTIVE</b> Device did not successfully receive its Link Partner's LCW $1_B$ <b>ACTIVE</b> The device has successfully received its link partner's link code word
RF	13	RO	<b>Link Partner Remote Fault</b> Remote fault indication from the link partner. See IEEE 802.3 28.2.1.2.4. $0_B$ <b>NONE</b> Remote fault is not indicated by the link partner $1_B$ <b>FAULT</b> Remote fault is indicated by the link partner
XNP	12	RO	<b>Link Partner XNP Ability</b> $0_B$ <b>UNABLE</b> Link Partner is not XNP able $1_B$ <b>ABLE</b> Link Partner is XNP able

Field	Bits	Type	Description (cont'd)
TAF	11:5	RW	<p><b>Technology Ability Field</b>            Indicate the link partner's supported technologies received in base page.</p> <p>40<sub>H</sub> <b>PS_ASYM</b> Advertise asymmetric pause            20<sub>H</sub> <b>PS_SYM</b> Advertise symmetric pause            10<sub>H</sub> <b>DBT4</b> Advertise 100BASE-T4            08<sub>H</sub> <b>DBT_FDX</b> Advertise 100BASE-TX full duplex            04<sub>H</sub> <b>DBT_HDX</b> Advertise 100BASE-TX half duplex            02<sub>H</sub> <b>XBT_FDX</b> Advertise 10BASE-T full duplex            01<sub>H</sub> <b>XBT_HDX</b> Advertise 10BASE-T half duplex</p>
SF	4:0	RO	<p><b>Link Partner Selector Field</b>            The selector field represents one of the 32 possible messages with encoding definitions shown in IEEE 802.3 Annex 28A.</p> <p>0x00 = Reserved            0x01 = IEEE 802.3            0x02 = IEEE 802.9 ISLAN-16T            0x03 = IEEE 802.5            0x04 = IEEE 1394            0x05 -&gt; 0x1F = Reserve            00001<sub>B</sub> <b>IEEE8023</b> IEEE802.3 Select the IEEE 802.3 technology</p>

**ANEG Local Dev XNP TX1 (Register 7.22)**

**ANEG\_XNP\_TX1** Reset Value  
0000<sub>H</sub>  
**ANEG Local Dev XNP TX1 (Register 7.22)**

15	14	13	12	11	10		0
NP	RES	MP	ACK2	TOGG		MCF	
RW	RO	RW	RW	RO		RW	

Field	Bits	Type	Description
NP	15	RW	<p><b>Next Page</b>            When NP bit is set, the GPY requests to transmit one additional page. Next Page transmission ends when both ends of a link segment set their Next Page bits to logic zero, indicating that neither has anything additional to transmit. See IEEE 802.3 28.2.3.4.</p> <p>0<sub>B</sub> <b>INACTIVE</b> No Next Page to Follow            1<sub>B</sub> <b>ACTIVE</b> Additional next page(s) will follow</p>
RES	14	RO	<p><b>Reserved</b>            Write as zero, ignore on read.</p>

Field	Bits	Type	Description (cont'd)
MP	13	RW	<b>Message Page</b> Message Page (MP) is used by the Next Page function to differentiate a Message Page from an Unformatted Page. Only message pages are used by GPY. 0 <sub>B</sub> <b>UNFOR</b> Unformatted Page 1 <sub>B</sub> <b>MESSG</b> Message Page
ACK2	12	RW	<b>Acknowledge 2</b> Not used during GPY auto negotiation. 0 <sub>B</sub> <b>INACTIVE</b> Device cannot comply with message 1 <sub>B</sub> <b>ACTIVE</b> Device will comply with message
TOGG	11	RO	<b>Toggle</b> The Toggle bit is used to ensure proper synchronization between the GPY and the Link Partner. See IEEE 802.3 28.2.3.4. 0 <sub>B</sub> <b>ZERO</b> Previous value of the Tx LCW was ONE 1 <sub>B</sub> <b>ONE</b> Previous value of the Tx LCW was ZERO
MCF	10:0	RW	<b>Message Code Field</b> When Message Page bit is set to 1 (7.16.1), this field is the Message Code Field of a message page used in Next Page exchange. The message codes are described in IEEE 802.3 Appendix 28C. It is used to indicate the type of message in UCF1 and UCF2. 0x0 = Reserved 0x1 = Null message 0x2 = One Unformatted Page (UP) with TAF follows 0x3 = Two UPs with TAF follows 0x4 = Remote fault details message 0x5 = OUI message 0x6 = PHY ID message 0x7 = 100BASE-T2 message 0x8 = 1000BASE-T message 0x9 = MULTIGBASE-T message 0xA = EEE technology capability follows in next UP 0xB = OUI XNP

**ANEG Local Dev XNP TX2 (Register 7.23)**

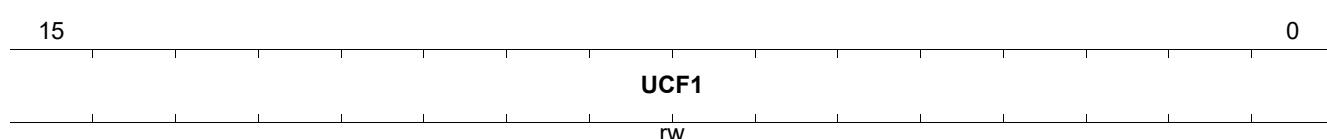
Unformatted Code field 1 contains Seed information and advertises support of 1GBT full duplex and half duplex.

See 28.2.3.4

IEEE Standard Register=7.23

**ANEG\_XNP\_TX2**

Reset Value

**ANEG Local Dev XNP TX2 (Register 7.23)**0000<sub>H</sub>

Field	Bits	Type	Description
UCF1	15:0	RW	<b>Unformatted Code Field 1</b> Transmits Master-Slave Seed bit to facilitate Auto-negotiation resolution, port type and duplex capability.

**ANEG Local Dev XNP TX3 (Register 7.24)**

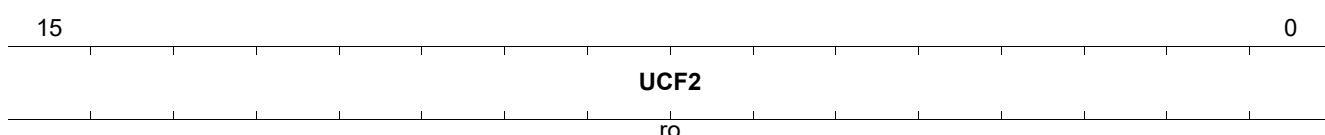
Unformatted Code field 2 - Register 7.24

See 28.2.3.4

IEEE Standard Register=7.24

**ANEG\_XNP\_TX3**

Reset Value

0000<sub>H</sub>**Field**

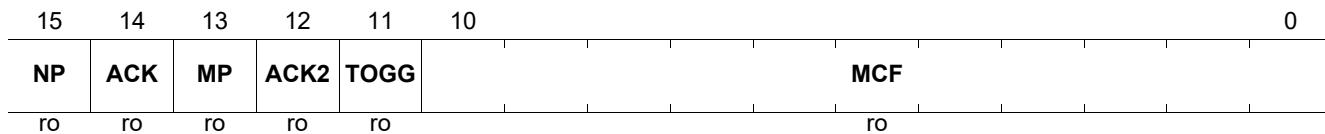
Field	Bits	Type	Description
UCF2	15:0	RO	<b>Unformatted Code Field 2</b>

**ANEG Link Partner XNP RX (Register 7.25)**

IEEE Standard Register=7.25

**ANEG\_LP\_XNP\_AB1**

Reset Value

0000<sub>H</sub>**Field**

Field	Bits	Type	Description
NP	15	RO	<b>Link Partner Next Page</b> See 28.2.3.4.3 Next Page (NP) is used by the Next Page function to indicate whether or not this is the last Next Page to be transmitted. 0 <sub>B</sub> <b>INACTIVE</b> Last Page 1 <sub>B</sub> <b>ACTIVE</b> Additional next page(s) will follow
ACK	14	RO	<b>Link Partner Acknowledge</b> As defined in 28.2.1.2.5. Acknowledge (Ack) is used by the Auto-Negotiation function to indicate that GPY has successfully received its Link Partner's link codeword.

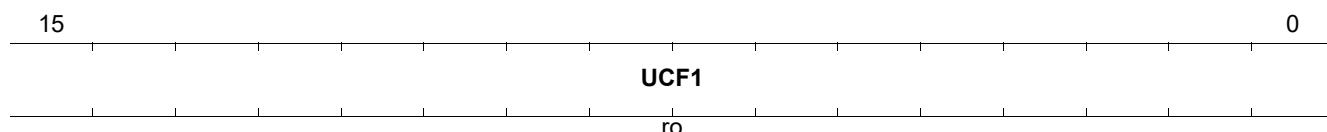
Field	Bits	Type	Description (cont'd)
MP	13	RO	<b>Link Partner Message Page</b> Indicates that the content of MCF is either an unformatted page or a formatted message. See IEEE 802.3 28.2.3.4. 0 <sub>B</sub> <b>UNFOR</b> Unformatted Page 1 <sub>B</sub> <b>MESSG</b> Message Page
ACK2	12	RO	<b>Link Partner Acknowledge 2</b> See IEEE 802.3 28.2.3.4. 0 <sub>B</sub> <b>INACTIVE</b> Device cannot comply with message 1 <sub>B</sub> <b>ACTIVE</b> Device will comply with message
TOGG	11	RO	<b>Link Partner Toggle</b> See IEEE 802.3 28.2.3.4. Set to the opposite of TOGG bit in previous page. 0 <sub>B</sub> <b>ZERO</b> Previous value of the TX LCW was ONE 1 <sub>B</sub> <b>ONE</b> Previous value of the TX LCW was ZERO
MCF	10:0	RO	<b>Link Partner Message Code Field</b> Indicate the type of Message Code. See IEEE 802.3 28.2.3.4 009 <sub>H</sub> <b>MC_2G5BT</b> Message Code for 2G5BT

**ANEG Link Partner XNP RX (Register 7.26)**

IEEE Standard Register=7.26

**Reset Value**  
**0000<sub>H</sub>**

**ANEG\_LP\_XNP\_AB2**

**ANEG Link Partner XNP RX (Register 7.26)**


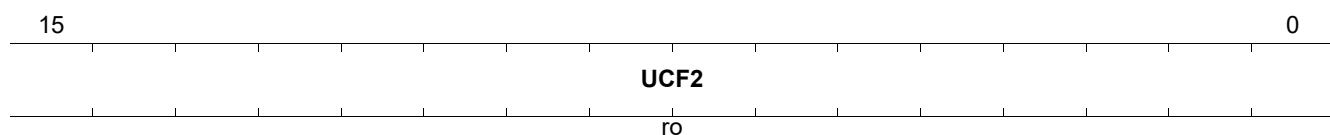
Field	Bits	Type	Description
UCF1	15:0	RO	<b>Unformatted Code Field 1</b> See 28.2.3.4

**ANEG Link Partner XNP RX (Register 7.27)**

IEEE Standard Register=7.27

**ANEG\_LP\_XNP\_AB3**

Reset Value

 0000<sub>H</sub>


Field	Bits	Type	Description
UCF2	15:0	RO	<b>Unformatted Code Field 2</b> See 28.2.3.4

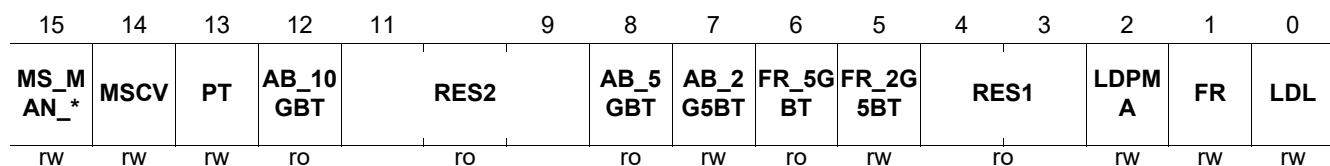
**MULTI GBT AN Control Register (Register 7.32)**

Advertise the GPY Capabilities

IEEE Standard Register=7.32

**ANEG\_MGBT\_AN\_CTRL**

Reset Value

 0002<sub>H</sub>


Field	Bits	Type	Description
MS_MAN_EN	15	RW	<b>Master Slave Config Manual Config Enable</b> 0 <sub>B</sub> ANEG ANEG is used to determine Master-Slave selection 1 <sub>B</sub> MAN Manual Config, MSCV bit determines Master-Slave
MSCV	14	RW	<b>Master Slave Config Value</b> 0 <sub>B</sub> SLAVE Manual set to SLAVE 1 <sub>B</sub> MASTER Manual set to MASTER
PT	13	RW	<b>Port Type</b> 0 <sub>B</sub> MASTER Preference as Master - Single Port Device 1 <sub>B</sub> SLAVE Preference as Slave - Multiport Device
AB_10GBT	12	RO	<b>10GBASE-T Ability</b> Not Supported - always 0
RES2	11:9	RO	<b>Reserved</b> Value always zero, writes ignored.

Field	Bits	Type	Description (cont'd)
AB_5GBT	8	RO	<b>5GBASE-T ability</b> Not supported by GPY 0 <sub>B</sub> <b>UNABLE</b> Do not Advertise PHY as 5GBASE-T capable 1 <sub>B</sub> <b>ABLE</b> Advertise PHY as 5GBASE-T capable. Not supported
AB_2G5BT	7	RW	<b>2.5 G BASE-T ability</b> Not supported by GPY. 0 <sub>B</sub> <b>UNABLE</b> Do not Advertise PHY as 2.5GBASE-T capable 1 <sub>B</sub> <b>ABLE</b> Advertise PHY as 2.5GBASE-T capable
FR_5GBT	6	RO	<b>5 G BASE-T Fast Retrain Ability</b> Not supported by GPY. See 45.2.7.10 bz 0 <sub>B</sub> <b>UNABLE</b> Do not Advertise PHY as 5GBT Fast retrain able 1 <sub>B</sub> <b>ABLE</b> Advertise PHY as 5GBASE-T Fast Retrain capable. Not supported
FR_2G5BT	5	RW	<b>2.5 G BASE-T Fast Retrain Ability</b> Not supported by GPY. See 45.2.7.10 bz 0 <sub>B</sub> <b>UNABLE</b> Do not Advertise PHY as 2.5G Fast Retrain Able 1 <sub>B</sub> <b>ABLE</b> Advertise PHY as 2.5G Fast retrain able
RES1	4:3	RO	<b>Reserved</b> Value always zero, writes ignored.
LDPMA	2	RW	<b>GPY PMA training reset request</b> If set to one the GPY expects the link partner to reset the PMA training PRBS for every PMA training frame. If bit is zero then the GPY expects link partner to run PMA training PRBS continuously through every PMA training frame
FR	1	RW	<b>Fast Retrain Ability</b>
LDL	0	RW	<b>GPY Loop Timing Ability</b>

**MultiGBASE-T AN Status register (Register 7.33)**

IEEE Standard Register=7.33

**ANEG\_MGBT\_AN\_STA**

Reset Value

**MultiGBASE-T AN Status register (Register 7.33)**0000<sub>H</sub>

15								7	6	5	4	3	2	0
Res								AB_5GBT	AB_2G5BT	FR_5GBT	FR_2G5BT	Res		
								ro	ro	ro	ro			

Field	Bits	Type	Description
AB_5GBT	6	RO	<b>5G BASE-T Ability of Link Partner</b> This bit is only valid after link is established and ANEG completed. 0 <sub>B</sub> <b>UNABLE</b> Link partner is not capable of 5GBASE-T 1 <sub>B</sub> <b>ABLE</b> Link partner is capable of 5GBASE-T

Field	Bits	Type	Description (cont'd)
AB_2G5BT	5	RO	<b>2.5 G BASE-T Ability of Link Partner</b> This bit is only valid after link is established and ANEG completed ( bit 7.1.5 is set to 1). 0 <sub>B</sub> <b>UNABLE</b> Link partner is not capable of 2.5GBASE-T 1 <sub>B</sub> <b>ABLE</b> Link partner is capable of 2.5GBASE-T
FR_5GBT	4	RO	<b>5 G BASE-T Fast Retrain Ability of Link Partner</b> This bit is only valid after link is established and ANEG completed. 0 <sub>B</sub> <b>UNABLE</b> Link partner is not capable of 5GBT fast retrain 1 <sub>B</sub> <b>ABLE</b> Link partner is capable of 5GBT fast retrain
FR_2G5BT	3	RO	<b>2.5 G BASE-T Fast Retrain Ability of Link Partner</b> This bit is only valid after link is established and ANEG completed ( bit 7.1.5 is set to 1). 0 <sub>B</sub> <b>UNABLE</b> Link partner is not capable of 2.5GBT fast retrain 1 <sub>B</sub> <b>ABLE</b> Link partner is capable of 2.5GBT fast retrain

**EEE Advertisement 1 (Register 7.60)**

IEEE Standard Register=7.60

ANEG_EEE_AN_ADV1										Reset Value					
EEE Advertisement 1 (Register 7.60)										0006 <sub>H</sub>					
15							7	6	5	4	3	2	1	0	
	Res						EEE_1 0G*	EEE_1 0G*	EEE_1 00*	EEE_1 0G*	EEE_1 00*	EEE_1 00*	Res		
							ro	ro	ro	ro	ro	rw	rw		

Field	Bits	Type	Description
EEE_10GBKR	6	RO	<b>Support of 10GBASE-KR EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE
EEE_10GBKX	5	RO	<b>Support of 10GBASE-KX4 EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE
EEE_1000BKX	4	RO	<b>Support of 1000BASE-KX EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE
EEE_10GBT	3	RO	<b>Support of 10GBASE-T EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE
EEE_1000BT	2	RW	<b>Support of 1000BASE-T EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE

Field	Bits	Type	Description (cont'd)
EEE_100BTX	1	RW	<b>Support of 100BASE-TX EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE

**EEE Link Partner Ability 1 (Register 7.61)**

After the AN process is completed, this register reflects the contents of the link partner's EEE advertisement register. The definitions are the same as for the EEE AN advertisement 1 register.

IEEE Standard Register=7.61

All of the bits in the EEE LP ability 1 register are read only. A write operation to the EEE LP advertisement register has no effect.

ANEG_EEE_AN_LPAB1	Reset Value
<b>EEE Link Partner Ability 1 (Register 7.61)</b>	<b>0000<sub>H</sub></b>

15			7	6	5	4	3	2	1	0
		Res								Res

Field	Bits	Type	Description
EEE_10GBKR	6	RO	<b>Support of 10GBASE-KR EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE
EEE_10GBKX <sub>4</sub>	5	RO	<b>Support of 10GBASE-KX4 EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE
EEE_1000BKX	4	RO	<b>Support of 1000BASE-KX EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE
EEE_10GBT	3	RO	<b>Support of 10GBASE-T EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE
EEE_1000BT	2	RO	<b>Support of 1000BASE-T EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE
EEE_100BTX	1	RO	<b>Support of 100BASE-TX EEE</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode is not supported for EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode is supported for EEE

**EEE Advertisement 2 (Register 7.62)**

EEE advertisement 2 register is a continuation of EEE advertisement 1 register.

IEEE Standard Register=7.62

<b>ANEG_EEE_AN_ADV2</b>	<b>Reset Value</b>
<b>EEE Advertisement 2 (Register 7.62)</b>	<b>0000<sub>H</sub></b>

15			1	0
RES				EEE2 G5
ro				rw

<b>Field</b>	<b>Bits</b>	<b>Type</b>	<b>Description</b>
RES	15:1	RO	<b>Reserved</b>
EEE2G5	0	RW	<b>Advertise 2G5BT EEE capability</b> 0 <sub>B</sub> <b>DISABLED</b> This PHY mode does not advertise 2G5BT EEE 1 <sub>B</sub> <b>ENABLE</b> This PHY mode does advertise 2G5BT EEE

**EEE Link Partner Ability 2 (Register 7.63)**

When the AN and training processes is completed, this register reflects the contents of the link partner's EEE advertisement 2 register.

IEEE Standard Register=7.63

All of the bits in the EEE LP ability 2 register are read-only. A write to the EEE LP ability 2 register will have no effect.

<b>ANEG_EEE_LP_AB2</b>	<b>Reset Value</b>
<b>EEE Link Partner Ability 2 (Register 7.63)</b>	<b>0001<sub>H</sub></b>

15			1	0
RES				EEE2 G5
ro				ro

<b>Field</b>	<b>Bits</b>	<b>Type</b>	<b>Description</b>
RES	15:1	RO	<b>Reserved</b>
EEE2G5	0	RO	<b>Link Partner advertised 2G5BT EEE capability</b> 0 <sub>B</sub> <b>DISABLED</b> LP not 2G5BT EEE capable 1 <sub>B</sub> <b>ENABLE</b> LP 2G5BT EEE capable

## 6.4 Vendor Specific 1 Device for MMD=0x1E

This register file contains GPY specific register for MMD=30 (decimal)

**Table 23 Registers Overview**

Register Short Name	Register Long Name	Reset Value
<b>VSPEC1_LED0</b>	Configuration for LED Pin 0 (Register 30.1)	0330 <sub>H</sub>
<b>VSPEC1_LED1</b>	Configuration for LED Pin 1 (Register 30.2)	0340 <sub>H</sub>
<b>VSPEC1_LED2</b>	Configuration for LED Pin 2 (Register 30.3)	0380 <sub>H</sub>
<b>VSPEC1_MBOX_CMD</b>	Mailbox CMD type (Register 30.7)	0000 <sub>H</sub>
<b>VSPEC1_SGMII_CTRL</b>	Chip Level SGMII control register (Register 30.8)	34DA <sub>H</sub>
<b>VSPEC1_SGMII_STAT</b>	Chip Level SGMII status register (Register 30.9)	0008 <sub>H</sub>
<b>VSPEC1_NBT_DS_CTRL</b>	NBASE-T Downshift Control Register (Register 30.10)	0400 <sub>H</sub>
<b>VSPEC1_NBT_DS_STA</b>	NBASE-T Downshift Status Register (Register 30.11)	0000 <sub>H</sub>
<b>VSPEC1_PM_CTRL</b>	Packet Manager Control (Register 30.12)	2083 <sub>H</sub>
<b>VSPEC1_MBOX_DATA_HIGH</b>	Data for Mailbox (Register 30.13)	EEEE <sub>H</sub>
<b>VSPEC1_TEMP_STA</b>	Temperature code (Register 30.14)	0000 <sub>H</sub>
<b>VSPEC1_LANE_ASP_MAP</b>	ASP Mapping to Physical Lanes (Register 30.20)	00E4 <sub>H</sub>

### 6.4.1 Vendor Specific 1 Device for MMD=0x1E

This section describes all registers of VSPEC1 in detail.

#### Configuration for LED Pin 0 (Register 30.1)

This register configures the behavior of the LED0 depending on pre-defined states or events the PHY has entered into or raised. Since more than one event/state can be active at the same time, more than one function might apply simultaneously. The priority from highest to lowest is given by the order PULSE, BLINKS, BLINKF, CON.

IEEE Standard Register=30.1

VSPEC1_LED0								Reset Value
Configuration for LED Pin 0 (Register 30.1)								0310 <sub>H</sub>
15	12	11	8	7	4	3	0	
BLINKS		PULSE		CON		BLINKF		
rw		rw		rw		rw		

Field	Bits	Type	Description
BLINKS	15:12	RW	<p><b>Slow Blinking Configuration</b></p> <p>The Blink-S field selects in which PHY states the LED blinks with the pre-defined slow frequency. Each bit mask indicates a link speed. Combinations of the bit mask below can be used to provide a combination of link speed states to enable the behavior.</p> <p>0000<sub>B</sub><b>NONE</b> Not Active            0001<sub>B</sub><b>LINK10</b> Blink when Link is 10 Mbit/s            0010<sub>B</sub><b>LINK100</b> Blink when Link is 100 Mbit/s            0100<sub>B</sub><b>LINK1000</b> Blink when Link is 1000 Mbit/s            1000<sub>B</sub><b>LINK2500</b> Blink when Link is 2500 Mbit/s</p>
PULSE	11:8	RW	<p><b>Pulsing Configuration</b></p> <p>The pulse field is a mask field in which certain events can be combined, e.g. TXACT RXACT, to generate a pulse on the LED when such an event is detected.</p> <p>0000<sub>B</sub><b>NONE</b> No pulsing            0001<sub>B</sub><b>TXACT</b> Transmit activity            0010<sub>B</sub><b>RXACT</b> Receive activity            0100<sub>B</sub><b>COL</b> Collision            1000<sub>B</sub><b>NO_CON</b> Constant ON behavior is switched off</p>
CON	7:4	RW	<p><b>Constant On Configuration</b></p> <p>The Constant-ON field selects in which PHY states the LED is constantly on. Each bit mask indicates a link speed. Combinations of the bit mask below can be used to provide a combination of link speed states to enable the behavior.</p> <p>0000<sub>B</sub><b>NONE</b> Not Active            0001<sub>B</sub><b>LINK10</b> On when Link is 10 Mbit/s            0010<sub>B</sub><b>LINK100</b> On when Link is 100 Mbit/s            0100<sub>B</sub><b>LINK1000</b> On when Link is 1000 Mbit/s            1000<sub>B</sub><b>LINK2500</b> On when Link is 2500 Mbit/s</p>
BLINKF	3:0	RW	<p><b>Fast Blinking Configuration</b></p> <p>The Blink-F Field selects in which PHY states the LED blinks with the pre-defined fast frequency. Each bit mask indicates a link speed. Combinations of the bit mask below can be used to provide a combination of link speed states to enable the behavior.</p> <p>0000<sub>B</sub><b>NONE</b> No Active            0001<sub>B</sub><b>LINK10</b> Blink when Link is 10 Mbit/s            0010<sub>B</sub><b>LINK100</b> Blink when Link is 100 Mbit/s            0100<sub>B</sub><b>LINK1000</b> Blink when Link is 1000 Mbit/s            1000<sub>B</sub><b>LINK2500</b> Blink when Link is 2500 Mbit/s</p>

**Configuration for LED Pin 1 (Register 30.2)**

Configuration Register for LED Pin 1

IEEE Standard Register=30.2

**VSPEC1\_LED1****Reset Value****0320<sub>H</sub>**

15	12	11	8	7	4	3	0
	BLINKS		PULSE		CON		BLINKF
rw			rw		rw		rw

Field	Bits	Type	Description
BLINKS	15:12	RW	<p><b>Slow Blinking Configuration</b></p> <p>The Blink-S field selects in which PHY states the LED blinks with the pre-defined slow frequency. Each bit mask indicates a link speed. Combinations of the bit mask below can be used to provide a combination of link speed states to enable the behavior.</p> <p>0000<sub>B</sub><b>NONE</b> Not Active            0001<sub>B</sub><b>LINK10</b> Blink when Link is 10 Mbit/s            0010<sub>B</sub><b>LINK100</b> Blink when Link is 100 Mbit/s            0100<sub>B</sub><b>LINK1000</b> Blink when Link is 1000 Mbit/s            1000<sub>B</sub><b>LINK2500</b> Blink when Link is 2500 Mbit/s</p>
PULSE	11:8	RW	<p><b>Pulsing Configuration</b></p> <p>The pulse field is a mask field by which certain events can be combined, e.g. TXACT RXACT, to generate a pulse on the LED when such an event is detected.</p> <p>0000<sub>B</sub><b>NONE</b> No pulsing            0001<sub>B</sub><b>TXACT</b> Transmit activity            0010<sub>B</sub><b>RXACT</b> Receive activity            0100<sub>B</sub><b>COL</b> Collision            1000<sub>B</sub><b>NO_CON</b> Constant ON behavior is switched off</p>
CON	7:4	RW	<p><b>Constant On Configuration</b></p> <p>The Constant-ON field selects in which PHY states the LED is constantly on. Each bit mask indicates a link speed. Combinations of the bit mask below can be used to provide a combination of link speed states to enable the behavior.</p> <p>0000<sub>B</sub><b>NONE</b> Not Active            0001<sub>B</sub><b>LINK10</b> On when Link is 10 Mbit/s            0010<sub>B</sub><b>LINK100</b> On when Link is 100 Mbit/s            0100<sub>B</sub><b>LINK1000</b> On when Link is 1000 Mbit/s            1000<sub>B</sub><b>LINK2500</b> On when Link is 2500 Mbit/s</p>

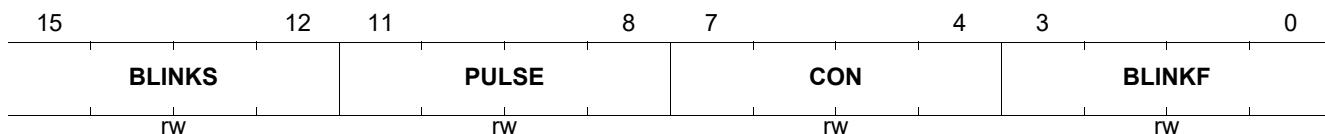
Field	Bits	Type	Description (cont'd)
BLINKF	3:0	RW	<p><b>Fast Blinking Configuration</b></p> <p>The Blink-F Field selects in which PHY states the LED blinks with the pre-defined fast frequency. Each bit mask indicates a link speed. Combinations of the bit mask below can be used to provide a combination of link speed states to enable the behavior.</p> <p>0000<sub>B</sub><b>NONE</b> Not Active  0001<sub>B</sub><b>LINK10</b> Blink when Link is 10 Mbit/s  0010<sub>B</sub><b>LINK100</b> Blink when Link is 100 Mbit/s  0100<sub>B</sub><b>LINK1000</b> Blink when Link is 1000 Mbit/s  1000<sub>B</sub><b>LINK2500</b> Blink when Link is 2500 Mbit/s</p>

#### Configuration for LED Pin 2 (Register 30.3)

Configuration Register for LED Pin 2

IEEE Standard Register=30.3

VSPEC1_LED2	Reset Value
Configuration for LED Pin 2 (Register 30.3)	0340 <sub>H</sub>



Field	Bits	Type	Description
BLINKS	15:12	RW	<p><b>Slow Blinking Configuration</b></p> <p>The Blink-S field selects in which PHY states the LED blinks with the pre-defined slow frequency. Each bit mask indicates a link speed. Combinations of the bit mask below can be used to provide combination of link speed states to enable the behavior.</p> <p>0000<sub>B</sub><b>NONE</b> Not Active  0001<sub>B</sub><b>LINK10</b> Blink when Link is 10 Mbit/s  0010<sub>B</sub><b>LINK100</b> Blink when Link is 100 Mbit/s  0100<sub>B</sub><b>LINK1000</b> Blink when Link is 1000 Mbit/s  1000<sub>B</sub><b>LINK2500</b> Blink when Link is 2500 Mbit/s</p>
PULSE	11:8	RW	<p><b>Pulsing Configuration</b></p> <p>The pulse field is a mask field by which certain events can be combined, e.g. TXACT RXACT, to generate a pulse on the LED when such an event is detected.</p> <p>0000<sub>B</sub><b>NONE</b> No pulsing  0001<sub>B</sub><b>TXACT</b> Transmit activity  0010<sub>B</sub><b>RXACT</b> Receive activity  0100<sub>B</sub><b>COL</b> Collision  1000<sub>B</sub><b>NO_CON</b> Constant ON behavior is switched off</p>

Field	Bits	Type	Description (cont'd)
CON	7:4	RW	<p><b>Constant On Configuration</b></p> <p>The Constant-ON field selects in which PHY states the LED is constantly on. Each bit mask indicates a link speed. Combinations of the bit mask below can be used to provide combination of link speed states to enable the behavior.</p> <p><math>0000_B</math> <b>NONE</b> Not Active</p> <p><math>0001_B</math> <b>LINK10</b> On when Link is 10 Mbit/s</p> <p><math>0010_B</math> <b>LINK100</b> On when Link is 100 Mbit/s</p> <p><math>0100_B</math> <b>LINK1000</b> On when Link is 1000 Mbit/s</p> <p><math>1000_B</math> <b>LINK2500</b> On when Link is 2500 Mbit/s</p>
BLINKF	3:0	RW	<p><b>Fast Blinking Configuration</b></p> <p>The Blink-F Field selects in which PHY states the LED blinks with the pre-defined fast frequency. Each bit mask indicates a link speed. Combinations of the bit mask below can be used to provide a combination of link speed states to enable the behavior.</p> <p><math>0000_B</math> <b>NONE</b> Not Active</p> <p><math>0001_B</math> <b>LINK10</b> Blink when Link is 10 Mbit/s</p> <p><math>0010_B</math> <b>LINK100</b> Blink when Link is 100 Mbit/s</p> <p><math>0100_B</math> <b>LINK1000</b> Blink when Link is 1000 Mbit/s</p> <p><math>1000_B</math> <b>LINK2500</b> Blink when Link is 2500 Mbit/s</p>

### Mailbox CMD type (Register 30.7)

This triggers the firmware to execute the mailbox command.

## IEEE Standard Register=30.7

VSPEC1_MBOX_CMD	Reset Value
Mailbox CMD type (Register 30.7)	0000 <sub>H</sub>
	0

Field	Bits	Type	Description
CMD	15:0	RW	<p><b>MBOX Command type</b></p> <p>To trigger a mailbox command or to use as a data input.</p> <p><b>0900<sub>H</sub> PATCH_REQ_FAST_SRAM</b> STA sends request to GPY to enter SRAM PROGRAM Mode</p> <p>In SRAM PROGRAM Mode, data writes to SRAM are accepted.</p> <p>Each 16 bit SRAM write sequence uses VSPEC1_MBOX_CMD.</p> <p>After receiving the PATCH_REQ_FAST_SRAM, the VSPEC1_MBOX_CMD is re-purposed into a data write, post-increment. Destination address need not be specified. SRAM PROGRAM Mode can be exited by receiving a STD_CTRL.RST or HRSTN to abort.</p> <p>Others: Reserved.</p>

**Chip Level SGMII control register (Register 30.8)**

SGMII control register to set up SGMII modes.

IEEE Standard Register=30.8

															<b>Reset Value</b>
															<b>34DA<sub>H</sub></b>
15	14	13	12	11	10	9	8	7	6	5	4	2	1	0	
<b>RST</b>	<b>LB</b>	<b>Res</b>	<b>ANEN</b>	<b>PD</b>	<b>RXINV</b>		<b>Res</b>	<b>EEE_CAP</b>	<b>Res</b>	<b>Res</b>		<b>Res</b>		<b>ANMODE</b>	
<small>RW</small>	<small>RW</small>		<small>RW</small>	<small>RW</small>	<small>RW</small>			<small>RW</small>		<small>RW</small>					<small>RW</small>

Field	Bits	Type	Description
RST	15	RW	<b>Reset SGMII</b> SGMII reset 0 <sub>B</sub> <b>NORM</b> Normal Operation SGMII 1 <sub>B</sub> <b>RST</b> Reset SGMII
LB	14	RW	<b>Loopback</b> SGMII loopback 0 <sub>B</sub> <b>OFF</b> SGMII Loopback is disabled 1 <sub>B</sub> <b>ON</b> SGMII Loopback Enabled
ANEN	12	RW	<b>ANEG Enable</b> If bit 12 is set to a logic one, ANMODE field determines the Auto-Negotiation protocol. If bit 12 is cleared to a logic zero, speed is set to maximum in full duplex mode. Once the TPI link is up, the SGMII speed is automatically forced to match the TPI speed. 0 <sub>B</sub> <b>OFF</b> SGMII ANEG DisabledSpeed is set to maximum in full duplex mode until TPI is linkup. 1 <sub>B</sub> <b>ON</b> SGMII ANEG EnabledThe negotiation style is configured by the field ANMODE
PD	11	RW	<b>Power Down</b> SGMII Power Down 0 <sub>B</sub> <b>OFF</b> Normal Operation SGMII 1 <sub>B</sub> <b>ON</b> SGMII Power Down. In this state, other bits on VSPEC1_SGMII_CTRL register has no effect.
RXINV	10	RW	<b>Inversion of RX0_M and RX0_P</b> The purpose of inverting RxM and RxP is to simplify PCB layout (not crossing of lanes, allows 1 layer) 0 <sub>B</sub> <b>NORMAL</b> No Inversion Pin 20 is RX0_P, pin 19 is RX0_M 1 <sub>B</sub> <b>INVERT</b> Invert RX SGMII Pin 20 is RX0_M, pin 19 is RX0_P
EEE_CAP	7	RW	<b>EEE SGMII ANEG</b> EEE SGMII Capability is advertised in ANEG Used only when ANMODE = AN_CIS_PHY 0 <sub>B</sub> <b>OFF</b> EEE is not advertised 1 <sub>B</sub> <b>ON</b> EEE is advertised

Field	Bits	Type	Description (cont'd)
ANMODE	1:0	rw	<p><b>SGMII ANEG Mode</b>            Defines the type of ANEG protocol when ANEG is enabled</p> <p>00<sub>B</sub> <b>RES</b> Reserved. Do not use, will default to AN_CIS_PHY</p> <p>01<sub>B</sub> <b>AN_1000BX</b> IEEE 1000Bx SGMII ANEG Clause 37 SGMII 1000Bx ANEG is used</p> <p>10<sub>B</sub> <b>AN_CIS_PHY</b> CISCO SGMII ANEG mode with GPY acting as a PHYANEG is done as defined by CISCO SGMII standard, as a PHY-side SGMII. This is the default configuration.</p> <p>11<sub>B</sub> <b>AN_CIS_MAC</b> CISCO SGMII ANEG mode with GPY acting as a MACANEG is done as defined by CISCO SGMII standard, as a MAC-side SGMII.</p>

#### Chip Level SGMII status register (Register 30.9)

SGMII Status register.

All of the bits in the Status register are read only, a write has no effect.

IEEE Standard Register=30.9

VSPEC1_SGMII_STAT												Reset Value		
Chip Level SGMII status register (Register 30.9)												0008 <sub>H</sub>		
15	14	Res				8	7	6	5	4	3	2	1	0
RES		Res					RES	Res	ANOK	RF	ANAB	LS	DR	
ro							ro	ro	rolh	ro	roll	ro	ro	

Field	Bits	Type	Description
RES	7	RO	<p><b>Reserved</b>            Ignore when read.</p>
ANOK	5	RO	<p><b>Auto-Negotiation Completed</b>            Indicates whether the auto-negotiation process is completed or not.</p> <p>0<sub>B</sub> <b>RUNNING</b> Auto-negotiation process is in progress or not started</p> <p>1<sub>B</sub> <b>COMPLETED</b> Auto-negotiation process is completed</p>
RF	4	ROLH	<p><b>Remote Fault</b>            Indicates the detection of a remote fault event.</p> <p>0<sub>B</sub> <b>INACTIVE</b> No remote fault condition detected</p> <p>1<sub>B</sub> <b>ACTIVE</b> Remote fault condition detected</p>
ANAB	3	RO	<p><b>Auto-Negotiation Ability</b>            Specifies the auto-negotiation ability.</p> <p>0<sub>B</sub> <b>DISABLED</b> PHY is not able to perform auto-negotiation</p> <p>1<sub>B</sub> <b>ENABLED</b> PHY is able to perform auto-negotiation</p>

Field	Bits	Type	Description (cont'd)
LS	2	ROLL	<b>Link Status</b> Indicates the link status of the SGMII 0 <sub>B</sub> <b>INACTIVE</b> The link is down. No communication with link partner possible. 1 <sub>B</sub> <b>ACTIVE</b> The link is up. Data communication with link partner is possible.
DR	1:0	RO	<b>SGMII Data Rate</b> This field indicates the operating data rate of SGMII when link is up 00 <sub>B</sub> <b>DR_10</b> SGMII link rate is 10 Mbit/s 01 <sub>B</sub> <b>DR_100</b> SGMII link rate is 100 Mbit/s 10 <sub>B</sub> <b>DR_1G</b> SGMII link rate is 1000 Mbit/s 11 <sub>B</sub> <b>RES</b> Reserved

**NBASE-T Downshift Control Register (Register 30.10)**

IEEE Standard Register=30.10

VSPEC1_NBT_DS_CTRL								Reset Value		
NBASE-T Downshift Control Register (Register 30.10)								0400 <sub>H</sub>		
15					8	7	6	2	1	0
NRG_RST_CNT				FORC_E_R*	DOWNSHIFT_THR				DOWN SHI*	NO_NRG_*
	rw					rw		rw	rw	rw

Field	Bits	Type	Description
NRG_RST_CNT	15:8	RW	<b>Timer to Reset the Downshift process</b> If energy is zero for a duration equal to NRG_RST_CNT units approximately, then resets the ANEG advertised capabilities to the maximum GPY capabilities. One NRG_RST_CNT unit is a random value between 2.4 seconds and 4 seconds. When NRG_RST_CNT is lower than 2, the ADS feature cannot be enabled. Default is 4 units. <i>Note: This timer only takes effect when NO_NRG_RST is set.</i>
FORCE_RST	7	RW	<b>Force Reset of Downshift Process</b> Setting this bit to 1 immediately resets the ANEG advertised capabilities to the maximum GPY capabilities.
DOWNSHIFT_THR	6:2	RW	<b>NBASE-T Downshift Training Counter Threshold</b> dsh_thr variable in NBASE-T specification Counter from 0 to 15 implemented on 4 bits controlling the number of training cycles allowed for linkup, otherwise downshift
DOWNSHIFT_EN	1	RW	<b>NBASE-T Downshift Enable</b> dsh_en variable in NBASE-T specification 0 <sub>B</sub> <b>DISABLE</b> Disable NBT downshift 1 <sub>B</sub> <b>ENABLE</b> Enable NBT downshift

Field	Bits	Type	Description (cont'd)
NO_NRG_RS_T	0	RW	<b>Advertise all Speeds if No Energy Detected</b> If no energy is detected, resets to advertise all speeds energy variable in NBASE-T specification 0 <sub>B</sub> <b>DISABLE</b> Do not reset speeds adv when no energy detected 1 <sub>B</sub> <b>ENABLE</b> Reset speed adv when no energy detected

**NBASE-T Downshift Status Register (Register 30.11)**

IEEE Standard Register=30.11

**VSPEC1\_NBT\_DS\_STA**

Reset Value

 0000<sub>H</sub>

15	Res				9	8	7	6	5	4	0
					ro						

**DOWNSHIFT\_CNT**

**Field**
**Bits**
**Type**
**Description**

DOWNSHIFT_1G	8	RO	<b>Downshift from 1G to lower speed</b>
DOWNSHIFT_2G5	7	RO	<b>Downshift from 2.5 G to lower speed</b> Not supported by GPY
DOWNSHIFT_5G	6	RO	<b>Downshift 5G to lower speed</b> Not supported by GPY
DOWNSHIFT_10G	5	RO	<b>Downshift 10G to lower speed</b> Not supported by GPY
DOWNSHIFT_CNT	4:0	RO	<b>Training attempt counter</b> Counts training attempts to select the operating speed dsh_cnt state variable in NBASE-T specification

**Packet Manager Control (Register 30.12)**

IEEE Standard Register=30.12

Control the Packet Manager Configuration

**VSPEC1\_PM\_CTRL**

Reset Value

 2083<sub>H</sub>

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Res	MDIO_VOL	Res	SI	Res					RES	RES	RES	RES	RES	PM_EN	

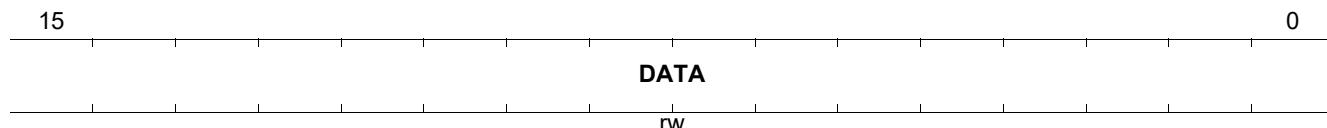
Field	Bits	Type	Description
MDIO_VOL	14	RW	<b>MDIO Voltage</b> Configure the voltage level on the MDIO, MDC, and MDINT pins. 0 <sub>B</sub> <b>NORMAL</b> 3.3 V 1 <sub>B</sub> <b>LOW</b> 1.8 V
SI	12	RW	<b>Super Isolate</b> Use in Super Isolate mode. Forces the device into a power down state by pin strapping (SLEEP) in which power consumption is the bare minimum required to still maintain the MII management interface communication. When activating the power down functionality, the PHY terminates active data links. The MII interface is also stopped in power down mode. See also IEEE 802.3 22.2.4.1.5. The SI bit is only used to release the device from Super Isolate mode. Entering Super Isolate mode can only be activated by pin strapping at power up. 0 <sub>B</sub> <b>NORMAL</b> Normal operational mode 1 <sub>B</sub> <b>SUPER_ISOLATE</b> Super Isolate mode
PM_EN	0	RW	<b>Enable Packet Manager</b> Enable LPI generation within the GPY Packet Manager on GPY supports the Smart AZ feature. 0 <sub>B</sub> <b>DISABLE</b> Disable PM is bypassed 1 <sub>B</sub> <b>ENABLE</b> Enable

#### Data for Mailbox (Register 30.13)

This register provides the status information for the mailbox command process.

IEEE Standard Register=30.13

VSPEC1_MBOX_DATA_HIGH	Reset Value
<b>Data for Mailbox (Register 30.13)</b>	<b>EEEE<sub>H</sub></b>



Field	Bits	Type	Description
DATA	15:0	RW	<b>Mailbox Data</b> Data Read by the MBOX transaction.

**Temperature code (Register 30.14)**

Junction Temperature Code that can be converted to T Celsius by the GPY API.

IEEE Standard Register=30.14

<b>VSPEC1_TEMP_STA</b>	<b>Reset Value</b>
Temperature code (Register 30.14)	<b>0000<sub>H</sub></b>

15	10	9	0
Res		<b>TEMP_DATA</b>	
			ro

Field	Bits	Type	Description
TEMP_DATA	9:0	RO	<p><b>Code for Junction Temperature</b></p> <p>This code can be converted to Temperature in Celsius Degrees by the GPY API driver. The STA is expected to take thermal mitigation measures when the junction temperature exceeds Normal Operating Range. The code is invalid when the value is 0x0000.</p> <p>Conversion formula: <math>T</math> in Celsius = <math>( -2.5761E-11) * N^4 + (9.7332E-8) * N^3 + (-1.9165E-04) * N^2 + (3.0762E-1) * N + (-5.2156E+1)</math>, with <math>N</math> = decimal value of the code TEMP_DATA</p> <p>For <math>T_j = -40</math> deg C, TEMP_DATA = 40.5 (decimal)</p> <p>For <math>T_j = +125</math> degC, TEMP_DATA = 912 (decimal)</p>

**ASP Mapping to Physical Lanes (Register 30.20)**

Programmable option to map physical lanes A,B,C,D of the TPI to the ASPs.

*Note: Each ASP must be mapped to each lane.*

IEEE Standard Register=30.20

<b>VSPEC1_LANE_ASP_MAP</b>	<b>Reset Value</b>
ASP Mapping to Physical Lanes (Register 30.20)	<b>00E4<sub>H</sub></b>

15	8	7	6	5	4	3	2	1	0				
Res						LANE_D	rw	LANE_C	rw	LANE_B	rw	LANE_A	rw

Field	Bits	Type	Description
LANE_D	7:6	RW	<p><b>Map Physical Lane-D to the ASP</b></p> <p>00<sub>B</sub> <b>ASPA</b> Map Physical Lane-D to the ASP-A</p> <p>01<sub>B</sub> <b>ASPB</b> Map Physical Lane-D to the ASP-B</p> <p>10<sub>B</sub> <b>ASPC</b> Map Physical Lane-D to the ASP-C</p> <p>11<sub>B</sub> <b>ASPD</b> Map Physical Lane-D to the ASP-D</p>

Field	Bits	Type	Description (cont'd)
LANE_C	5:4	RW	<b>Map Physical Lane-C to the ASP</b> 00 <sub>B</sub> <b>ASPA</b> Map Physical Lane-C to the ASP-A 01 <sub>B</sub> <b>ASPB</b> Map Physical Lane-C to the ASP-B 10 <sub>B</sub> <b>ASPC</b> Map Physical Lane-C to the ASP-C 11 <sub>B</sub> <b>ASPD</b> Map Physical Lane-C to the ASP-D
LANE_B	3:2	RW	<b>Map Physical Lane-B to the ASP</b> 00 <sub>B</sub> <b>ASPA</b> Map Physical Lane-B to the ASP-A 01 <sub>B</sub> <b>ASPB</b> Map Physical Lane-B to the ASP-B 10 <sub>B</sub> <b>ASPC</b> Map Physical Lane-B to the ASP-C 11 <sub>B</sub> <b>ASPD</b> Map Physical Lane-B to the ASP-D
LANE_A	1:0	RW	<b>Map Physical Lane-A to the ASP</b> 00 <sub>B</sub> <b>ASPA</b> Map Physical Lane-A to the ASP-A 01 <sub>B</sub> <b>ASPB</b> Map Physical Lane-A to the ASP-B 10 <sub>B</sub> <b>ASPC</b> Map Physical Lane-A to the ASP-C 11 <sub>B</sub> <b>ASPD</b> Map Physical Lane-A to the ASP-D

## 6.5 Vendor Specific 2 Device for MMD=0x1F

This register file contains GPY specific register for MMD=31 (decimal)

Table 24 Registers Overview

Register Short Name	Register Long Name	Reset Value
<a href="#">VPSPEC2_WOL_CTL</a>	Wake-on-LAN Control Register (Register 31.3590)	0000 <sub>H</sub>
<a href="#">VPSPEC2_WOL_AD01</a>	Wake-On-LAN Address Byte 0 and 1 (Register 31.3592)	0000 <sub>H</sub>
<a href="#">VPSPEC2_WOL_AD23</a>	Wake-on-LAN Address Byte 2 and 3 (Register 31.3593)	0000 <sub>H</sub>
<a href="#">VPSPEC2_WOL_AD45</a>	Wake-On-LAN Address Byte 4 and 5 (Register 31.3594)	0000 <sub>H</sub>
<a href="#">VPSPEC2_WOL_PW01</a>	Wake-On-LAN SecureON Password Byte 0 (Register 31.3595)	0000 <sub>H</sub>
<a href="#">VPSPEC2_WOL_PW23</a>	Wake-on-LAN SecureON Password Byte 2 and 3 (Register 31.3596)	0000 <sub>H</sub>
<a href="#">VPSPEC2_WOL_PW45</a>	Wake-on-LAN SecureON Password Byte 4 and 5 (Register 31.3597)	0000 <sub>H</sub>

### 6.5.1 Vendor Specific 2 Device for MMD=0x1F

This chapter describes all registers of VSPEC2 in detail.

#### Wake-on-LAN Control Register (Register 31.3590)

Wake-on-LAN Control Register. Redirected to PCS\_PDI\_WOL\_CTL

IEEE Standard Register=31.3590

VPSPEC2_WOL_CTL		Reset Value			
Wake-on-LAN Control Register (Register 31.3590)		0000 <sub>H</sub>			
15	Res	3	2	1	0
			SPWD_EN	RES	EN
			rw	ro	rw

Field	Bits	Type	Description
SPWD_EN	2	RW	<p><b>Secure-ON Password Enable</b>            If enabled, checks for the Secure-ON password after the 16 MAC address repetitions.</p> <p>0<sub>B</sub> <b>DISABLED</b> Secure-On password check is disabled            1<sub>B</sub> <b>ENABLED</b> Secure-On password check is enabled</p>
RES	1	RO	<p><b>Reserved</b>            Must always be written to zero!</p>
EN	0	RW	<p><b>Enables the Wake-on-LAN functionality</b>            If Wake-on-LAN is enabled, the PHY scans for the configured magic packet and indicates its reception via the register bit ISTAT.WOL, and optionally also via interrupt.</p> <p>0<sub>B</sub> <b>DISABLED</b> Wake-on-LAN functionality is disabled            1<sub>B</sub> <b>ENABLED</b> Wake-on-LAN functionality is enabled</p>

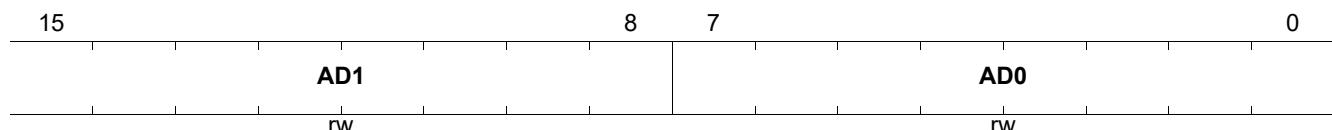
**Wake-On-LAN Address Byte 0 and 1 (Register 31.3592)**

Wake-on-LAN Address Byte 0 and 1. Redirected to PCS\_PDI\_WOL\_AD01

IEEE Standard Register=31.3592

**VPSPEC2\_WOL\_AD01**

Reset Value

**Wake-On-LAN Address Byte 0 and 1 (Register 31.3592)**0000<sub>H</sub>

Field	Bits	Type	Description
AD1	15:8	RW	<b>Address Byte 1</b> Defines byte 1 of the WoL-designated MAC address to which the PHY is sensitive.
AD0	7:0	RW	<b>Address Byte 0</b> Defines byte 0 of the WoL-designated MAC address to which the PHY is sensitive.

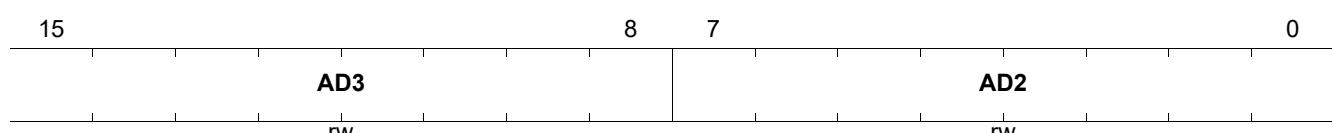
**Wake-on-LAN Address Byte 2 and 3 (Register 31.3593)**

Wake-On-LAN Address Byte 2 and 3. Redirected to PCS\_PDI\_WOL\_AD23

IEEE Standard Register=31.3593

**VPSPEC2\_WOL\_AD23**

Reset Value

**Wake-on-LAN Address Byte 2 and 3 (Register 31.3593)**0000<sub>H</sub>

Field	Bits	Type	Description
AD3	15:8	RW	<b>Address Byte 3</b> Defines byte 3 of the WoL-designated MAC address to which the PHY is sensitive.
AD2	7:0	RW	<b>Address Byte 2</b> Defines byte 2 of the WoL-designated MAC address to which the PHY is sensitive.

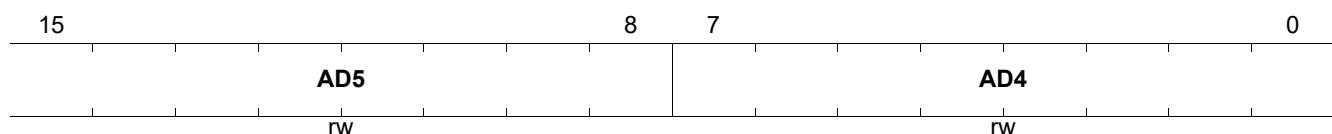
**Wake-On-LAN Address Byte 4 and 5 (Register 31.3594)**

Wake-On-LAN Address Byte 4 and 5. Redirected to PCS\_PDI\_WOL\_AD45

IEEE Standard Register=31.3594

**VPSPEC2\_WOL\_AD45****Wake-On-LAN Address Byte 4 and 5 (Register 31.3594)**

Reset Value

0000<sub>H</sub>

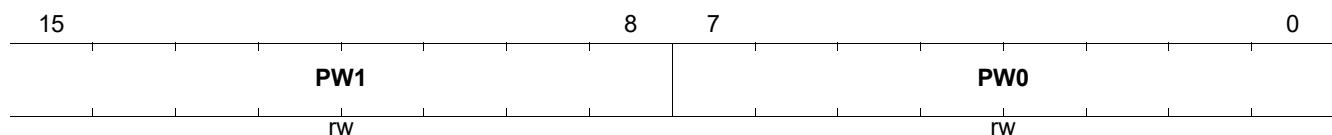
Field	Bits	Type	Description
AD5	15:8	RW	<b>Address Byte 5</b> Defines byte 5 of the WoL-designated MAC address to which the PHY is sensitive.
AD4	7:0	RW	<b>Address Byte 4</b> Defines byte 4 of the WoL-designated MAC address to which the PHY is sensitive.

**Wake-On-LAN SecureON Password Byte 0 (Register 31.3595)**

Wake-on-LAN SecureON Password Byte 0. Redirected to PCS\_PDI\_WOL\_PWD01

IEEE Standard Register=31.3595

Field	Bits	Type	Reset Value
			0000 <sub>H</sub>



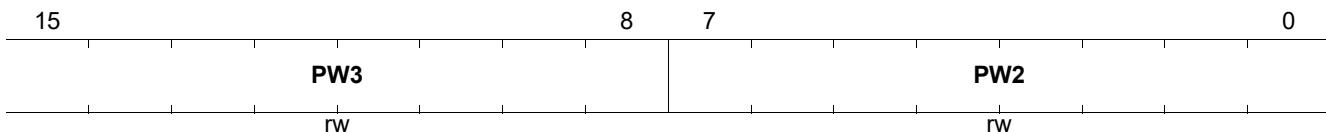
Field	Bits	Type	Description
PW1	15:8	RW	<b>SecureON Password Byte 1</b> Defines byte 1 of the WoL-designated SecureON password to which the PHY is sensitive.
PW0	7:0	RW	<b>SecureON Password Byte 0</b> Defines byte 0 of the WoL-designated SecureON password to which the PHY is sensitive.

**Wake-on-LAN SecureON Password Byte 2 and 3 (Register 31.3596)**

Wake-On-LAN SecureON Password Byte 2 and 3. Redirected to PCS\_PDI\_WOL\_PWD23

IEEE Standard Register=31.3596

Field	Bits	Type	Reset Value
			0000 <sub>H</sub>



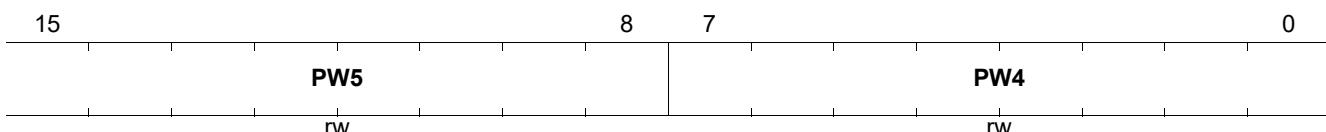
Field	Bits	Type	Description
PW3	15:8	RW	<b>SecureON Password Byte 3</b> Defines byte 3 of the WoL-designated SecureON password to which the PHY is sensitive.
PW2	7:0	RW	<b>SecureON Password Byte 2</b> Defines byte 2 of the WoL-designated SecureON password to which the PHY is sensitive.

#### Wake-on-LAN SecureON Password Byte 4 and 5 (Register 31.3597)

Wake-on-LAN SecureON Password Byte 4 and 5. Redirected to PCS\_PDI\_WOL\_PWD45

IEEE Standard Register=31.3597

VPSPEC2_WOL_PW45	Reset Value
Wake-on-LAN SecureON Password Byte 4 and 5 (Register 31.3597)	0000 <sub>H</sub>



Field	Bits	Type	Description
PW5	15:8	RW	<b>SecureON Password Byte 5</b> Defines byte 5 of the WoL-designated SecureON password to which the PHY is sensitive.
PW4	7:0	RW	<b>SecureON Password Byte 4</b> Defines byte 4 of the WoL-designated SecureON password to which the PHY is sensitive.

## 7 Electrical Characteristics

This chapter defines the electrical characteristics of the MxL86112C.

### 7.1 Absolute Maximum Ratings

**Table 25** shows the absolute maximum ratings for the MxL86112C.

**Table 25 Absolute Maximum Ratings**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Storage Temperature Limits	$T_{STG}$	-55.0	—	125.0	°C	—
Soldering Temperature	$T_{SOL}$	—	—	260.0	°C	Compliance with Pb free re-flow soldering profile as J-STD-020D
Moisture Level 3 Temperature Limits	$T_{ML3}$	—	—	260.0	°C	According to IPS J-STD 020
Absolute Junction Temperature	$T_{JABS}$	0		125	°C	Thermal solution must ensure that $T_J$ never exceeds $T_{JABS}$ . The chip resets the device when $T_J > T_{JABS}$ to prevent any damage to occur.
DC Voltage Limits on VDDP3V3 Pins	$V_{DDP3V3}$	-0.5	—	+3.63	V	$V_{HIGH}$ supply
DC Voltage Limits on VDDP Pin when the maximum voltage level of 3.3 V is used on MDC, MDIO, and MDINT pins	$V_{DDP}$	-0.5	—	+3.63	V	$V_{HIGH}$ supply
DC Voltage Limits on VDDP Pin when the maximum voltage level of 1.8 V is used on MDC, MDIO, and MDINT pins	$V_{DDP}$	-0.5	—	+1.98	V	1.8 V supply dedicated to MDIO pins in lower mode
DC Voltage Limits on VPH Pin	$V_{PH}$	-0.5	—	+3.63	V	$V_{HIGH}$ supply
DC Voltage Limits on VP Pin	$V_P$	-0.5	—	+1.05	V	$V_{LOW}$ supply
DC Voltage Limits on VDDA3V3 Pins	$V_{DDA3V3}$	-0.5	—	+3.63	V	$V_{HIGH}$ supply
DC Voltage Limits on VDDA3V3XO Pin	$V_{DDA3V3XO}$	-0.5	—	+3.63	V	$V_{HIGH}$ supply
DC Voltage Limits on VDDA0V9 Pins	$V_{DDA0V9}$	-0.5	—	+1.05	V	$V_{LOW}$ supply
DC Voltage Limits on VDD Pins	$V_{DD}$	-0.5	—	+1.05	V	$V_{LOW}$ supply

## Electrical Characteristics

Table 25 Absolute Maximum Ratings (cont'd)

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
ESD HBM Robustness	$V_{ESD,HBM}$	—	—	1000.0	V	According to ANSI/ESDA/JEDEC JS-001-2014
ESD CDM Robustness	$V_{ESD,CDM}$	—	—	250.0	V	According to ANSI/ESDA/JEDEC JS-002-2014

**Attention: Stresses above the max. values listed here may cause permanent damage to the device.**

**Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.**

## Electrical Characteristics

## 7.2 Operating Range

**Table 26** defines the maximum values of voltages and temperature that must be applied to guarantee proper operation of the MxL86112C. The values are relative to a ground voltage  $V_{SS}$  of 0.0 V.

Table 26 Operating Range

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Ambient Temperature	$T_A$	0	–	70	°C	The device can operate in an ambient temperature of up to 85°C, when it is ensured that the maximum junction temperature ( $T_j$ ) of 110°C is not exceeded.
Junction Temperature	$T_j$	–	–	110	°C	Thermal solution must ensure that $T_j$ remains within operating range and never exceed maximum absolute ratings.
Multi Voltage Pin Supply Voltage for MDIO signals when the maximum voltage level of 1.8 V is used on MDC, MDIO, and MDINT pins	$V_{DDP}$	1.71	1.8	1.89	V	1.8 V supply dedicated to MDIO pins in lower mode
Multi Voltage Pin Supply Voltage for MDIO signals when the maximum voltage level of 3.3 V is used on MDC, MDIO, and MDINT pins	$V_{DDP}$	3.135	3.30	3.46	V	$V_{HIGH}$ supply
Pin Supply Voltage for non-MDIO signals	$V_{DDP3V3}$	3.13	3.30	3.46	V	$V_{HIGH}$ supply
Analog High Supply Voltage	$V_{DDA3V3}$	3.13	3.30	3.46	V	$V_{HIGH}$ supply
XO High Supply Voltage	$V_{DDA3V3XO}$	3.13	3.30	3.46	V	$V_{HIGH}$ supply
SGMII High Supply Voltage	$V_{PH}$	3.13	3.30	3.46	V	$V_{HIGH}$ supply
Analog Low Supply Voltage	$V_{DDA0V9}$	0.94	0.97	1.00	V	$V_{LOW}$ supply
SGMII Low Supply Voltage	$V_P$	0.94	0.97	1.00	V	$V_{LOW}$ supply
Core Digital Supply Voltage	$V_{DD}$	0.94	0.97	1.00	V	$V_{LOW}$ supply
Digital Input Voltage	$V_{ID}$	-0.30	–	$V_{DDP3V3}+0.3$	V	–

**Attention: Operations above the max. values listed here for extended periods can adversely affect long-term reliability of the device.**

### 7.3 Chip Power Consumption

**Table 27** lists the typical power consumption for different modes. Typical power is the power consumed by a nominal process device, nominal supply voltages, at 25°C ambient temperature and a CAT5e link segment. The Link-up conditions are full-speed, bidirectional, full-duplex.

**Table 27 Typical Power Consumption**

	3.3 V $V_{HIGH}$ Domain Current	0.97 V $V_{LOW}$ Domain Current	Chip Power
Unit	mA	mA	W
1000BASE-T Link-Up, 100 m cable	77	230	0.48
1000BASE-T EEE	30	125	0.22
100BASE-TX Link-Up, 100 m cable	45	100	0.25
100BASE-TX EEE	29	90	0.18
10BASE-Te Link-Up, 100 m cable	34	84	0.19
Cable Unplugged - ANEG	37	95	0.21
Cable Unplugged - LP	15	18	0.07
Reset	4	8	0.02

### 7.4 Maximum Thermal Design Power

**Table 28** lists the maximum Thermal Design Power (TDP). The TDP is the power consumption for a full traffic load and worst-case process, supply voltage, cable, and temperature conditions. This value is relevant to design the thermal solution.

**Table 28 Maximum Power Consumption**

	Maximum Power
Unit	W
Maximum Chip Power at Maximum Operating Range	0.75

*Note: With a properly designed thermal solution (heat sink), it is unlikely that  $T_j$  exceeds the maximum operating junction temperature. An excess is reported in the MDIO register VSPEC1\_TEMP\_STA and the STA can initiate a renegotiation to a lower link rate to get  $T_j$  back into the operating temperature range if ADS is disabled.*

### 7.5 Maximum Current

**Table 29** provides the maximum current to dimension the power supply. It is the maximum current consumption per rail for a full traffic load and worst-case process, supply voltage and temperature conditions that may occur in any operating state of the device. The maximum current can be higher than the steady state current, for instance in training phases of the internal filters.

**Table 29 Maximum Current Per Rail**

3.3 V $V_{HIGH}$ Domain Current	0.97 V $V_{LOW}$ Domain Current
mA	mA
89	582

## 7.6 DC Characteristics

The following sections describe the DC characteristics of the MxL86112C external interfaces.

### 7.6.1 Digital Interfaces

This chapter defines the DC characteristics of the GPIO interfaces as follows:

- MDIO
- Interrupts
- Clock Outputs
- General Purpose IO
- LED
- HRSTN
- DVS

The DC characteristics for  $V_{DDP3V3}=3.3$  V and  $V_{DDP}=3.3$  V are summarized in [Table 30](#).

**Table 30 DC Characteristics of the GPIO Interfaces (VDDP3V3 = 3.3 V, VDDP = 3.3 V)**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input High Voltage	$V_{IH}$	2	—	$V_{DDP}+0.3$	V	—
Input Low Voltage	$V_{IL}$	—0.3	—	0.8	V	—
Output High Voltage	$V_{OH}$	$V_{DDP}-0.4$	—	—	V	$I_{OH}=2, 4, 8, 12$ mA
Output Low Voltage	$V_{OL}$	—	—	0.4	V	$I_{OL}=2, 4, 8, 12$ mA

The DC characteristics for  $V_{DDP}=1.8$  V are summarized in [Table 31](#).

**Table 31 DC Characteristics of the GPIO Interfaces (VDDP = 1.8 V)**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input High Voltage	$V_{IH}$	$0.65*V_{DDP}$	—	$V_{DDP}+0.3$	V	—
Input Low Voltage	$V_{IL}$	—0.3	—	$0.35*V_{DDP}$	V	—
Output High Voltage	$V_{OH}$	$V_{DDP}-0.4$	—	—	V	$I_{OH}=2, 4, 8, 12$ mA
Output Low Voltage	$V_{OL}$	—	—	0.4	V	$I_{OL}=2, 4, 8, 12$ mA

### 7.6.2 Twisted Pair Interface

The TPI conforms to the specifications of 10BASE-T (Clause 14), 100BASE-TX (Clause 25), and 1000BASE-T (Clause 40) given in IEEE 802.3, as well as ANSI X3.263-1995.

## Electrical Characteristics

## 7.6.3 Built-in Temperature Sensor

Table 32 gives the parameters of the integrated temperature sensor, measuring junction temperature  $T_j$ .

Table 32 Temperature Sensor Characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Temperature Range	$T_{range}$	-10		125	°C	Thermal Mitigation measures must ensure that $T_j$ remains within operating range. If $T_j$ exceeds Maximum Ratings, the GPY performs a self-reset to prevent damage, and the next ANEG is re-started advertising a lower speed.
Resolution		—	10	—	bits	—
Accuracy		-5	—	+5	°C	—

## 7.7 AC Characteristics

The following sections describe the AC characteristics of the external interfaces.

### 7.7.1 Power Up Sequence

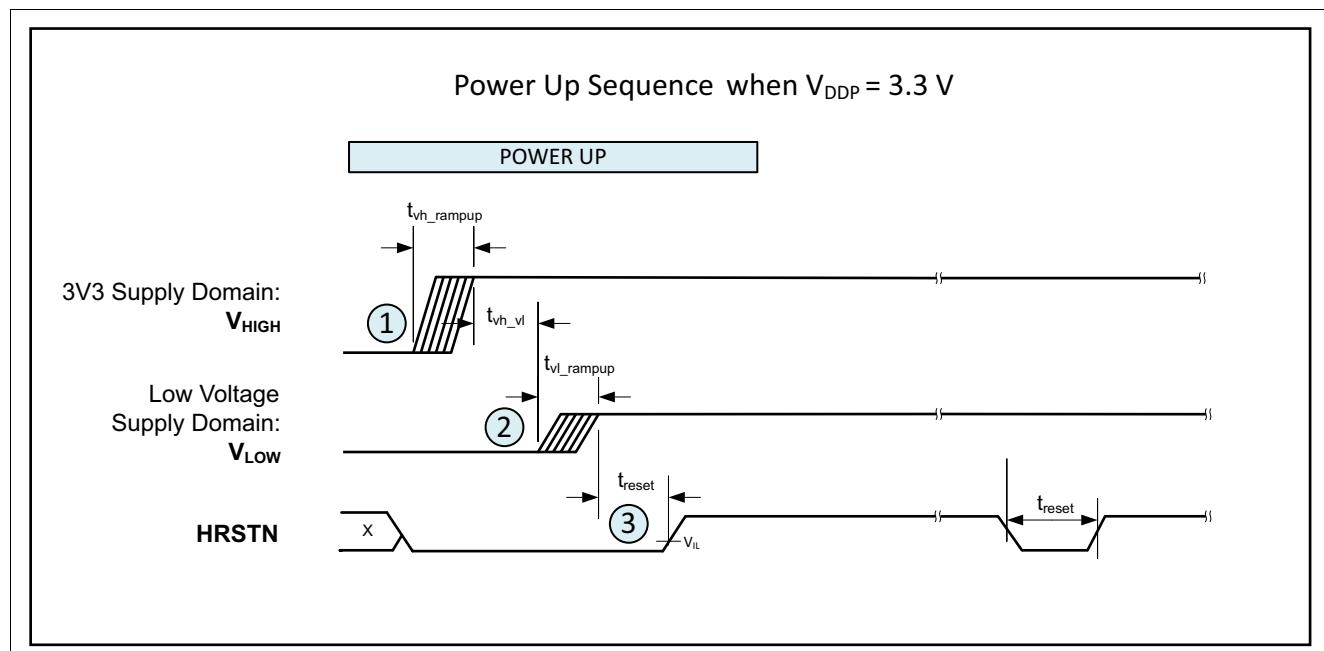
The High Voltage domain  $V_{HIGH}$  must always be at a higher voltage level, than the Low Voltage Domain  $V_{LOW}$ . When  $V_{DDP}$  is at 1.8 V,  $V_{HIGH}$  must always be at a higher voltage than  $V_{DDP}$  and  $V_{DDP}$  must always be at a higher voltage than the Low Voltage Domain  $V_{LOW}$ .

$V_{HIGH}$ ,  $V_{DDP}$ <sup>1)</sup> and  $V_{LOW}$  ramp-up times ( $t_{vh\_rampup}$ ,  $t_{vddp\_rampup}$ <sup>1)</sup> and  $t_{vl\_rampup}$ ) must be above the minimum requirement.

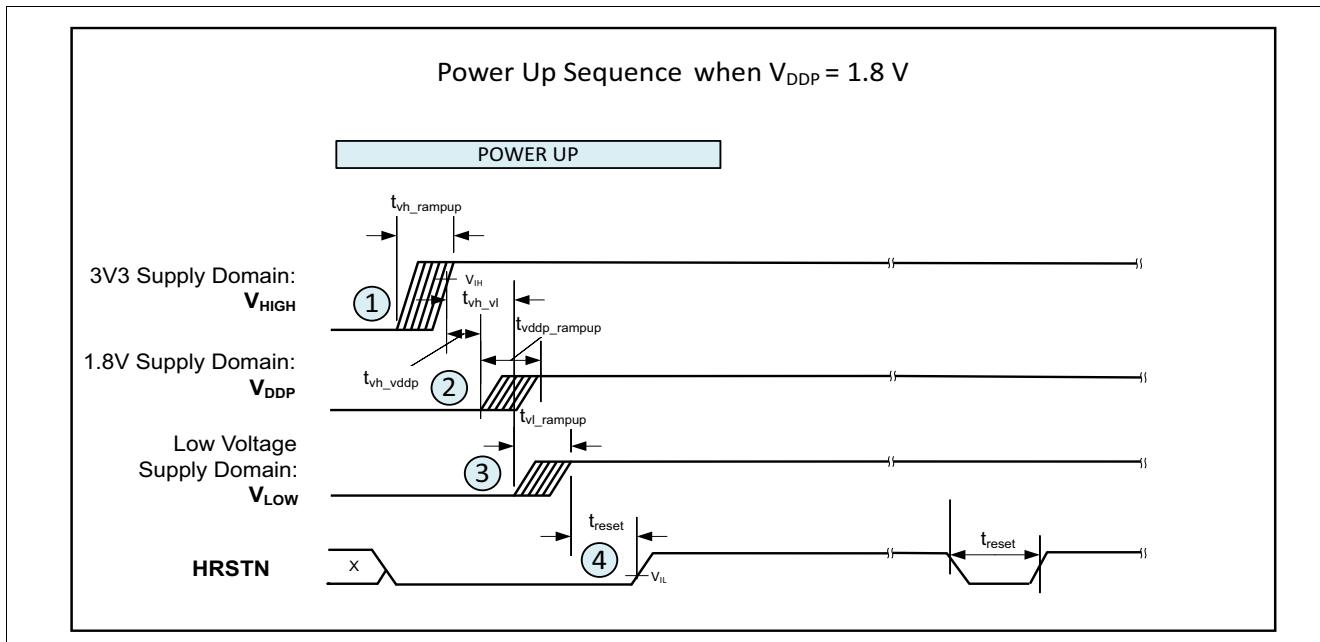
All the supply domains  $V_{HIGH}$ ,  $V_{DDP}$ <sup>1)</sup> and  $V_{LOW}$  must be stabilized before releasing the reset HRSTN.

The device reset HRSTN must be held for a  $t_{reset}$  time after the stabilization of the power supplies and pin strap values. When reset is released, the integrated PLL locks and the device boots up.

The MxL86112C supports an asynchronous hardware reset HRSTN. The timing requirements of the power supply pins are listed in [Table 33](#). The timings refer to the signal sequence waveforms depicted in [Figure 16](#) when  $V_{DDP}=3.3$  V and [Figure 17](#) when  $V_{DDP}=1.8$  V.



**Figure 16 Timing Diagram for the Reset Sequence when  $V_{DDP} = 3.3$  V**

Figure 17 Timing Diagram for the Reset Sequence when  $V_{DDP} = 1.8$  VTable 33 Power Supply Timings (External supply of  $V_{LOW}$  domain)

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
$V_{HIGH}$ domain ramp up	$t_{vh\_rampup}$	50	—	—	μs	
$V_{DDP}^{1)}$ domain ramp up	$t_{vddp\_rampup}$	50	—	—	μs	
$V_{LOW}$ domain ramp up	$t_{vl\_rampup}$	50	—	—	μs	
Delay between $V_{HIGH}$ and $V_{LOW}$ domains voltage ramp up	$t_{vh\_vl}$	100	—	—	μs	The $V_{LOW}$ voltage must never be higher than $V_{HIGH}$ voltage
Delay between $V_{HIGH}$ and $V_{DDP}^{1)}$ domains voltage ramp up	$t_{vh\_vddp}$	50	—	—	μs	The $V_{DDP}$ voltage must never be higher than $V_{HIGH}$ voltage.
Reset time after $V_{HIGH}$ and $V_{LOW}$ domains are stabilized	$t_{reset}$	100	—	—	ns	HRSTN must be released after the power supplies have stabilized.

Rise and ramp down times are from 10% to 90% marks for  $V_{HIGH}$ ,  $V_{LOW}$  and HRSTN.

### 7.7.2 Power Supply Rail Requirements

**Table 34** lists the required characteristics of the power supplies.

**Table 34 AC Characteristics of the Power Supply**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Power Supply Ripple on VDDA0V9	$R_{VDDA0V9}$	—	—	40.0	mV	Peak to Peak value
Power Supply Ripple on VP	$R_{VP}$	—	—	40.0	mV	Peak to Peak value
Power Supply Ripple on VDD	$R_{VDD}$	—	—	40.0	mV	Peak to Peak value
Power Supply Ripple on VDDP	$R_{VDDP}$	—	—	100.0	mV	Peak to Peak value
Power Supply Ripple on VDDA3V3	$R_{VDDA3V3}$	—	—	100.0	mV	Peak to Peak value
Power Supply Ripple on VDDA3V3XO	$R_{VDDA3V3XO}$	—	—	100.0	mV	Peak to Peak value
Power Supply Ripple on VPH	$R_{VPH}$	—	—	100.0	mV	Peak to Peak value

### 7.7.3 Input Clock

**Table 35** lists the input clock requirements when not using a crystal, i.e., when an external reference clock is injected into the XTAL1 pin of the MxL86112C. The requirements include the nominal frequency, frequency deviation, duty cycle, and signal characteristics. When a crystal is applied to generate the reference clock using the integrated XO, the clock requirements stated here are met explicitly as long as the specification for the crystal is satisfied.

**Table 35 AC Characteristics of Input Clock on XTAL1 Pin**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Frequency with 25 MHz Input	$f_{clk25}$	—	25.0	—	MHz	—
Frequency Deviation <sup>1)</sup>		-50.0	—	+50.0	ppm	—
Duty Cycle		40.0	50.0	60.0	%	—
Rise/Fall Times		—	—	10.0	ns	—
Input Long Term Jitter (Jrms)		—	4.0	7.0	ps	1 kHz...10 MHz
Input High Voltage		0.6	—	2.0	V	—
Input Low Voltage		-0.3	—	0.2	V	—
Load Capacitance		—	15	—	pF	—

1) Including the frequency stability tolerance due to temperature, and aging effects over the product lifetime of 5 years.

## 7.7.4 MDIO Interface

Figure 18 shows a timing diagram of the slave MDIO interface for a clock cycle in the read, write and turnaround modus. The timing measurements are annotated. The defined absolute values are summarized in Table 36.

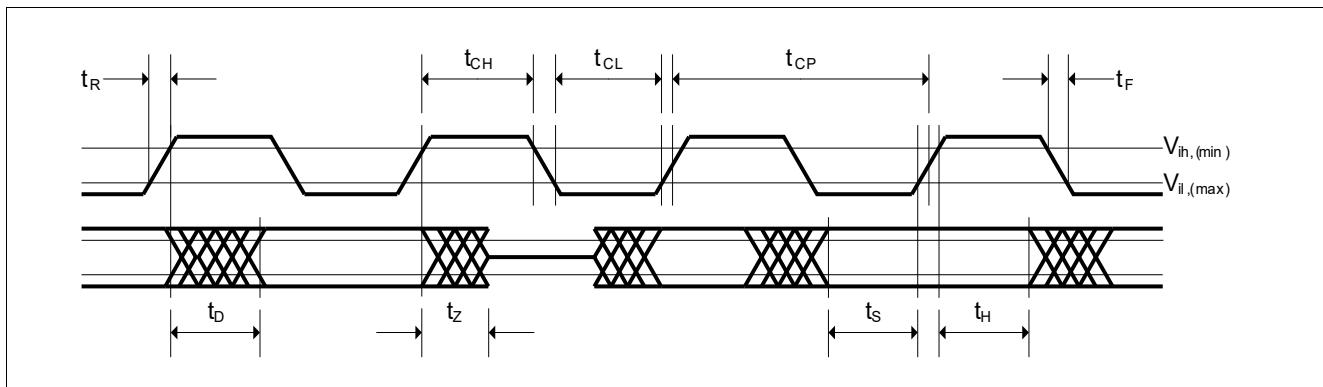


Figure 18 Timing Diagram for the MDIO Interface

Table 36 Timing Characteristics of the MDIO Interface

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
MDC High Time	$t_{CH}$	10.0	—	—	ns	Given timings all refer to the MDC signal probed at the pin of the MxL86112C.
MDC Low Time	$t_{CL}$	10.0	—	—	ns	
MDC Clock Period	$t_{CP}$	40.0	400.0	—	ns	
MDC Clock Frequency <sup>1)</sup>	$t_{CP}$	—	2.5	25.0	MHz	
MDC Rise Time	$t_R$	—	—	5.0	ns	
MDC Fall Time	$t_F$	—	—	5.0	ns	
MDIO Input Setup Time	$t_s$	10.0	—	—	ns	MxL86112C Receive
MDIO Input Hold Time	$t_h$	10.0	—	—	ns	MxL86112C receive
MDIO Output Delay Time	$t_D$	0.0	—	10	ns	MxL86112C transmit
<b>Standard @2.5 MHz</b>						
MDIO Output Delay	$t_D$	0.0	—	300.0	ns	PHY transmit
MDIO Output Setup Time	$t_s$	10.0	—	—	ns	MAC transmit
MDIO Output Hold Time	$t_h$	10.0	—	—	ns	MAC transmit

1) MDC clock supports range of frequencies up to 25 MHz. Default/typical frequency is 2.5 MHz.

### 7.7.5 SGMII Interface

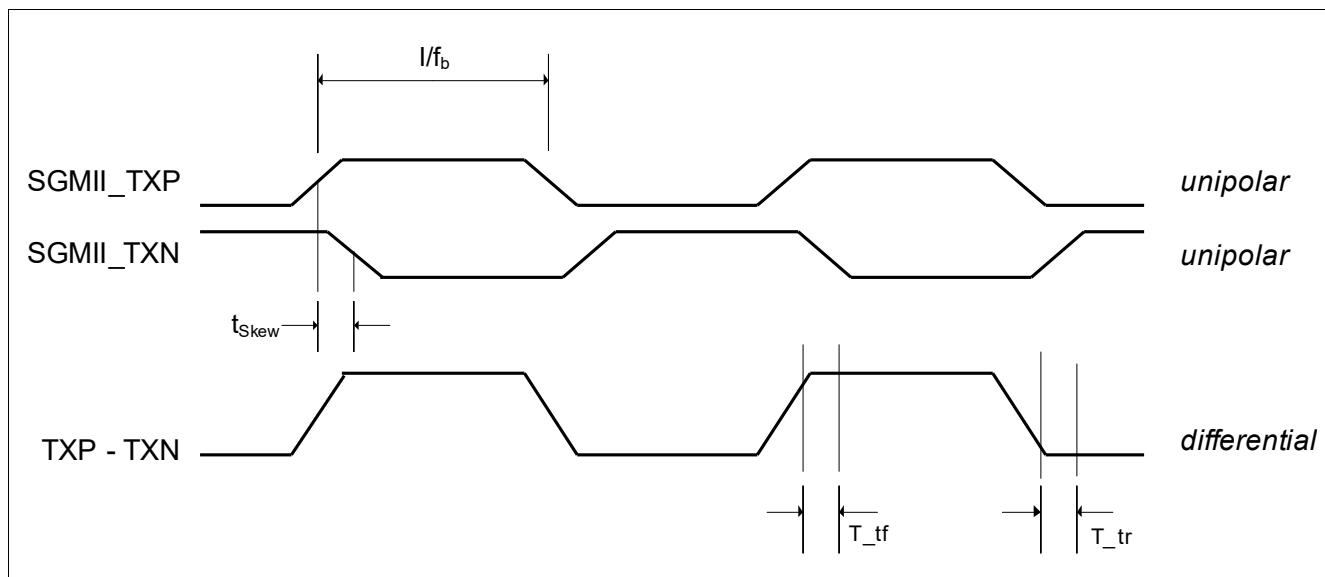
This section describes the AC characteristics of the SGMII Interface on the MxL86112C.

The SGMII Interface timing characteristics are described below:

- Transmit timing characteristics ([Chapter 7.7.5.1](#))
- Receive timing characteristics ([Chapter 7.7.5.2](#))

#### 7.7.5.1 Transmit Timing Characteristics

[Figure 19](#) shows the timing diagram of the transmit SGMII interface on the MxL86112C. It is referred to by [Table 37](#), which specifies the timing requirements.



**Figure 19** Transmit Timing Diagram of the SGMII (shows alternating data sequence)

**Table 37** Transmit Timing Characteristics of the SGMII

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Transmit baud rate	$f_b$	-100 ppm	$f_b$	+100 ppm	Mbaud	$f_b = 1.25$ Gbaud
Differential transmit rise time	$T_{tr}$	30 ps	—	0.25 UI	—	20%→80% <sup>1)</sup>
Differential transmit fall time	$T_{tf}$	30 ps	—	0.25 UI	—	80%→20%
Output timing jitter	$T_{TJ}$	—	—	0.30	UI <sub>pp</sub> <sup>2)</sup>	
Time skew between pairs	$t_{Skew}$	—	—	15	ps	—
Output differential voltage	$V_{OD}$	400	—	1600	mV	Peak-peak amplitude
Output impedance (differential)	$R_O$	80	100	120	$\Omega$	—

1) UI =  $1/f_b$ , Unit Interval.

2) Refer to [\[3\]](#) for details. The p-p (peak to peak) measurement states the maximum to minimum amount of time deviation.

### 7.7.5.2 Receive Timing Characteristics

Figure 20 shows the timing diagram of the receive SGMII interface of the MxL86112C. Refer to Table 38 for the timing requirements.

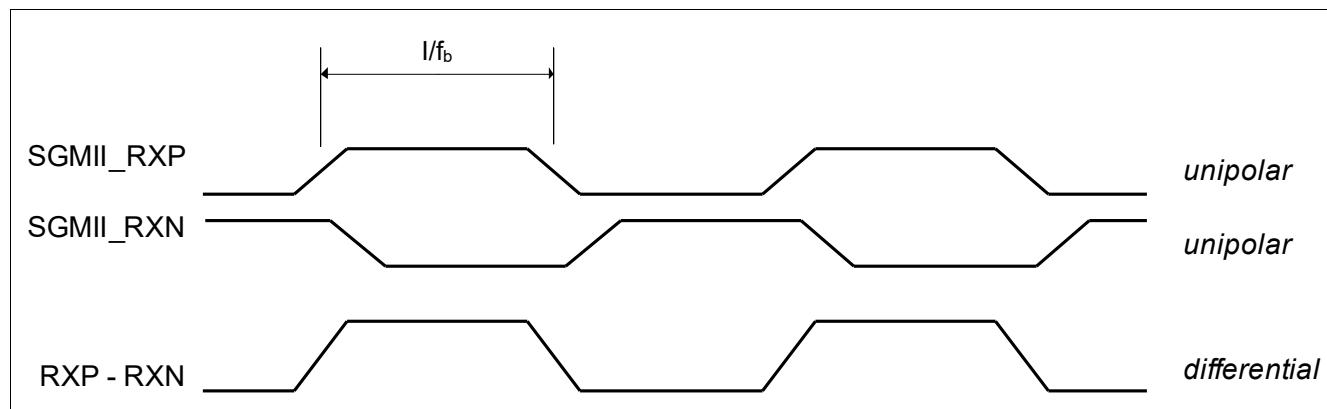


Figure 20 Receive Timing Diagram of the SGMII (alternating data input sequence)

Table 38 Receive Timing Characteristics of the SGMII

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Receive baud rate	$f_b$	-100 ppm	$f_b$	+100 ppm	Mbaud	$f_b = 1.25$ Gbaud
Receive data jitter tolerance	$R_{TJ}$	–	–	0.6	$UI_{pp}^{1)}$	–
Input differential voltage	$V_{ID}$	200	–	1600	mV	peak-peak amplitude
Input impedance (differential)	$R_I$	80	100	120	$\Omega$	–

1) Refer to [3] for details.

## Electrical Characteristics

## 7.7.6 Crystal Specification

The 25 MHz crystal must follow the specification given in [Table 39](#).

**Table 39 Specification of the Crystal**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Frequency with 25 MHz input	$f_{clk25}$	–	25.0	–	MHz	–
Total Frequency Stability	–	-50	–	+50	ppm	Refers to sum of all effects: e.g. general tolerance, aging, temperature dependency
Series Resonant Resistance	–	–	–	60	$\Omega$	–
Drive Level	–	–	–	0.1	mW	–
Load Capacitance	$C_L$	–	18	–	pF	–
Shunt Capacitance	$C_0$	–	–	5	pF	–

## 7.8 External Circuitry

This chapter specifies the component characteristics of the external circuitry connected to the MxL86112C.

### 7.8.1 Twisted-Pair Common-Mode Rejection and Termination Circuitry

This section describes the external circuitry that is required to properly terminate the common mode of the Twisted Pair Interface (TPI). These external components are also required to perform proper rejection of alien disturbers injected into the common mode of the TPI. **Figure 21** shows a typical external circuit, and in particular the common-mode components. **Table 40** defines the component values and their supported tolerances.

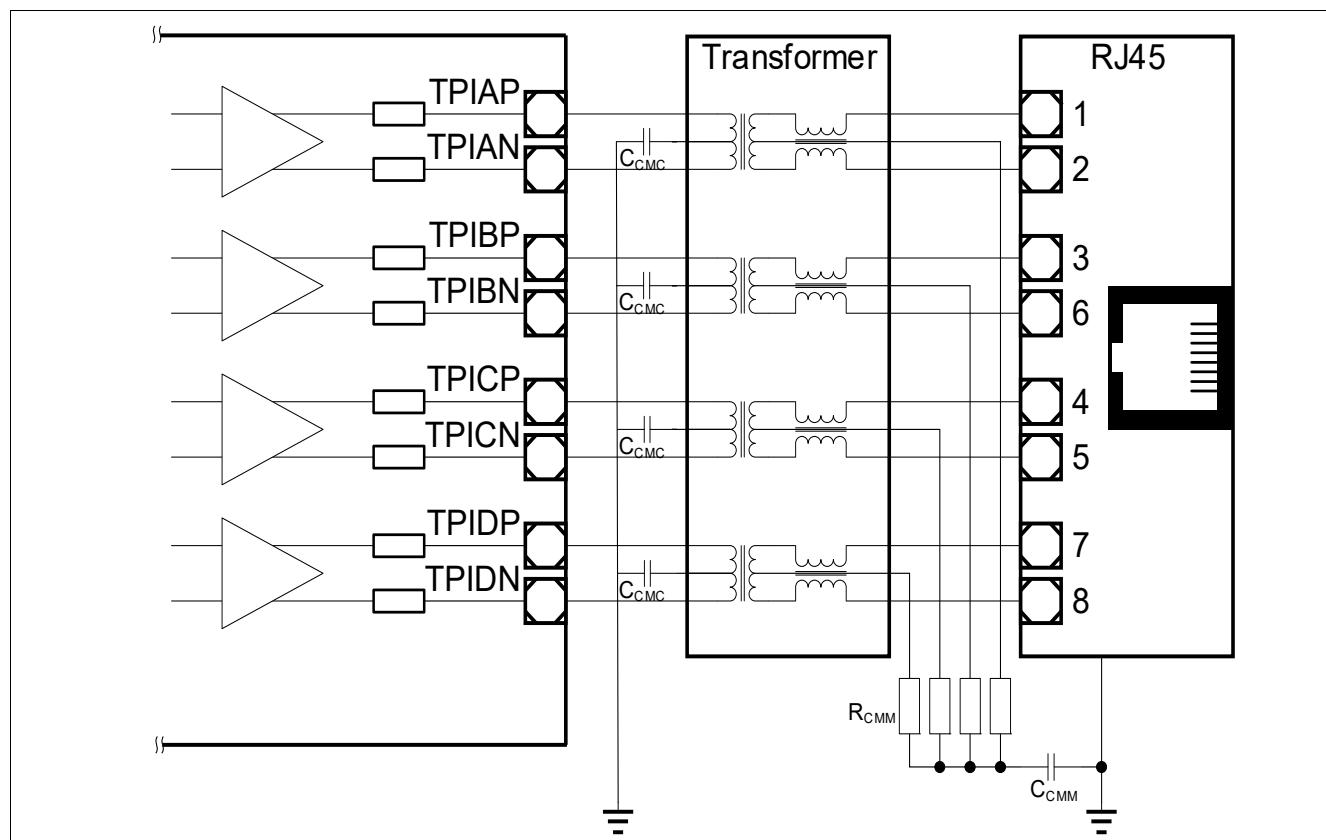


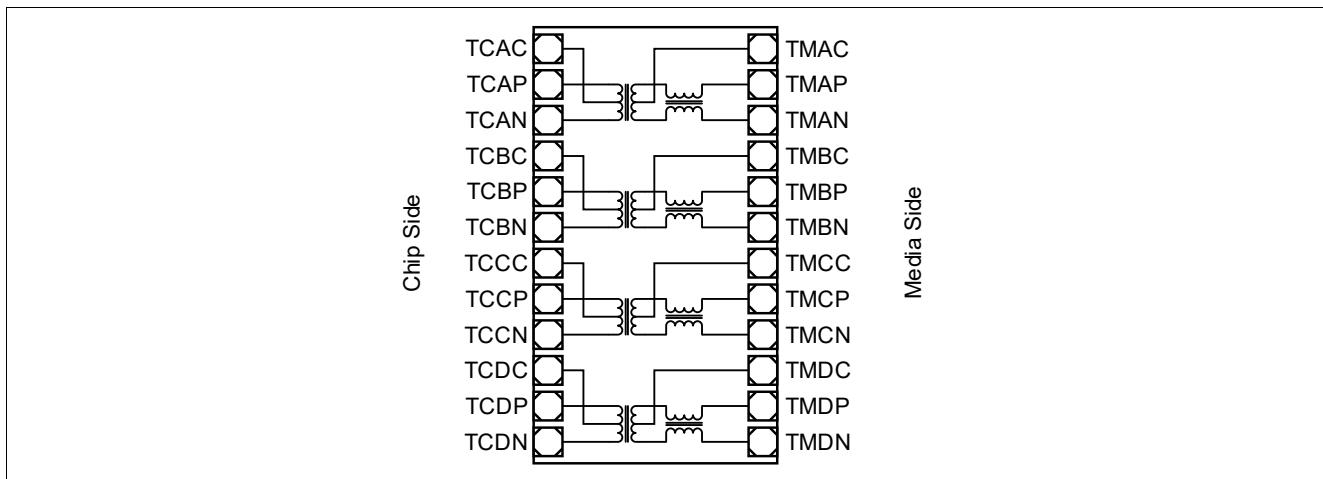
Figure 21 Twisted Pair Common-Mode Rejection and Termination Circuitry

Table 40 Electrical Characteristics for Common-Mode Rejection and Termination Circuitry

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Common-mode de-coupling capacitance (media end)	$C_{CMM}$	800	1000	1200	pF	$\pm 20\%$ , 2 kV
Common-mode de-coupling capacitance (chip end)	$C_{CMC}$	80	100	120	nF	$\pm 20\%$ , 2 kV
Common-mode termination resistance (media end)	$R_{CMM}$	67.5	75	82.5	$\Omega$	$\pm 10\%$

### 7.8.2 Transformer (Magnetics)

This section specifies the required electrical characteristics of the transformer<sup>1)</sup> devices that are supported. The specifications listed here guarantee proper operation according to IEEE 802.3 [1].



**Figure 22 Schematic of an Ethernet Transformer Device**

A typical Gigabit Ethernet capable transformer device is depicted in [Figure 22](#). [Table 41](#) lists the characteristics of the supported transformer devices. Note that these characteristics represent the minimum for achieving standard performance. Since the transformer significantly impacts the link performance, it is possible to increase the loop reach by selecting transformers with improved parameters.

**Table 41 Electrical Characteristics for Supported Transformers (Magnetics)**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Turns Ratio	1:tr	0.95	1.00	1.05		±5%
Differential-to-common-mode rejection	DCMR	40	—	—	dB	30 MHz
		35	—	—	dB	60 MHz
		30	—	—	dB	100 MHz
Crosstalk attenuation	CTA	45	—	—	dB	30 MHz
		40	—	—	dB	60 MHz
		35	—	—	dB	100 MHz
Insertion loss	IL	—	—	1	dB	1 MHz ≤ f ≤ 100 MHz
Insertion loss	IL	—	—	2	dB	100 MHz ≤ f ≤ 250 MHz
Return loss	RL	16	—	—	dB	1 MHz ≤ f ≤ 40 MHz
Return loss	RL	16-10*log10(f/40)	—	—	dB	40 MHz ≤ f ≤ 125 MHz

1) Also often referred to as “magnetics”.

## Electrical Characteristics

## 7.8.3 RJ45 Plug

Table 42 describes the electrical characteristics of the RJ45 plug to be used in conjunction with the MxL86112C.

Table 42 Electrical Characteristics for Supported RJ45 Plugs

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Crosstalk attenuation	CTA	45	—	—	dB	30 MHz
		40	—	—	dB	60 MHz
		35	—	—	dB	100 MHz
Insertion loss	IL	—	—	1	dB	1 MHz $\leq$ f $\leq$ 250 MHz
Return loss	RL	16	—	—	dB	1 MHz $\leq$ f $\leq$ 40 MHz
Return loss	RL	16-10*log10(f/40)	—	—	dB	40 MHz $\leq$ f $\leq$ 250 MHz

## 7.8.4 Calibration Resistors

An external resistor  $R_{RESREF}$  of  $200 \Omega$  1% must be connected between the RESREF pin and ground to calibrate the MxL86112C SGMII analog modules.

The resistor values are indicated in Table 43.

Table 43 Calibration Resistors Values

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
SGMII PHY calibration resistor	$R_{RESREF}$	198	200	202	$\Omega$	$\pm 1\%$

## 8 Package Outline

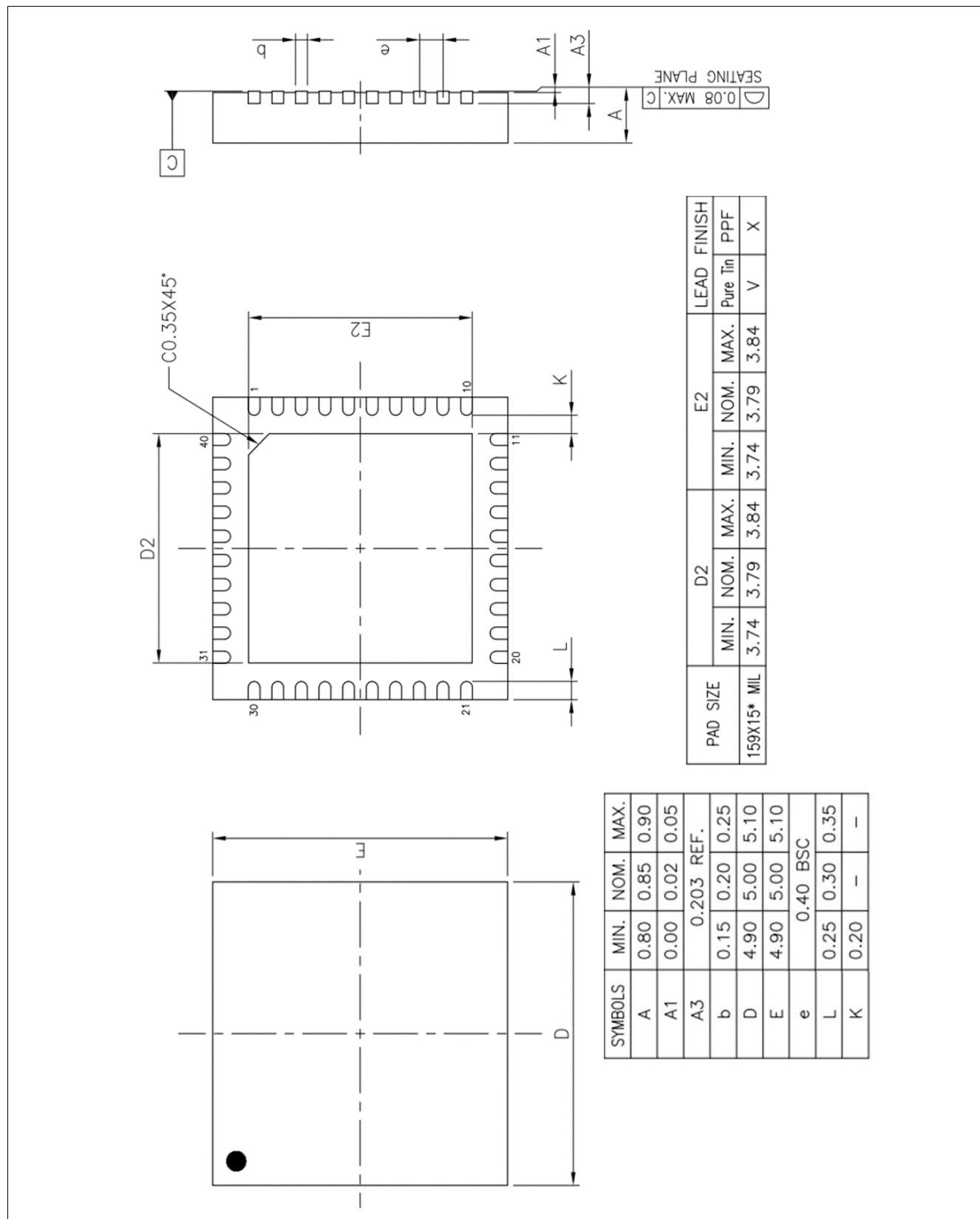
The product is assembled in a PG-VQFN-40 package, which complies with regulations requiring lead free material. The following parameters are generated in accordance with JEDEC JESD51 standards [\[4\]](#).

**Table 44 JEDEC Thermal Resistance Package Parameter**

Item	Name/Value
Environmental conditions	The chip is mounted on a 4-layer PCB (2S2P) according to JESD51-7 <a href="#">[4]</a> , PCB size 40 mm x 100 mm. Natural convection: still air, according to JESD51-2 <a href="#">[4]</a> Ambient temperature: 70°C
Thermal Resistance - Junction to Ambient	$R_{th, JA} = 21.91 \text{ K/W}$
Thermal Resistance - Junction to Board	$R_{th, JB} = 6.0 \text{ K/W}$

## Package Outline

The mechanical drawings for this package are shown in [Figure 23](#). Dimensions are in millimeters.



**Figure 23 PG-VQFN-40 5 mm x 5 mm Package Outline**

## 8.1 Ordering Information

**Table 45** describes the product, ordering, and packaging information for MxL86112C.

**Table 45 Product Naming**

Marketing Part Number	Ordering Part Number	Device Number <sup>1)</sup>	Device Revision Number <sup>2)</sup>	PHY Identifier <sup>3)</sup>
MxL86112C	MXL86112C-AQB-T	0x01	0x0	0x5410

1) LDN field in CL22 and CL45 registers

2) LDRN field in CL22 and CL45 registers

3) PHY Identifier 2 register 16-bit value

## Standards References

- [1] IEEE 802.3-2022: Carrier Sense Multiple Access with Collision Detection (CSMA/CD) Access Method and Physical Layer Specifications, IEEE Computer Society, May 2022  
<https://standards.ieee.org/ieee/802.3/10422/>
- [2] Serial-GMII Specification: Revision 1.8, Cisco Systems, November 2 2005
- [3] Common Electrical I/O (CEI) – Electrical and Jitter Interoperability agreements for 6G+ bps and 11G+ bps I/O (IA # OIF-CEI-02.0) 28th February 2005
- [4] JEDEC standard, JESD 51: Methodology for the Thermal Measurement of Component Packages (Single Semiconductor Device), December 1995  
<https://www.jedec.org/standards-documents/docs/jesd-51>

## Terminology

### A

ADS	Auto-Downspeed
ANEG	Auto-Negotiation
ANSI	American National Standards Institute

### B

BER	Bit Error Rate
BW	Bandwidth

### C

CAT5	Category 5 Cabling
CAT5e	Category 5 Enhanced Cabling
CDR	Clock and Data Recovery
CRC	Cyclic Redundancy Check

### E

EEE	Energy-Efficient Ethernet
EMI	Electromagnetic Interference
ESD	Electrostatic Discharge

### F

FLP	Fast Link Pulse
-----	-----------------

### G

GbE	Gigabit Ethernet
GPIO	General Purpose Input/Output

### H

HBM	Human Body Model
-----	------------------

### I

IC	Integrated Circuit
IEEE	Institute of Electrical and Electronics Engineers

### J

JTAG	Joined Test Action Group
------	--------------------------

### L

LAN	Local Area Network
LED	Light Emitting Diode
LPI	Low Power Idle
LSB	Least Significant Bit

### M

MAC	Media Access Controller
MDI	Media-Dependent Interface
MDIO	Management Data Input/Output
MDIX	Media-Dependent Interface Crossover

---

MII	Media-Independent Interface
MMD	MDIO Manageable Device
MSB	Most Significant Bit
<b>N</b>	
NLP	Normal Link Pulse
NP	Next Page
<b>O</b>	
OSI	Open Systems Interconnection
OUI	Organizationally Unique Identifier
<b>P</b>	
PCB	Printed Circuit Board
PCS	Physical Coding Sublayer
PD	Powered Device
PHY	Physical Layer (device)
PLL	Phase-Locked Loop
PMA	Physical Media Attachment
PSE	Power-Sourcing Equipment
PWM	Pulse Width Modulation
<b>R</b>	
RX	Receive
<b>S</b>	
SerDes	Serializer-Deserializer
SFD	Start-of-frame Delimiter
SGMII	Serial Gigabit Media-Independent Interface
SMD	Surface Mounted Device
SoC	System on Chip
STA	Station Management Entity (MAC SoC)
<b>T</b>	
TAP	Test Access Port
TPI	Twisted Pair Interface
TX	Transmit
<b>V</b>	
VQFN	Very Thin Quad Flat Non-leaded
<b>W</b>	
WoL	Wake-on-LAN
<b>X</b>	
xMII	Symbolic shortening which denotes the set of supported MII Interfaces, e.g. RGMII and SGMII